

Airbag System Basis Chip (SBC) with Power Supply and PSI5 Sensor Interface

The 33789, a SafeAssure SMARTMOS solution, is a mixed signal IC for airbag safety applications. The 33789 provides a cost effective and flexible system IC solution across the range of airbag partitions used in cars and other vehicles.

The 33789 connects to the 12 V vehicle battery and supplies the multiple voltages of a typical airbag system. The 33789 can detect switched input states, communicate with both local and remote crash sensors. It offers an industry standard interface (SPI) and four PSI5 master interfaces. The 33789 has a dedicated safing state machine that complements the airbag's MCU hardware/ software safing approach. Also included are a diagnostic - self protection capability and a programmable analog interface accessible by the system MCU.

The 33789 is well suited for use in low to high end airbag systems by allowing the designer to scale a design for the number of firing loops needed while providing enhanced safety and system reliability.

Features

- Designed to operate 5.2 V \leq V $_{PWR}$ \leq 20 V, up to a 40 V transient
- · Safing state machine with programmable sensing thresholds
- · Two configurable high-side/low-side drivers with PWM capability
- Four PSI5 satellite sensor master interfaces
- · Self-protected and diagnostic capability
- Watchdog and system Power ON Reset (POR)
- Supports complete airbag system power supply architecture, including system power mode control, supplies for squib firing (33 V), satellite sensors (6.3 V), and local ECU sensors and ECU logic circuits (5.0 V)
- Nine configurable switch input monitors for simple switch and Hall- effect sensor interfaces with internal power supply
- 16-bit SPI interface
- · LIN 2.1 physical layer interface



Applications

· Airbag safety

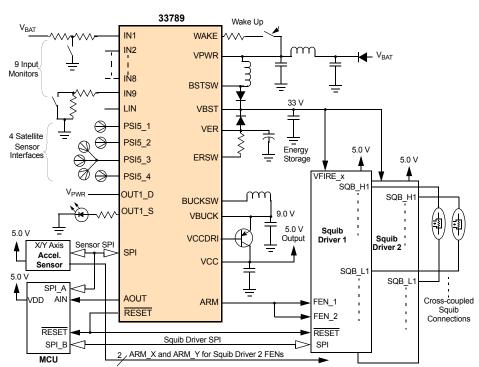


Figure 1. 33789 Simplified Application Diagram

* This document contains certain information on a new product. Specifications and information herein are subject to change without notice.

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ORDERABLE PARTS

This section describes the part numbers available to be purchased along with their differences. Valid orderable part numbers are provided on the web. To determine the orderable part numbers for this device, go to http://www.freescale.com and perform a part number search for the following device numbers.

Table 1. Orderable Part Variations

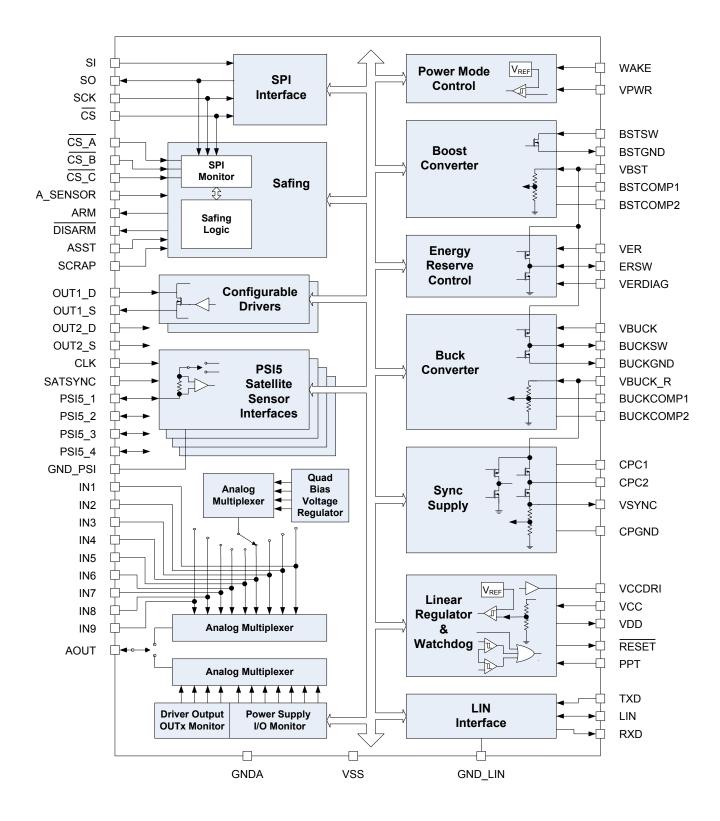
| Part Number | Notes | Temperature (T _A) | Package |
|-------------|-------|-------------------------------|------------|
| MCZ33789BAE | (1) | -40 °C to 125 °C | 64 LQFP EP |

Notes

1. To order parts in Tape & Reel, add the R2 suffix to the part number.



INTERNAL BLOCK DIAGRAM







PIN CONNECTIONS

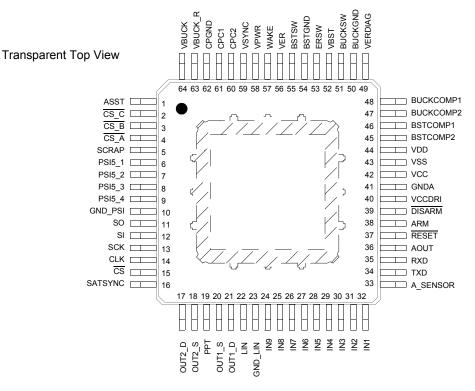


Figure 3. 33789 Pin Connections

A functional description of each pin can be found in the Functional Pin Description section beginning on page 26.

| Table 2. | 33789 | Pin I | Definitions |
|----------|-------|-------|-------------|
|----------|-------|-------|-------------|

| Pin Number | Pin Name | Pin Function | Formal Name | Definition |
|---------------|----------|-----------------|-------------------------|--|
| 1 | ASST | Input | Analog Sensor Self-test | Active high input to initiate analog sensor self-test |
| 2 | CS_C | Input | Chip Select C | Active low SPI monitor chip select input dedicated for on-board sensor C. |
| 3 | CS_B | Input | Chip Select B | Active low SPI monitor chip select input dedicated for on-board sensor B |
| 4 | CS_A | Input | Chip Select A | Active low SPI monitor chip select input dedicated for on-board sensor A |
| 5 | SCRAP | Input | Scrap | Scrap command input |
| 6 | PSI5_1 | Input/Output | PSI5 Interface 1 | PSI5 standard interface 1 as satellite sensor channel 1 |
| 7 | PSI5_2 | Input/Output | PSI5 Interface 2 | PSI5 standard interface 2 as satellite sensor channel 2 |
| 8 | PSI5_3 | Input/Output | PSI5 Interface 3 | PSI5 standard interface 3 as satellite sensor channel 3 |
| 9 | PSI5_4 | Input/Output | PSI5 Interface 4 | PSI5 standard interface 4 as satellite sensor channel 4 |
| 10 | GND_PSI | Ground | PSI Ground | Dedicated ground point for PSI5 sensor |
| 11 | SO | Output | SPI Data Out | SPI data output |
| 12 | SI | Input | SPI Data In | SPI data input |
| 13 | SCK | Input | SPI Clock | SPI clock input |
| 14 | CLK | Input | Satellite Sensor Clock | Clock input for the PSI5 sensor interface(s) running in synchronous operation mode |
| 15 | CS | Input | SPI Chip Select | Active low SPI chip select input from MCU, also used for satellite channels on SPI monitor |



Table 2. 33789 Pin Definitions (continued)

| Pin Number | Pin Name | Pin Function | Formal Name | Definition |
|---------------|---------------|-----------------|--|---|
| 16 | SATSYNC | Input | Satellite Sync-pulse Trigger | Satsync command input from MCU to trigger PSI5 Sync-pulse |
| 17 | OUT2_D | Output | Output Driver2 Drain | Drain pin of the configurable driver2 outputs |
| 18 | OUT2_S | Output | Output Driver2 Source | Source pin of the configurable driver2 outputs |
| 19 | PPT | Input | Production Programming and Testing | Active high input to enable test-mode for production programming and testing. Not for application |
| 20 | OUT1_S | Output | Output Driver1 Source | Source pin of the configurable driver1 outputs |
| 21 | OUT1_D | Output | Output Driver1 Drain | Drain pin of the configurable driver1 outputs |
| 22 | LIN | Input/output | LIN Interface | LIN interface. It can be configured as a bi-directional pin which represents the single- wire bus transmitter and receiver |
| 23 | GND_LIN | Ground | LIN Ground | Dedicated ground point for a bi-directional pin which represents the single-wire bus transmitter and receiver |
| 24 | IN9 | Input | Input Monitor Port 9 | Port 9 of input monitor for DC sensor |
| 25 | IN8 | Input | Input Monitor Port 8 | Port 8 of input monitor for DC sensor |
| 26 | IN7 | Input | Input Monitor Port 7 | Port 7 of input monitor for DC sensor |
| 27 | IN6 | Input | Input Monitor Port 6 | Port 6 of input monitor for DC sensor |
| 28 | IN5 | Input | Input Monitor Port 5 | Port 5 of input monitor for DC sensor |
| 29 | IN4 | Input | Input Monitor Port 4 | Port 4 of input monitor for DC sensor |
| 30 | IN3 | Input | Input Monitor Port 3 | Port 3 of input monitor for DC sensor |
| 31 | IN2 | Input | Input Monitor Port 2 | Port 2 of input monitor for DC sensor |
| 32 | IN1 | Input | Input Monitor Port 1 | Port 1 of input monitor for DC sensor |
| 33 | A_SENSOR | Input | Analog Sensor Input | Analog sensor input for safing |
| 34 | TXD | Input | Data Input from UART | Logic-level data input from MCU UART transmitter for LIN/K-line |
| 35 | RXD | Output | Data Output to UART | Logic-level data output to MCU UART receiver for LIN/K-line |
| 36 | AOUT | Output | Analog Output | Analog output to send MCU scaled, multiplexed and buffered analog signals for diagnosis |
| 37 | RESET | Output | Reset | Active low reset output |
| 38 | ARM | Output | Arm Enable | Active high safing enable signal to squib driver |
| 39 | DISARM | Output | Arm Disable | Active low safing enable signal to squib driver |
| 40 | VCCDRI | Output | V _{CC} Bypass Transistor Drive | Linear regulator drive output to control an external PNP transistor for 5.0 V $\rm V_{CC}$ output |
| 41 | GNDA | Ground | Analog Ground | Analog ground |
| 42 | VCC | Input | V _{CC} Input | 5.0 V V_{CC} input for monitoring and internal supply |
| 43 | VSS | Ground | Digital Ground | Digital ground |
| 44 | VDD | Output | Digital Power Supply Output | 2.5 V linear regulator output for output capacitor connection. |
| 45 | BSTCOMP2 | Input | Boost Compensation pin2 | Connection 2 to the boost converter compensation network |
| 46 | BSTCOMP1 | Input | Boost Compensation pin1 | Connection 1 to the boost converter compensation network |
| 47 | BUCKCOM P2 | Input | Buck Compensation pin2 | Connection 2 to the buck converter compensation network |
| 48 | BUCKCOM P1 | Input | Buck Compensation pin1 | Connection 1 to the buck converter compensation network |



| Pin Number | Pin Name | Pin Function | Formal Name | Definition |
|---------------|----------|-----------------|-----------------------------------|--|
| 49 | VERDIAG | Input | Energy Reserve Diagnosis | AC coupled energy reserve diagnostic input |
| 50 | BUCKGND | Ground | Buck Converter Ground | Ground return of the buck converter, buck switch ground |
| 51 | BUCKSW | Output | Buck Switch | Buck switch driver output to connect buck inductor |
| 52 | VBST | Input | Boost Voltage Input | Boost voltage input for boost loop feedback and source of buck converter, same voltage as boost output |
| 53 | ERSW | Output | Energy Reserve Switch | Storage driver output to control the energy reserve capacitor charging |
| 54 | BSTGND | Ground | Boost Converter Ground | Ground return of the boost converter, buck switch ground |
| 55 | BSTSW | Output | Boost Switch | Boost switch driver output to connect boost inductor |
| 56 | VER | Input | Energy Reserve Voltage | Energy reserve voltage input for the storage capacitor charge control and energy reserve monitor |
| 57 | WAKE | Input | Wake-up | Wake-up signal input to start-up boost and buck converters |
| 58 | VPWR | Input | Power Supply | Battery voltage power supply input |
| 59 | VSYNC | Input/output | Sensor Sync Power Supply | Satellite sensor sync voltage supply charge/discharge connection |
| 60 | CPC2 | Output | Charge Pump Capacitor Pin2 | Charge pump capacitor pin2 |
| 61 | CPC1 | Output | Charge Pump Capacitor Pin1 | Charge pump capacitor pin1 |
| 62 | CPGND | Ground | Charge Pump Ground | Charge pump ground |
| 63 | VBUCK_R | Input | Buck Converter Redundant Input | Redundant buck converter input to supply current for charge pump |
| 64 | VBUCK | Input | Buck Converter Input | Buck converter input for buck loop feedback and current source of charge pump |

Table 2. 33789 Pin Definitions (continued)



ELECTRICAL CHARACTERISTICS

MAXIMUM RATINGS

Table 3. Maximum Ratings

All voltages are with respect to ground unless otherwise noted. Exceeding these ratings may cause a malfunction or permanent damage to the device.

| Ratings | Symbol | Value | Unit |
|---|--|--------------------------|------|
| ELECTRICAL RATINGS | | | |
| Supply Input Voltage | V _{PWR} | -0.3 to 40 | V |
| Wake-up Input Voltage | V _{WAKE} | -16 to 40 | V |
| Supply Voltage - 1 | V _{BST} , V _{BSTSW} , V _{BUCKSW} , V _{ERSW} , V _{ER} | -0.3 to 40 | V |
| Supply Voltage - 2 | V _{SYNC} , V _{CPC2} | -0.3 to 20 | V |
| Supply Voltage - 3 | V _{CPC1} , V _{BUCK} , V _{BUCK} R, V _{CCDRI} | -0.3 to 10 | V |
| Supply Voltage - 4 | V _{ERDIAG} | -0.3 to 7 | V |
| Supply Voltage - 5 | V _{CC} | -0.3 to 5.5 | V |
| Supply Voltage - 6 | V _{DD} , V _{BSTCOMP1} , V _{BSTCOMP2} , V _{BUCKCOMP1} , V _{BUCKCOMP2} | -0.3 to 3 | V |
| LIN Interface Voltage | V _{LIN} | -27 to 40 | V |
| I/O Voltage - 1 | V _{OUT1 D} , V _{OUT1 S} , V _{OUT2 D} , V _{OUT2 S} | -1 to 40 | V |
| I/O Voltage - 2 | V _{IN1} ~ V _{IN9} , V _{PSI5_1} ~ V _{PSI5_4} | -1 to 20 | V |
| I/O Voltage - 3 | V _{ARM} , V _{DISARM} , V _{PPT} | -0.3 to 10 | V |
| I/O Voltage - 4 | V _{A SENSOR} , V _{AOUT} , V _{ASST} , V _{SCRAP} , V _{RESET} , V _{TXD} , V _{RXD} , V _{SI} , V _{SO} , V _{SCK} , V _{CLK} , V _{CS} , V _{CS_A} , V _{CS_B} , V _{CS C} , V _{SATSYNC} | -0.3 to 5.5 | V |
| GND Shift | V _{SS} , V _{GND} LIN, V _{CPGND} , V _{GND} PSI | -0.3 to 0.3 | V |
| LIN Bus Voltage ⁽²⁾ Normal Operation (DC) Transient (Coupled Through 1.0 nF Capacitor, according to ISO7637-2 & ISO7637-3) (See <u>Table 4</u> and <u>Figure 4</u>) - Pulse 1 (test up to the limit for Damage - Class C ⁽¹⁾) - Pulse 2a (test up to the limit for Damage - Class C ⁽¹⁾) - Pulse 3a (test up to the limit for Damage - Class | V _{BUS(SS)} V _{BUS(S1)} V _{BUS(S2A)} | -27 to 40 -100 +75 | V |
| C ⁽¹⁾) | V _{BUS(S3A)} | 150 | |
| - Pulse 3b (test up to the limit for Damage - Class | | -150 | |
| C ⁽¹⁾) | V _{BUS(S3B)} | +100 | |

Notes

1. Class C: At least one function of the transceiver stops working properly during the test, and will return to the proper operation automatically when the exposure to the disturbance has ended. No physical damage of the IC occurs.

2. The LIN bus voltage is applied on the LIN pin as $V_{\mbox{LIN}}$ during tests.



Table 3. Maximum Ratings (continued)

All voltages are with respect to ground unless otherwise noted. Exceeding these ratings may cause a malfunction or permanent damage to the device.

| Ratings | Symbol | Value | Unit |
|---|---|----------------------------|------|
| ESD Capability | | | |
| AECQ100 | | | |
| Human Body Model - JESD22/A114 ⁽³⁾ All pins | V _{ESD1-1} | ±2.0 k | |
| Charge Device Model - JESD22/C101 ⁽³⁾ Corner pins VCCDRI pin All other pins | V _{ESD2-1} V _{ESD2-2} V _{ESD2-3} | ±750 ±400 ±500 | v |
| Additional for LIN Conformance Contact Discharge, Unpowered ⁽⁴⁾ LIN pin without capacitor LIN pin with 220 pF capacitor LIN pin with 220 pF capacitor and indirect ESD coupling (according to ISO10605 - Annex F) | VLIN_ESD1-1 VLIN_ESD1-2 VLIN_ESD1-3 | ±6.0 k ±6.0 k ±8.0 k | |

THERMAL RATINGS

| Operating Temperature Junction Temperature Case (Exposed Pad) Temperature | T _J T _C | -40 to 150 -40 to 125 | °C |
|---|----------------------------------|--------------------------|----|
| Storage Temperature | T _{STG} | -65 to +150 | °C |
| Peak Package Reflow Temperature During Reflow ⁽⁵⁾ , ⁽⁶⁾ | T _{PPRT} | Note 6 | °C |

THERMAL RESISTANCE

| Junction to Ambient (Natural Convection) | θ_{JA} | 26 | °C/W |
|--|-----------------|-----|------|
| Junction to Case (Exposed Pad) | θ _{JC} | 1.5 | °C/W |

Notes

ESD testing is performed in accordance with the Human Body Model (HBM) (C_{ZAP} = 100 pF, R_{ZAP} = 1500 Ω), and the Charge Device Model (CDM) (C_{ZAP} = 4.0 pF).

 According to "Hardware Requirements for LIN, CAN, and Flexray Interfaces in Automotive Applications" specification Rev. 1.1/December 2, 2009 (C_{ZAP} = 150 pF, R_{ZAP} = 330 Ω).

5. Pin soldering temperature limit is for 10 seconds maximum duration. Not designed for immersion soldering. Exceeding these limits may cause malfunction or permanent damage to the device.

6. Freescale's Package Reflow capability meets Pb-free requirements for JEDEC standard J-STD-020C. For Peak Package Reflow Temperature and Moisture Sensitivity Levels (MSL), Go to www.freescale.com, search by part number [e.g. remove prefixes/suffixes and enter the core ID to view all orderable parts (i.e. MC33xxxD enter 33xxx), and review parametrics.



| Test Pulse | V _S [V] | Pulse Repetition Frequency [Hz] (1/T ₁) | Test Duration [min] | R _i [W] | Remarks |
|------------|--------------------|---|---------------------|--------------------|---------------------|
| 1 | -100 | 2 | 10 | 10 | t ₂ = 0s |
| 2a | +75 | 2 | 10 | 2 | |
| 3а | -150 | 10 | 10 | 50 | |
| 3b | +100 | 10 | 10 | 50 | |

Table 4. Limits / Maximum Test Voltage for LIN Pin Transient Immunity Tests

Notes

7. V_{SUP} is applied on the VPWR pin as a test condition.

The I/V characteristic and leakage of the pin is performed before and after the test.

The supply pins and LIN must pass the V_S voltage level specified in Table 4 without damage.

The failure validation during test is evaluated at RxD.

Tests perform in Normal mode on LIN (Failure on RxD), V_{SUP} (Failure on LIN)⁽⁷⁾.

The voltage level found is for information only.

Failure criteria on RxD in Normal Mode: ± 0.9 V and $\pm 7.5~\mu s$

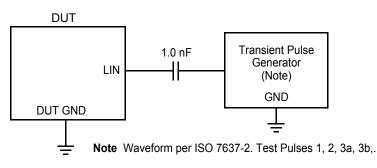


Figure 4. Test Circuit for Transient Test Pulses (LIN)



STATIC ELECTRICAL CHARACTERISTICS

Table 5. Static Electrical Characteristics

Characteristics noted under conditions 7.0 V \leq V_{SUP}⁽⁸⁾ \leq 18 V, -40 °C \leq T_A \leq 125 °C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_{A =} 25°C under nominal conditions unless otherwise noted.

| Symbol | Characteristic | Min | Тур | Max | Unit | Notes |
|----------------------------|--|-----------------------|-----------------------|-----------------------|------------------|-------|
| POWER MANAGE | MENT | | 1 | 1 | | 1 |
| V _{PWR} | Power Supply Input Voltage Normal Operation | 5.2 | - | 20 | V | |
| V _{WAKE_TH} | Wake-up Threshold Voltage Normal V _{PWR} Range | 0.3* V _{PWR} | 0.5* V _{PWR} | 0.7* V _{PWR} | V | |
| R _{WAKE} | Wake-up Input Internal Pull-down Resistance | 120 | 200 | 320 | kΩ | |
| V _{BST} | Boost Converter Output Voltage Normal V _{PWR} Range, $0 \le I_{BST} \le Max$. I_{BST} | 31.6 | 33.3 | 35 | V | |
| V _{BST_OV} | Boost Overvoltage Threshold | 36 | 38 | 40 | V | |
| V _{BST_OV_CLMP} | Boost Overvoltage Clamping Boost operating with active clamping | 40 | 43 | 46 | V | |
| V _{BST_OV_HYS} | Boost Overvoltage Hysteresis | 2.2 | 2.6 | 3.0 | V | |
| V _{BST_UV} | Low V_{PWR} as Boost Undervoltage Lockout Threshold and IGNSTAT Detect Threshold | 4.7 | 4.95 | 5.2 | V | |
| V _{BST_UV_HYS} | Boost Undervoltage Hysteresis | 0.3 | 0.5 | 0.8 | V | |
| R _{BSTSW_ON} | Boost Switch Transistor On Resistance | - | - | 550 | mΩ | |
| I _{BSTSW_LMT} | Boost Switch Current Limit | 1.3 | 1.5 | 1.8 | А | |
| T _{SW_SHDN} | Power Switch Thermal Shutdown | 155 | 175 | 195 | °C | |
| T _{SW_HYST} | Power Switch Thermal Shutdown Hysteresis | 15 | - | 30 | °C | |
| ESR _{CERM} | Energy Reserve Capacitor ESR Measurement Range | 200 | - | 600 | mΩ | |
| - | C _{ER} ESR Measurement Tolerance | -50 | - | 50 | mΩ | |
| - | C _{ER} Capacitance Measurement Tolerance | -15 | - | 15 | % | |
| R _{ERSW_CH_ON} | C _{ER} Charge Transistor On Resistance | 3.0 | 10 | 14 | Ω | |
| IERSW_CH_SHDN | C _{ER} Charge Transistor Overcurrent Shutdown Threshold | 400 | 550 | 800 | mA | |
| R _{ERSW_DISCH_ON} | C _{ER} Discharge Transistor On Resistance | 2.0 | 5.5 | 8.0 | Ω | |
| ERSW_DISCH_SHDN | C _{ER} Discharge Transistor Overcurrent Shutdown Threshold | 350 | 450 | 800 | mA | |
| I _{ERSW_LEAK} | ERSW Pin Leakage Current | - | - | 250 | nA | |
| I _{VER_LEAK} | VER Pin Leakage Current | - | - | 200 | μA | |
| V _{ER_RESD} | C _{ER} Residual Voltage after 10 s Discharge | - | - | 2.5 | V | |
| V _{BUCK} | Buck Converter Output Voltage 10 V \leq V_{BST} \leq 40 V, 100 mA \leq I_{BUCK} \leq I_{BUCK_C} | 8.73 | 9.0 | 9.27 | V | |
| VBUCK_OV_SHDN | Buck Converter Output Overvoltage Shutdown Threshold | 9.6 | 10 | 10.8 | V | |
| V _{BUCK_UV} | Low V_{BST} as Buck Converter Start-up Threshold | 13.5 | 15.5 | 17.5 | V | |
| V _{BUCK_RIPL} | Buck Converter Output Ripple Voltage $6.0 \text{ V} \le \text{V}_{PRW} \le 40 \text{ V}, 100 \text{ mA} \le \text{I}_{BUCK} \le \text{I}_{BUCK_C}$ | - | - | 460 | mV _{PP} | |

Notes

8. V_{SUP} is applied on the VPWR pin as a test condition.



Characteristics noted under conditions 7.0 V \leq V_{SUP}⁽⁸⁾ \leq 18 V, -40 °C \leq T_A \leq 125 °C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_A = 25°C under nominal conditions unless otherwise noted.

| Symbol | Characteristic | Min | Тур | Max | Unit | Notes |
|------------------------|--|-----------------------|------------|----------------------|------------------|-------|
| POWER MANAGE | MENT (CONTINUED) | | | | | 1 |
| I _{BUCK_C} | Buck Converter Output Current Capability | 400 | - | - | mA | |
| V _{BUCK_LOAD} | Buck Converter Load Regulation I_{BUCK} = 100 mA, ΔI_{BUCK} = 100 mA I_{BUCK} = 300 mA, ΔI_{BUCK} = 100 mA | | 5.0 4.0 | 8.0 6.0 | mV | |
| IBUCKSW_HS_LMT | Buck High-side Switch Current Limit | 500 | 800 | 1100 | mA | |
| V _{SYNC} | Sync Supply Output Voltage $6.0 \text{ V} \le \text{V}_{PRW} \le 40 \text{ V}$ | 15 | - | 2x V _{BUCK} | V | |
| V _{SYNC_RIPL} | Sync Supply Output Ripple Voltage $6.0 \text{ V} \le \text{V}_{PRW} \le 40 \text{ V}$ | - | - | 300 | mV _{PP} | |
| I _{SYNC_C} | Sync Supply Output Current Capability | 20 | - | - | mA | |
| I _{SYNC_OC} | Sync Switch Overcurrent Protection Limit | 65 | - | 150 | mA | |
| V _{CC} | V_{CC} Supply Output Voltage 6.0 V \leq V_{BUCK} \leq 9.5 V, 0 \leq I_{CC} \leq 200 mA | 4.85 | 5.0 | 5.15 | V | |
| - | V_{CC} Supply Line Regulation $V_{PWR\text{-}AC}$ = 200 mV_{PP,} f _{PWR\text{-}AC} \leq 500 kHz | 20 | - | - | dB | |
| - | V_{CC} Supply Load Regulation $I_{CC-DC} = 0.8^* I_{CC_MAX}, \Delta I_{CC} = 50 \text{ mA}$ | - | - | 10 | mV | |
| V _{CC_NOISE} | V _{CC} Supply Noise Voltage | - | 5.0 | 20 | mV _{PP} | |
| IVCCDRI_LMT | V _{CC} Base Driver Current Limit T _A = 25°C, Temperature coefficient = 300 ppm/ °C (typ.) | 9.0 | 13.5 | 22 | mA | |
| V _{BUCK_VCC} | Minimum V _{BUCK} Voltage for V _{CC} Operation | - | - | 6.0 | V | |
| V _{BST_VCC} | Minimum V _{BST} Voltage for V _{CC} Operation | - | - | 7.0 | V | |
| V _{DD} | V _{DD} Supply Voltage | - | 2.5 | - | V | |
| RESET AND WAT | CHDOG | | | | | |
| V _{RESET_H} | Reset Output High IRESET = -2.0 mA | V _{CC} - 0.4 | - | V _{CC} | V | |
| V _{RESET_L} | Reset Output Low IRESET = 2.0 mA | 0.0 | - | 0.4 | V | |
| V _{CC_OP} | Rising V _{CC} Threshold for Reset Operation | - | - | 1.5 | V | |
| V _{CC_OV} | V _{CC} Overvoltage for Reset | 5.2 | - | 5.5 | V | |
| V _{CC_UV} | V _{CC} Undervoltage for Reset | 4.5 | - | 4.80 | V | |
| V _{CC_VM_HYS} | V _{CC} Voltage Monitor Threshold Hysteresis | 30 | - | - | mV | |
| V _{DD_OV} | V _{DD} Overvoltage for Reset | 2.7 | - | 3.0 | V | |
| V _{DD_UV} | V _{DD} Undervoltage for Reset | 1.85 | 1.90 | 2.10 | V | |
| GNDA_GND_LIN_TH | GNDA to GND_LIN Voltage Difference to Activate Open GNDA Detection | 0.3 | - | 0.8 | V | |



Characteristics noted under conditions 7.0 V \leq V_{SUP}⁽⁸⁾ \leq 18 V, -40 °C \leq T_A \leq 125 °C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_A = 25°C under nominal conditions unless otherwise noted.

| Symbol | Characteristic | Min | Тур | Max | Unit | Notes |
|-----------------------------|---|-------------------------------|------|-------------------------------|------------------|-------|
| SATELLITE SENS | OR INTERFACE | | | | | |
| ISAT_BUS_SUP_Q | Satellite Bus Supply Quiescent Current | - | - | 2.2 | mA | |
| ISAT_BUS_SUP | Satellite Bus Supply Operation Current | - | - | 4.0 | mA | |
| ISAT_SYNC_SUP_Q | Sync Supply Quiescent Current | - | - | 1.0 | mA | |
| ISAT_SYNC_SUP | Sync Supply Operation Current | - | - | 1.0 | mA | |
| I _{SAT_VCC_Q} | Satellite Logic Supply Quiescent Current | - | - | 1.0 | mA | |
| I _{SAT_VCC} | Satellite Logic Supply Operation Current | - | - | 3.0 | mA | |
| V _{SAT_OUT} | Satellite Interface DC Output Operation Voltage $0 \le I_{SAT_OUT} \le 65 \text{ mA}$ | 5.8 | 6.3 | 6.7 | V | |
| V _{SAT_OUT_DIS} | Satellite Interface DC Output Disable Voltage I _{SAT_OUT} = 0 mA | - | _ | 0.5 | V | |
| P _{SRRSAT_BUS_SUP} | Satellite Interface Ripple Rejection from Bus Supply 50 kHz \leq f _{RIPL} \leq 280 kHz 280 kHz \leq f _{RIPL} \leq 560 kHz | 30 20 | - | - | dB | |
| V _{SAT_RIPL} | Satellite Interface Ripple Voltage due to Current Modulation (typical application configuration) | - | - | 200 | mV _{PP} | |
| V _{SAT_SYNC_ABS} | Sync Pulse Absolute Voltage | 10 | - | 12 | V | |
| V _{SAT_SYNC_STEP} | Sync Pulse Voltage Step | V _{SAT_OUT} + 4.3 | - | V _{SAT_OUT} + 5.5 | V | |
| V _{SATSYNC_L} | SATSYNC Input Low Voltage | -0.3 | - | 1.0 | V | |
| V _{SATSYNC_H} | SATSYNC Input High Voltage | 2.0 | - | V _{CC} +0.3 | V | |
| ISATSYNC_PULLDN | SATSYNC Input Pull-down Current | 10 | - | 50 | μA | |
| I _{SAT} | Satellite Interface Operational Current Range | 0.0 | - | 65 | mA | |
| ISAT_PD_LIM | Satellite Interface Pull-down Current Limit | 27 | - | 60 | mA | |
| I _{SAT_OC} | Satellite Interface Overcurrent Limit | 70 | - | 120 | mA | |
| ISAT_Q_RANGE_MIN | Minimum Satellite Quiescent Current Adaptation Level | 1.9 | - | 3.8 | mA | |
| ISAT_Q_RANGE_MAX | Maximum Satellite Quiescent Current Adaptation Level | 35 | - | 50 | mA | |
| ISAT_Q_SINGLE | Satellite Quiescent Current for Single Satellite Synchronous Satsync-steered Mode | 4.0 | - | 18.5 | mA | |
| I _{SAT_Q_DUAL} | Satellite Quiescent Current for Dual Satellite Synchronous Satsync-steered Mode | 8.0 | - | 26.5 | mA | |
| I _{SAT_Q_TOTAL} | Total Bus Quiescent Current Synchronous TDM Mode | 4.0 | - | 35 | mA | |
| - | Satellite Quiescent Current Detect Accuracy 4.0 mA = Current Threshold = 14 mA 14 mA = Current Threshold = 35 mA | -10 -6.0 | - | 10 6.0 | % | |
| I _{SAT_MOD} | Satellite Sensor Modulation Current | 20 | - | 30 | mA | |
| ISAT_TH_RANGE | Satellite Data Comparator Current Threshold Range | 15.75 | - | 48.25 | mA | |
| I _{SAT_TH_OFS} | Satellite Data Comparator Threshold Current Offset | 11.25 | 12.5 | 13.75 | mA | |
| I _{SAT_TH_HYST} | Satellite Data Detection Current Threshold Hysteresis | 2.0 | - | 3.5 | mA | |



Characteristics noted under conditions 7.0 V \leq V_{SUP}⁽⁸⁾ \leq 18 V, -40 °C \leq T_A \leq 125 °C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_{A =} 25°C under nominal conditions unless otherwise noted.

| Symbol | Characteristic | Min | Тур | Мах | Unit | Notes |
|-------------------------|---|--------------------------|----------------------|----------------------|-------------------|-------|
| SYNC PULSE LIM | ITS FOR SYNCHRONOUS TDM MODE (SEE <u>Figure 5</u> . SYNCHRONO | US TDM MO | DE SYNC PL | JLSE TIMIN | G) | |
| V _{t0} | Sync Slope Reference Voltage | - | 0.5 | - | V | |
| V _{t2} | Sync Signal Sustain Voltage | 4.3 | - | 5.5 | V | |
| DC SENSOR INTE | RFACE | | | | | |
| I _{DCREG_LMT} | DC Sensor Supply Regulator Current Limit | 30 | - | 55 | mA | |
| IDCREG_OC_DIFF | Current Difference Between the Regulator Overcurrent Detection Threshold and the Regulator Current Limit | | | | mA | (9) |
| Doneo_00_Din 1 | IDCREG_OC_DIFF = IDCREG_LMT - IDCREG_OC | 1.0 | 9.0 | 18 | | |
| V ₁ | Regulated Output Voltage 1 | 1.35 | 1.5 | 1.73 | V | |
| V ₂ | Regulated Output Voltage 2 | 2.25 | 2.5 | 2.75 | V | |
| V ₃ | Regulated Output Voltage 3 | 4.5 | 5.0 | 5.5 | V | |
| V ₄ | Regulated Output Voltage 4 | 5.85 | 6.5 | 7.15 | V | |
| - | Output Voltage Overshoot When Changing the Setting Measured as Percentage of the Voltage Step | - | - | 25 | % | |
| R _{DCREG_FBK} | Regulator Feedback Load Resistance | 100 | 200 | 300 | kΩ | |
| Th _{DCREG_SD} | Regulator Thermal Shutdown Temperature | 155 | 175 | 195 | °C | |
| Th _{DCREG_HYS} | Regulator Thermal Shutdown Hysteresis | 15 | - | 30 | °C | |
| C _{INx} | INx Load Capacitance | 12.5 | - | 220 | nF | |
| K _{CONV} | DC Sensor Interface Current to Voltage Conversion Factor (See Figure 21) I_{INx} : 2.5 mA ~ 25 mA | 0.163 | 0.177 | 0.190 | V/mA | |
| V _{CONV_NLIN} | DC Sensor Interface Current to Voltage Conversion Nonlinearity | - | - | 20 | mV _{RMS} | |
| | Current Measurement Output Offset Voltage $I_{INx} = 0, C_{INx} = 0.22 \text{ nF}, R_{INx} = 1.0 \text{ M}\Omega$ $V_1 = 1.5 \text{ V}$ | | | | | |
| V _{INx_I_OFS} | $V_1 = 1.5 V$ $V_2 = 2.5 V$ $V_3 = 5.0 V$ $V_4 = 6.5 V$ | 0.0 0.0 0.0 0.0 | 28 29 33 38 | 50 55 60 65 | mV | |
| V _{INx_OFS} | INx Pin Offset Voltage Voltage Source not Enable and I _{INx} = 0 | - | - | 1.0 | v | |
| I _{INX_PULLDN} | INx Active Pull-down Current 2.0 V \leq V _{INx} \leq 7.15 V and INx is not selected | -110 | -85 | -30 | μA | |

Notes

9. I_{DCREG_OC} is the regulator overcurrent detection threshold to trigger the regulator switch between a voltage source and a current source.



Characteristics noted under conditions 7.0 V \leq V_{SUP}⁽⁸⁾ \leq 18 V, -40 °C \leq T_A \leq 125 °C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_A = 25°C under nominal conditions unless otherwise noted.

| Symbol | Characteristic | Min | Тур | Max | Unit | Notes |
|------------------------------|--|------------------------------|------------|------------------------------|------|-------|
| ANALOG OUTPUT | | | | -11 | | |
| V _{AOUT} | Analog Output Voltage | GND | - | V _{CC} | V | |
| V _{AOUT_OFS} | Analog Buffer Offset | -20 | - | 20 | mV | |
| A | Analog Output Buffer Gain For Output Voltage Monitors For DC Sensor Interface INx Voltage Monitors | 0.99 0.48 | 1.0 0.5 | 1.01 0.52 | | |
| K ₁ | Scale Factor of Pin VBST Monitor $V_{BST} \le 35 \text{ V}$ | 8.0 | 8.5 | 9.1 | | |
| K ₂ | Scale Factor of Pin VER Monitor $V_{ER} \le 35 \text{ V}$ | 8.0 | 8.5 | 9.1 | | |
| K ₃ | Scale Factor of Pin VERDIAG Monitor | 4.5 | 5.0 | 5.5 | | |
| K ₄ | Scale Factor of Pin VBUCK Monitor $V_{BUCK} \leq 10 \text{ V}$ | 2.6 | 2.8 | 2.9 | | |
| K ₅ | Scale Factor of Pin VSYNC Monitor $V_{SYNC} \leq 20 \ V$ | 4.5 | 5.0 | 5.5 | | |
| K ₆ | Scale Factor of Pin VPWR Monitor $V_{PWR} \le 20 \text{ V}$ | 5.2 | 5.6 | 5.9 | | |
| K ₇ | Scale Factor of Pin OUTx_D Monitor | 5.2 | 5.6 | 5.9 | | |
| K ₈ | Scale Factor of Pin OUTx_S Monitor | 5.2 | 5.6 | 5.9 | | |
| ONFIGURABLE | DRIVERS | | | | | • |
| V _{OUTx_S_ON_HS} | Drain-Source On Voltage in High-side Driver Configuration V_{OUTx_D} = 18 V, I_{OUTx_S} = 70 mA | V _{OUTx_D} - 0.5 | - | V _{OUTx_D} | V | |
| V _{OUTx_D_ON_LS} | Drain-Source On Voltage in Low-side Driver Configuration V _{OUTx_S} = 0 V, I _{OUTx_D} = 70 mA | V _{OUTx_S} | - | V _{OUTx_S} + 0.5 | V | |
| I _{OUTX_S_LMT} | High-side Driver Current Limit V _{OUTx_D} = 18 V, V _{OUTx_S} = 0 V | 70 | - | 110 | mA | |
| I _{OUTx_D_LMT} | Low-side Driver Current Limit V _{OUTx_D} = 18 V, V _{OUTx_S} = 0 V | -110 | - | -70 | mA | |
| Th _{OUTx_SD} | Driver Thermal Shutdown Temperature | 155 | 175 | 195 | °C | |
| Th _{OUTx_HYS} | Driver Thermal Shutdown Hysteresis | 15 | - | 30 | °C | |
| OUTx_D_LEAK_GND | Drain Leakage to GND VRESET = 0 V, or in Sleep Mode, V _{OUTx_D} = 0 V VRESET = 5 V, V _{PWR} = 18 V, Driver Off, V _{OUTx_D} = 0 V | -1.0 45 | - | 1.0 100 | μA | |
| I _{OUTx_D_LEAK_BAT} | Drain Leakage to Battery $V_{\overline{RESET}} = 0 V, V_{OUTx_D} = V_{PWR}$ $V_{\overline{RESET}} = 5.0 V, V_{PWR} = 18 V, Driver Off, V_{OUTx_D} = 18 V$ | -1.0 -100 | - - | 1.0 -45 | μA | |
| V _{OUTx_D_OPEN} | Open Drain Voltage VRESET = 5.0 V, Driver Off | 0.4 x V _{PWR} | - | 0.6 x V _{PWR} | V | |
| IOUTX_S_LEAK_GND | Source Leakage to GND V _{RESET} = 0 V, or in Sleep Mode, V _{OUTx_S} = 0 V V _{RESET} = 5.0 V, V _{PWR} = 18 V, Driver Off, V _{OUTx_S} = 0 V | -1.0 50 | - - | 1.0 100 | μA | |



Characteristics noted under conditions 7.0 V \leq V_{SUP}⁽⁸⁾ \leq 18 V, -40 °C \leq T_A \leq 125 °C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_{A =} 25°C under nominal conditions unless otherwise noted.

| Symbol | Characteristic | Min | Тур | Max | Unit | Notes |
|------------------------------|--|-----------------------------|-----------------------------|--|------|-----------|
| CONFIGURABLE I | DRIVERS (CONTINUED) | I | | <u>ı </u> | | |
| I _{OUTX_S_LEAK_BAT} | Source Leakage to Battery V _{RESET} = 0 V, V _{OUTx_S} = V _{PWR} V _{RESET} = 5.0 V, V _{PWR} = 18 V, Driver Off, V _{OUTx_S} = 18 V | 0.0 -100 | - | 300 -50 | μA | |
| V _{OUTx_S_OPEN} | Open Source Voltage VRESET = 5.0 V, Driver Off | 0.4 x V _{PWR} | - | 0.6 x V _{PWR} | V | |
| V _{TH_2/3} | 2/3 V _{PWR} Comparator Threshold for Diagnostics 6.0 V \leq V _{PWR} \leq 18 V | 0.6 x V _{PWR} | 0.666 x V _{PWR} | 0.734 x V _{PWR} | V | |
| V _{TH_1/3} | 1/3 V_{PWR} Comparator Threshold for Diagnostics 6.0 V \leq V_{PWR} \leq 18 V | 0.266 x V _{PWR} | 0.333 x V _{PWR} | 0.4 x V _{PWR} | V | |
| D _{OUTx} | PWM Duty Cycle Fixed Frequency = 128 Hz, Increment step = 1.6% | 0.0 | - | 100 | % | |
| GENERAL LOGIC | INPUTS: CS, CS_X, SCK, SI, ASST, SCRAP, CLK | 1 | | 1 1 | | <u>_I</u> |
| V _{LGIN_H} | Logic Input High | 2.0 | - | V _{CC} + 0.3 | V | |
| V _{LGIN_L} | Logic Input Low | -0.3 | - | 1.0 | V | |
| ILGIN_PULLUP | $\begin{array}{l} \mbox{Logic Input Pull-up Current} \\ \mbox{For } \overline{CS} \colon V_{LGIN} = V_{\overline{CS}} \leq 2.0 \ V \\ \mbox{For others: } V_{LGIN} \leq 4.5 \ V \end{array}$ | 10 | - | 50 | μA | |
| I _{LGIN_LEAK} | Logic Input Leakage V _{LGIN} = V _{DD} | -2.0 | - | 5.0 | μA | |
| SPI (OTHERS) AN | D SPI MONITOR INTERFACE | | | | | _1 |
| V _{SO_L} | SO Voltage Low I _{SO} = 0.5 mA | - | - | 0.4 | V | |
| V _{SO_H} | SO Voltage High I _{SO} = -0.2 mA | V _{CC} - 0.4 | - | V _{CC} | V | |
| ANALOG SENSOR | RINPUT | | | 11 | | |
| V _{IN_ANA} | Analog Sensor Input Voltage | 0.0 | - | V _{CC} | V | |
| I _{IN_ANA} | Analog Sensor Input Pull-down Current | 2.0 | - | 8.0 | μA | |
| ARM ENABLE / DI | SABLE OUTPUTS | | | | | |
| V _{ARM_H} | ARM / DISARM Output High | V _{CC} - 0.4 | - | V _{CC} | V | |
| V _{ARM_L} | ARM / DISARM Output Low | 0.0 | - | 0.4 | V | 1 |
| I _{ARM_LEAK} | ARM / DISARM Output High-impedance Leakage | -2.0 | - | 2.0 | μA | |
| PRODUCTION PRO | OGRAM AND TEST INPUT | | | | | |
| R _{PPT_IN} | PPT Input Pull-down Resistance | 100 | 230 | 400 | kΩ | |
| V _{PPT_TEST} | PPT Input Test Mode Enable Threshold | 4.0 | 4.5 | 5.0 | V | |



Characteristics noted under conditions 7.0 V \leq V_{SUP}⁽⁸⁾ \leq 18 V, -40 °C \leq T_A \leq 125 °C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_A = 25°C under nominal conditions unless otherwise noted.

| Symbol | Characteristic | Min | Тур | Max | Unit | Notes |
|-------------------------------------|---|----------------------------|-----------------------|----------------------------|------------------|-------|
| LIN TRANSCEIVE | R LOGIC INTERFACE | I | I | | | |
| V _{RXD_OL} | RXD Output Low Level Voltage $I_{RXD_IN} \le 1.5$ mA sinking current | 0.0 | _ | 0.9 | V | |
| V _{RXD_OH} | RXD Output High Level Voltage $I_{RXD_OUT} \le 250 \ \mu A$ source current | 4.25 | _ | 5.25 | V | |
| V _{TXD_IL} | TXD Input Low Level Voltage | _ | _ | 0.8 | V | |
| V _{TXD_IH} | TXD Input High Level Voltage | 2.0 | _ | _ | V | |
| V _{TXD_IN_HYST} | TXD Input Threshold Voltage Hysteresis | 100 | 300 | 600 | mV | |
| ITXD_PULLUP | TXD Pull-up Current Source 1.0 V < V_{TXD} < 3.5 V | -60 | -35 | -20 | μΑ | |
| IN TRANSCEIVE | R PHYSICAL LAYER ^{(14),(12)} | | | | | |
| V _{BAT} | Operating Voltage Range | 8.0 | _ | 18 | V | (10) |
| V _{SUP} | Operating Supply Voltage Range | 7.0 | _ | 18 | V | |
| V _{SUP_NON_OP} | Supply Voltage Range (within which the device is not destroyed) | -0.3 | _ | 40 | V | |
| I _{BUS_LIM} | Current Limitation for Driver Dominant State Driver ON, V _{BUS} = 18 V | 40 | 90 | 200 | mA | |
| IBUS_PAS_DOM | Input Leakage Current at the Receiver Driver off; V _{BUS} = 0 V; V _{BAT} = 12 V | -1.0 | _ | _ | mA | |
| IBUS_PAS_REC | $\label{eq:linear} \begin{array}{l} \mbox{Leakage Output Current to GND} \\ \mbox{Driver Off; 8.0 V} < V_{BAT} < 18 \ V; 8.0 \ V < V_{BUS} < 18 \ V; V_{BUS} \geq V_{BAT}; \\ \ V_{BUS} \geq V_{SUP} \end{array}$ | _ | _ | 20 | μA | |
| I _{BUS_NO_GND} | Control Unit Disconnected from Ground GND _{DEVICE} = V _{SUP} ; V _{BAT} = 12 V; 0 < V _{BUS} < 18 V | -1.0 | _ | 1.0 | mA | (11) |
| I _{BUSNO_BAT} | V _{BAT} Disconnected; V _{SUP_DEVICE} = GND; 0 V < V _{BUS} < 18 V | - | - | 100 | μA | (13) |
| V _{BUSDOM} | Receiver Dominant State | _ | _ | 0.4* V _{SUP} | V | |
| V _{BUSREC} | Receiver Recessive State | 0.6* V _{SUP} | - | - | V | |
| V _{BUS_CNT} | Receiver Threshold Center (V _{TH_DOM} + V _{TH_REC})/2 | 0.475* V _{SUP} | 0.5* V _{SUP} | 0.525* V _{SUP} | V | |
| V _{HYS} | Receiver Threshold Hysteresis (V _{TH_REC} - V _{TH_DOM}) | - | - | 0.175* V _{SUP} | V | |
| V _{SERDIODE} | Voltage Drop at the Serial Diode in Pull-up Path | 0.4 | _ | 1.0 | V | |
| V _{SHIFT_BAT} | V _{BAT} SHIFT | 0.0 | - | 11.5% | V_{BAT} | |
| V _{SHIFT_GND} | GND_SHIFT | 0.0 | _ | 11.5% | V _{BAT} | |
| V _{UVL} , V _{UVH} | LIN Undervoltage Threshold (positive and negative) | 5.9 | - | 6.7 | V | |
| V _{UVHYST} | LIN Undervoltage Hysteresis (V _{UVL} - V _{UVH}) | _ | 100 | - | mV | |



Characteristics noted under conditions 7.0 V \leq V_{SUP}⁽⁸⁾ \leq 18 V, -40 °C \leq T_A \leq 125 °C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_{A =} 25°C under nominal conditions unless otherwise noted.

| Symbol | Characteristic | Min | Тур | Max | Unit | Notes | | |
|--|--|-----|-----|-----|------|-------|--|--|
| LIN TRANSCEIVER PHYSICAL LAYER (CONTINUED) (14),(12) | | | | | | | | |
| V _{BUSWU} | LIN Wake-up Threshold from Sleep Mode | - | 4.3 | 5.0 | V | | | |
| R _{SLAVE} | LIN Pull-up Resistor to V _{SUP} | 20 | 40 | 60 | kΩ | | | |

Notes

10. Voltage range at the battery level, including the reverse battery diode.

11. Loss of local ground must not affect communication in the residual network.

12. In this LIN Physical Layer EC section, use VSUP to represent VPWR and use VBUS to represent VLIN, in order to be consistent with the LIN Protocol Specification, and other Freescale LIN product specifications.

13. Node has to sustain the current that can flow under this condition. The bus must remain operational under this condition.

14. Guaranteed by design.



DYNAMIC ELECTRICAL CHARACTERISTICS

Table 6. Dynamic Electrical Characteristics

Characteristics noted under conditions 7.0 V $\leq V_{SUP}^{(15)} \leq$ 18 V, -40 °C $\leq T_A \leq$ 125 °C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at $T_A = 25$ °C under nominal conditions unless otherwise noted.

| Symbol | Characteristic | Min | Тур | Max | Unit | Notes |
|------------------------------|---|--------------------|--------------|--------------------|-------|-------|
| OWER MANAGE | MENT | | | | 1 | |
| t _{BSTSW} | Boost Switch Transistor Switching Time | 20 | 50 | 150 | ns | |
| t _{SYNCSW} | Sync Switch Transistor Switching Time | 10 | - | 250 | ns | |
| t _{VCC_RISE} | V_{CC} Voltage Rise Time From 0.1xV_{CC} to 0.9xV_{CC} | 200 | - | 1800 | μs | |
| t _{VCC_VM_REJ} | V _{CC} Voltage Monitor Deglitch Filter Time | 45 | 50 | 55 | μs | |
| t _{VCC_VM_RST} | V _{CC} Voltage Monitor Reset Time Delay | 10 | - | 15 | ms | |
| t _{WDW_MIN} | Watchdog Refresh Window Lower Limit | 275 | - | 400 | μs | |
| t _{WDW_MAX} | Watchdog Refresh Window Upper Limit | 650 | - | 900 | μs | |
| - | Reset Pin Activation Time for Watchdog Error | 0.7 | - | 1.0 | ms | |
| f _{BST/BUCK} | Boost and Buck Regulators Switch Frequency Low Speed Frequency High Speed Frequency | 133 232 | 140 245 | 147 258 | kHz | (16) |
| f _{SYNC_CP} | Sync Supply Charge Pump Switch Frequency | - | 160 | - | kHz | |
| ATELLITE SENS | OR INTERFACE PSI5 | | | | 1 | |
| f _{CLK} | Satellite Interface Input Clock Frequency Synchronous SATSYNC-steered mode Synchronous TDM mode | 3.92 3.98 | 4.00 4.00 | 4.08 4.02 | MHz | |
| f _{SAT} | Satellite bit Rate Operation Range | 118.75 | 125 | 131.25 | kHz | |
| D _{SAT_IMOD} | Satellite Sensor Current Modulation Duty Cycle Synchronous SATSYNC-steered mode Synchronous TDM mode | 45 47 | - | 55 53 | % | |
| t _{SAT_IMOD_FR} | Satellite Sensor Current Signal Rising and Falling Time From 10% to 90% of Modulation Amplitude | 0.5 | - | 1.0 | μs | |
| SR _{SAT_IMOD} | Satellite Sensor Current Signal Slew Rate | 16 | - | 48 | mA/µs | |
| t _{SAT_SYNC_FR} | Sync Pulse Rising and Falling Time | 3.0 | 4.0 | 6.0 | μs | |
| t _{SAT_IQ_FLT} | Satellite Quiescent Current Sampling Filter Time Constant | - | 60 | - | μs | |
| t _{SAT_IQ_DET} | Satellite Quiescent Current Out of Range Detection Time | 3/f _{CLK} | - | 4/f _{CLK} | μs | |
| t _{SAT_OC_DET} | Satellite Current Overcurrent Detection Time | - | 512 | - | μs | |
| tSAT_OC_SDDEL | Satellite Interface Overcurrent Shutdown Delay t _{SATSYNC_PER} = 500 µs, t _{SAT_OC_DET} = 512 µs | 3.5 | - | 4.0 | ms | |
| $t_{SAT_TH_DEL_{\Delta}}$ | Satellite Data Detection Delay Difference Between Rising Edge and Falling Edge | - | - | 250 | ns | |
| t _{SAT_IQ_INIT_DEL} | Initial Satellite Quiescent Current Measurement Delay | - | 10 | - | ms | |
| t _{sat iq} init dur | Initial Satellite Quiescent Current Measurement Duration | - | 35 | - | ms | |

Notes

15. V_{SUP} is applied on the VPWR pin as a test condition.

16. The switching frequency used for the Boost and Buck supplies is selectable via the SPI with a LIN_CONFIG command at either a low-speed or high-speed switching mode.



Characteristics noted under conditions 7.0 V $\leq V_{SUP}^{(15)} \leq$ 18 V, -40 °C $\leq T_A \leq$ 125 °C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at $T_A = 25^{\circ}$ C under nominal conditions unless otherwise noted.

| Symbol | Characteristic | Min | Тур | Мах | Unit | Notes | | | |
|---|--|-----|-----|-----|------|-------|--|--|--|
| SATELLITE SENSOR INTERFACE PSI5 (CONTINUED) | | | | | | | | | |
| t _{SAT_IQ_DEL} | Satellite Quiescent Current Measurement Delay | - | 5.0 | - | μs | | | | |
| t _{SAT_IQ_DUR} | Satellite Quiescent Current Measurement Duration | - | 3.0 | - | μs | | | | |
| t _{SAT_IQ_DEL_NA} | Satellite Quiescent Current Measurement Delay with No Bus Activity | - | 120 | - | μs | | | | |
| SYNC PULSE LIMITS FOR SYNCHRONOUS TDM MODE (SEE Figure 5. Synchronous TDM Mode Sync Pulse Timing) | | | | | | | | | |
| + | Reference Time Base | | 0.0 | | 110 | | | | |

| | ι ₀ | | - | 0.0 | - | μs | |
|---|--------------------------|---|------|------|-----|------|--|
| F | t ₁ | Sync Signal Earliest Start | - | -3.0 | - | μs | |
| | t ₂ | Sync Signal Sustain Start | 0 | 7.0 | - | μs | |
| | - | Sync Rising Slope Slew Rate | 0.43 | - | 1.5 | V/µs | |
| | - | Sync Falling Slope Slew Rate | -1.5 | - | - | V/µs | |
| | t ₃ | Sync Signal Sustain Time | - | 16 | - | μs | |
| | t ₄ | Sync Discharge Time Limit | - | 35 | - | μs | |
| | t _{SLOT1_START} | Start of First Sensor Data Word (Remaining discharge current < 2.0 mA) | 44 | - | - | μs | |

SATELLITE TIMING LIMITS FOR SYNCHRONOUS TDM MODE (SEE Figure 6, Synchronous TDM Mode Satellite Interface Timing)

| t _{SYNC} | Sync Pulse Period | 495 | 500 | 505 | μs | |
|----------------------------|---|------|-------|-----|----|--|
| t _{SATSYNC_WIDTH} | Satsync Input Pulse Width | 40 | - | - | μs | |
| t _{SLOT1_START} | Slot1 Start Time (relative to t_0) | - | 44 | - | μs | |
| t _{SLOT2_START} | Slot2Start Time (relative to t ₀) | - | 181.3 | - | μs | |
| t _{SLOT3_START} | Slot3 Start Time (relative to t_0) | - | 328.9 | - | μs | |
| t _{SLOT3_END} | Slot3 End Time (relative to t ₀) | - | 492 | - | μs | |
| t _{EMC} | Timing Variation Margin | -2.1 | - | 2.1 | μs | |

SATELLITE TIMING LIMITS FOR SYNCHRONOUS SATSYNC-STEERED MODE (SEE Figure 7. Synchronous Satsync-Steered Mode Satellite Interface Timing)

| t _{SAT_ACT} | PSI5_x Activation Time from Rising Edge of Chip Select (1) | 1.0 | - | 10 | μs | |
|-----------------------------|--|-------|-----|----------|----|--|
| t _{SATSYNC_PER} | Satsync Period (2) | 167 | - | ∞ | μs | |
| t _{SATSYNC_PH1} | Satsync Phase 1 Time (3) | - | 200 | - | μs | |
| t _{SATSYNC_PH0} | Satsync Phase 0 Time (4) | - | 170 | - | μs | |
| tSATSYNC_S_DEL | Satsync Sampling Delay Time (5) (1/ F _{SAT_CLK} to 3/ F _{SAT_CLK}) | 250 | - | 750 | ns | |
| tSAT_SYNC_WIDTH | Sync Pulse Width (6) | - | 32 | 34 | μs | |
| t _{SAT_STAGGER} | Channel Stagger Time (7) (16/ F _{SAT_CLK}) | - | 4.0 | - | μs | |
| SAT_SYNC_GEN_DEL | SYNC Pulse Generation Delay (8) | - | - | 2.5 | μs | |
| t _{SAT_SYNC_BLANK} | Sync Blanking Time (Decoder disabled) (9) | - | 69 | - | μs | |
| tSAT_PHASE_BLANK | Phase Transition Blanking Time (Manchester Decoder disabled) (10) | - | 10 | - | μs | |
| t _{SAT_MSG} | Message Time (11) | 81.48 | - | 156.5 | μs | |
| | | | | | | |



Characteristics noted under conditions 7.0 V $\leq V_{SUP}^{(15)} \leq$ 18 V, -40 °C $\leq T_A \leq$ 125 °C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at $T_A = 25$ °C under nominal conditions unless otherwise noted.

| Symbol | Characteristic | Min | Тур | Мах | Unit | Notes | | | | |
|------------------------|---|------|-----|----------|------|-------|--|--|--|--|
| DC SENSOR INTE | C SENSOR INTERFACE AND ANALOG OUTPUT | | | | | | | | | |
| t _{MEAS} | DC Sensor Measurement Duration | 0.5 | - | 2.0 | ms | | | | | |
| t _{DCREG_SET} | Supply Regulator Setting Time $V_{INx} = 90\% x V4 = 90\% x 6.5 V,$ $I_{Inx} = 20 \text{ mA}, C_{Inx} = 10 \text{ nF}$ | - | - | 70 | μs | | | | | |
| dV _{Inx} /dt | Regulator Output Switch Slew Rate | 0.08 | 5.0 | 7.0 | V/µs | | | | | |
| t _{AOUT_SETL} | Analog Output Settling Time $C_L = 0.22 \text{ nF}, R_L = 1.0 \text{ M}\Omega$ $A_{OUT} = 90\%$ final value $A_{OUT} = 99\%$ final value | - | - | 40 70 | μs | | | | | |

CONFIGURABLE DRIVERS

| dV _{OUTx} /dt | Driver Output Switching Slew Rate Control 6.0 V < V _{OUTx} <18 V, R _{LOAD} = 273 Ω, C _{LOAD} = 100 nF | 135 | 190 | 210 | mV/µs | |
|--------------------------|---|-----|-----|-----|-------|--|
| t _{LATCH_DELAY} | Delay for Comparator Latch (992/F _{CLK}) | - | 248 | - | μs | |

SPI AND SPI MONITOR INTERFACE (SEE Figure 8. SPI TIMING, WITH AN EXTERNAL PULL-UP OF 47 kΩ OR 110 MA ON DO)

| f _{SCK} | SCK Frequency | - | - | 8.08 | MHz | |
|----------------------|------------------------------------|------------------------------|---|------|-----|--|
| ^t scк_н | SCK High Time (A) | 1/2 t _{SCK} - 13 | - | - | ns | |
| t _{SCK_L} | SCK High Time (B) | 1/2 t _{SCK} - 13 | - | - | ns | |
| t _{scк} | SCK Period (C) | 123.7 | - | - | ns | |
| t _{FALL} | SCK Falling Time (D) | 5.5 | - | 13 | ns | |
| t _{RISE} | SCK Rising Time (E) | 5.5 | - | 13 | ns | |
| t _{SET} | SI Setup Time (F) | 37 | - | - | ns | |
| t _{HOLD} | SI Hold Time (G) | 49 | - | - | ns | |
| t _{ACC} | SO Access Time (H) | - | - | 43 | ns | |
| t _{VALID} | SO Valid Time after SCK (I) | - | - | 30 | ns | |
| t _{LAG} | SO Lag Time (J) | 0.0 | - | - | ns | |
| t _{DISABLE} | SO Disable Time (K) | - | - | 750 | ns | |
| t _{CS_LEAD} | CS Lead Time (L) | 1/2 t _{SCK} | - | - | ns | |
| t cs _lag | CS Lag Time (M) | 1/2 t _{SCK} | - | - | ns | |
| t _{TD} | Sequential Data Transfer Delay (N) | 3/ F _{CLK} | - | - | μs | |

ADDITIONAL COMMUNICATION LINE (ACL) INPUT FOR SCRAP

| t _{KEY_TOUT} | Scrap KEY Timeout | - | - | 600 | μs | |
|-----------------------|---------------------|-----|-----|-----|----|--|
| t _{ACL} | ACL Period | 180 | 200 | 220 | ms | |
| t _{ACL_H} | ACL Pulse High Time | 126 | 140 | 154 | ms | |
| t _{ACL_L} | ACL Pulse Low Time | 54 | 60 | 66 | ms | |



Characteristics noted under conditions 7.0 V $\leq V_{SUP}^{(15)} \leq 18$ V, -40 °C $\leq T_A \leq 125$ °C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at $T_A = 25$ °C under nominal conditions unless otherwise noted.

| Symbol | Characteristic | Min | Тур | Max | Unit | Notes | |
|--------|----------------|-----|-----|-----|------|-------|--|
|--------|----------------|-----|-----|-----|------|-------|--|

LIN PHYSICAL LAYER: DRIVER CHARACTERISTICS FOR NORMAL SLEW RATE - 20.0 KBIT/SEC ACCORDING TO THE LIN PHYSICAL LAYER SPECIFICATION^{(17), (18)}

| D1 | | 39.6 | _ | _ | % | |
|----|---|------|---|------|---|--|
| D2 | $ \begin{array}{l} \mbox{Duty Cycle 2:} \\ TH_{REC(MIN)} = 0.422 * V_{SUP} \\ TH_{DOM(MIN)} = 0.284 * V_{SUP} \\ D2 = t_{BUS_REC(MAX)} / (2 \ x \ t_{BIT}), \ t_{BIT} = 50 \ \mu s, \ 7.6 \ V \leq V_{SUP} \leq 18 \ V \end{array} $ | _ | _ | 58.1 | % | |

LIN PHYSICAL LAYER: DRIVER CHARACTERISTICS FOR SLOW SLEW RATE - 10.4 KBIT/SEC ACCORDING TO LIN PHYSICAL LAYER SPECIFICATION^{(17), (19)}

| D3 | $ Duty Cycle 3: \\ TH_{REC(MAX)} = 0.778 * V_{SUP} \\ TH_{DOM(MAX)} = 0.616 * V_{SUP} \\ D3 = t_{BUS_REC(MIN)}/(2 \text{ x } t_{BIT}), t_{BIT} = 96 \ \mu\text{s}, 7.0 \ \text{V} \leq \text{V}_{SUP} \leq 18 \ \text{V} $ | 41.7 | _ | _ | % | |
|----|---|------|---|----|---|--|
| D4 | $ \begin{array}{l} \text{Duty Cycle 4:} \\ & \text{TH}_{\text{REC}(\text{MIN})} = 0.389 \ ^{*}\text{V}_{\text{SUP}} \\ & \text{TH}_{\text{DOM}(\text{MIN})} = 0.251 \ ^{*}\text{V}_{\text{SUP}} \\ & \text{D4} = t_{\text{BUS}_{\text{REC}}(\text{MAX})'(2 \ x \ t_{\text{BIT}}), \ t_{\text{BIT}} = 96 \ \mu\text{s}, \ 7.6 \ \text{V} \leq \text{V}_{\text{SUP}} \leq 18 \ \text{V} \end{array} $ | _ | _ | 59 | % | |

LIN PHYSICAL LAYER: RECEIVER CHARACTERISTICS (20)

| t _{REC_PD} t _{REC_SYM} | Propagation Delay and Symmetry Propagation Delay of Receiver, t _{REC_PD} = MAX (t _{REC_PDR} , t _{REC_PDF}) Symmetry of Receiver Propagation Delay, t _{REC_PDF} - t _{REC_PDR} | -2.0 | | 6.0 2.0 | μs | (21) | |
|---|---|------|--|------------|----|------|--|
|---|---|------|--|------------|----|------|--|

TXD TIMING

| t _{TXDDOM} | TXD Permanent Dominant State Delay | 3.75 | 5.0 | 6.25 | ms | (22) |
|-------------------------|--|------|-----|------|----|------|
| t _{LIN_1STDOM} | First Dominant bit Delay The transmitter delay before sending the first dominant bit, after the transceiver is activated | | 50 | 80 | μs | (23) |

Notes

17. Bus load R_{BUS} and C_{BUS} 1.0 nF / 1.0 kΩ, 6.8 nF / 660 Ω, 10 nF / 500 Ω. Measurement thresholds: 50% of TXD signal to LIN signal threshold defined at each parameter. See Figure 9. In Figure 9, use VSUP to represent the VPWR pin, and use GND to represent both the GND and GND_LIN VLIN pins, in order to be consistent with LIN Protocol Specification, and other Freescale LIN product specifications.

18. See <u>Figure 10</u>.

19. See Figure 11.

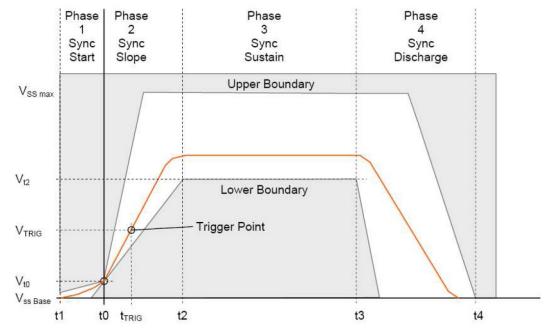
20. V_{SUP} from 7.0 to 18 V, bus load R_{BUS} and C_{BUS} 1.0 nF / 1.0 kΩ, 6.8 nF / 660 Ω, 10 nF / 500 Ω. Measurement thresholds: 50% of TXD signal to LIN signal threshold defined at each parameter. See Figure 9.

21. See Figure 12.

- 22. The LIN is in Recessive state and the receiver is still active.
- 23. The First Dominant bit delay normally has no impact to LIN communication, but may need additional care on the software for ISO 9141 (K-line) communication initialization.



TIMING DIAGRAMS





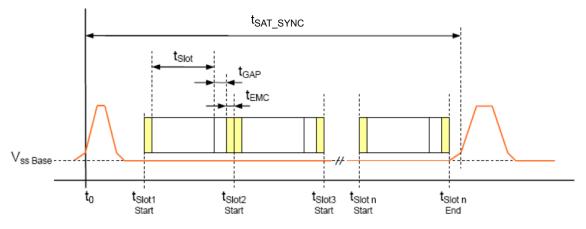


Figure 6. Synchronous TDM Mode Satellite Interface Timing



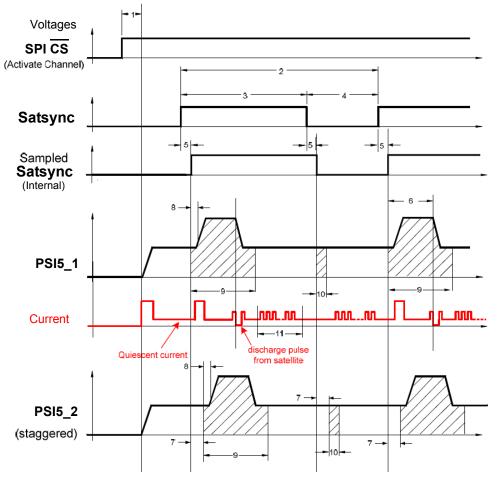


Figure 7. Synchronous Satsync-Steered Mode Satellite Interface Timing

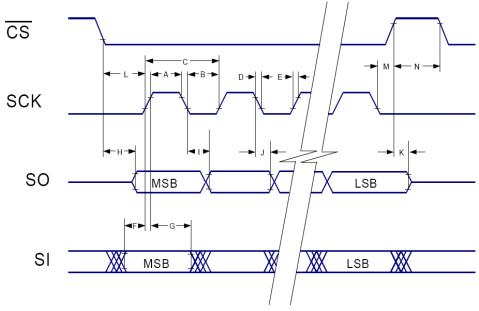
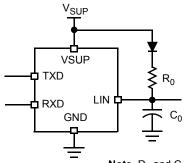


Figure 8. SPI Timing

33789





Note R_0 and C_0 : 1.0 k Ω /1.0 nF, 660 Ω /6.8 nF, and 500 Ω /10 nF.

Figure 9. Test Circuit for Timing Measurements

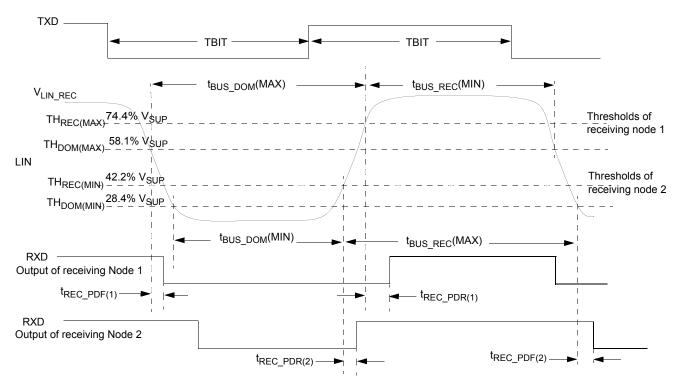


Figure 10. LIN Timing Measurements for Normal Baud Rate



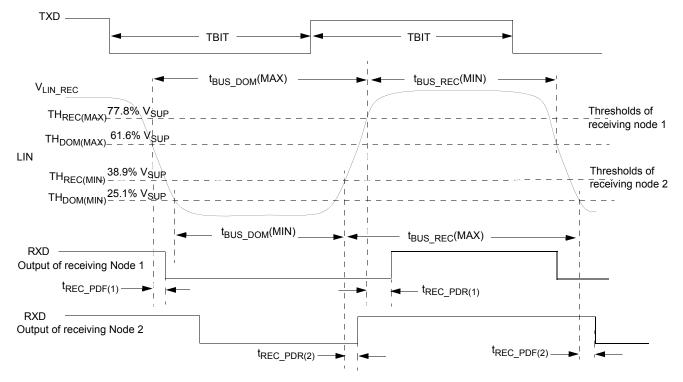


Figure 11. LIN Timing Measurements for Slow Baud Rate

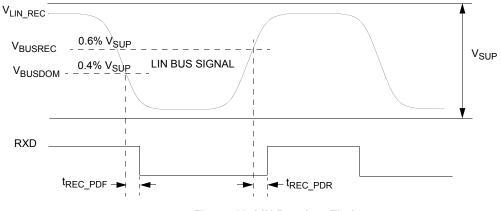


Figure 12. LIN Receiver Timing



FUNCTIONAL DESCRIPTION

INTRODUCTION

The 33789 provides an integrated solution for multiple basic functions in an air bag control module.

As a system basis chip, the 33789 supplies different voltages to a complete airbag system with centralized power management. It controls the wake-up and power down of the system through the Power Mode Control function. It runs the Watchdog State Machine to respond to the MCU refresh and controls all of internal and external resets. It operates in Safing mode to prevent inadvertent deployment of the airbags, and thereby secure the occupants safety. It also operates in Scrap mode, to allow for the disposal of the unused pyrotechnic devices (squibs) at the end of vehicle life. For different voltage applications, it uses internal switches to boost battery voltage up to 33 V to supply external squib drivers and to charge the energy reserve. It then combines internal buck switches and the charge pump to create bus and sync supplies for satellite sensors, and uses an external bipolar transistor to supply V_{CC} for all on-board IC cores.

Safing is another key function of the 33789. There are four SPI5 satellite sensor interfaces, nine DC sensor inputs, and one highly accurate analog input, equipped on the 33789 for the airbag system acquiring different types of safing data. The SPI Monitor in the safing block monitors on-board sensor data and satellite sensor data read by the MCU via the SPI. The on-chip safing logic compares all of the sensor data to the configurable thresholds, and thereby determines whether a <u>safety event</u> (collision) is happening. Whenever a collision is detected, an arm control will be created in which complementary ARM and DISARM logic outputs are activated.

The 33789 can output two PWM signals with high-side/low-side configurable drivers, which can be used to drive alert indicators. The 33789 outputs a multiplexed analog signal to the MCU for diagnostics on all DC sensors, power supplies, and configurable driver outputs.

A LIN / ISO-9141 physical layer interface can be used to communicate with either LIN based Occupant Classification Systems or vehicle diagnostics. Its communication mode can be selected by the MCU through the SPI.

FUNCTIONAL PIN DESCRIPTION

POWER SUPPLY INPUT (VPWR)

VPWR is the system power supply input. It takes a protected 12 V vehicle battery input, which should be protected for load dump and reverse battery. Additional filtering is preferred for better EMC performance.

WAKE-UP INPUT (WAKE)

WAKE is a battery voltage, active high logic input. When activated, it brings the system out of sleep mode by starting the boost and buck converters.

Internally, the WAKE input is implemented with a 200 kΩ pull-down resistance and a 1.0 ms glitch filter.

BOOST SWITCH OUTPUT (BSTSW)

BSTSW is an internal low-side switch output. When the switch is turned on, its voltage will be pulled down close to GND (V_{BSTGND}), thus increasing the current in the boost inductor. When the switch is turned off, the un-interrupted current will charge the boost capacitor.

BOOST SUPPLY INPUT (VBST)

The VBST pin is externally connected to the boost capacitor. It inputs V_{BST} as a regulated higher voltage supply, and distributes it internally for all sub-system applications.

BOOST COMPENSATION CONNECTION (BSTCOMPX)

The two boost compensation pins are used for connecting an external RC filter in the boost converter feedback loop.

ENERGY RESERVE SWITCH OUTPUT (ERSW)

ERSW is an energy reserve control output. It is connected to a charge/discharge switch pair. When the energy reserve voltage across the energy reserve capacitor C_{ER} is lower than the target value, the internal charge switch will be turned on to provide source current from the boost supply to charge C_{ER} . A short discharge pulse can be used for measuring C_{ER} capacitance and ESR.

ENERGY RESERVE MONITOR (VER)

VER is a voltage input for the system, to monitor the voltage across C_{ER}, to maintain enough energy storage.

ENERGY RESERVE DIAGNOSTIC INPUT (VERDIAG)

VER and VERDIAG both monitor the voltage across C_{ER} . However, VERDIAG only takes AC samples coupled by an external capacitor. The VERDIAG sample will be processed with 10-bit ADC and sent to the MCU for C_{ER} diagnostics.

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BUCK SWITCH OUTPUT (BUCKSW)

BUCKSW is a synchronous half-bridge switch output for the buck converter, to create V_{BUCK} on C_{BUCK} . When V_{BUCK} is below the target threshold, the high-side switch is turned on to charge C_{BUCK} , sourcing current from the internal V_{BST} connection. Once V_{BUCK} has reached the threshold, the high-side switch is turned off and the low-side driver is turned on for the current circulation.

BUCK SUPPLY INPUT (VBUCK, VBUCK_R)

The 33789 uses two pins to input V_{BUCK}. VBUCK provides supply source for the Sync charge pump and other internal applications, while VBUCK_R shares all applications except Sync.

BUCK COMPENSATION CONNECTION (BUCKCOMPX)

The two buck compensation pins are used for connecting an external RC filter in the buck converter feedback loop.

CHARGE PUMP CAPACITOR CONNECTION (CPCX)

A charge pump capacitor is connected between CPC1 and CPC2.

SYNC SUPPLY CONNECTION (VSYNC)

The internal charge pump outputs current to charge C_{SYNC} , which is externally connected on this pin, to achieve V_{SYNC} . The satellite sensor interface block sources V_{SYNC} to create sync pulse internally.

DEDICATED GROUND CONNECTIONS FOR SWITCHING POWER SUPPLIES (BSTGND, BUCKGND, CPGND)

There are three dedicated ground connection pins designed for the boost converter, buck converter, and charge pump ground returns respectively, to shorten their own current loops for the best EMC performance. Eventually, all of ground pins, including GNDA, VSS, GND_LIN, and GND_PSI, must be connected together and terminated on the circuit board ground.

ANALOG GROUND (GNDA)

The ground return terminal or ground source pin for analog circuits.

DIGITAL GROUND (VSS)

The ground return terminal or ground source pin for logic circuits.

5.0 V V_{CC} TRANSISTOR BASE DRIVER OUTPUT (VCCDRI)

The VCCDRI pin is an internal driver output to control the base pin of an external PNP transistor to regulate 5.0 V V_{CC}.

5.0 V V_{CC} INPUT (VCC)

The VCC pin is used to input 5.0 V V_{CC}, which supplies the internal analog circuit and provides feedback for the linear regulator.

2.5 V V_{DD} CONNECTION (VDD)

 $2.5 \text{ V} \text{ V}_{\text{DD}}$ is converted from VPWR and VBUCK, to supply internal logic circuits. The VDD pin is the connection point between the internal VDD regulator driver and its external load capacitor.

RESET (RESET)

The RESET pin is the reset driver output to issue global resets to other system ICs.

PRODUCTION PROGRAMMING AND TEST (PPT)

The PPT pin is an active high enable input. It will be only used by manufacturers to program and test the circuit during production. It should not be connected to any application circuit externally. The PPT pin should be grounded to secure airbag system operation.

LIN INTERFACE (LIN)

The LIN pin is a LIN 2.1 compatible physical layer interface to communicate with devices or diagnostic systems external to the airbag ECU.

LIN GROUND (GND_LIN)

The dedicated ground for LIN (or K-line) interface.



UART CONNECTION (TXD, RXD)

The 33789 uses TXD and RXD ports to receive and transmit 5.0 V logic level LIN bus data through the MCU UART interface.

DC SENSOR INPUTS (INX)

There are nine switch mode analog inputs, IN1 through IN9, on the 33789 to monitor the switch mode sensor status of up to 9 independent DC type sensors. The sensors can be Hall-effect sensors, resistive sensors, on/off switches, or any other regular analog sensors. The 33789 supplies one of four selectable bias voltages for each channel, multiplexes the sensor inputs, and outputs them in serial to the MCU through the AOUT pin.

ANALOG DIAGNOSTIC OUTPUT (AOUT)

The AOUT pin outputs multiple scanned, rescaled, and buffered analog signals to the MCU. With the AOUT signal, the MCU can read DC sensor status, and conduct diagnostics on DC sensors, configurable driver outputs, and all power supplies.

CONFIGURABLE DRIVER OUTPUTS (OUTX_D, OUTX_S)

The 33789 provides two general purpose low current drivers. Each one can be independently configured as either a high-side or a low-side driver by a SPI command. Both the drain and the source terminals of each driver have dedicated pins for external connections.

SATELLITE SENSOR INTERFACES (PSI5_X)

The four satellite sensor interface pins, PSI5_1 through PSI5_4, provide four PSI5 V 1.3 physical connections. All four channels can be enabled or disabled via SPI commands. Each channel can be used to connect up to three satellite sensors in PSI5-P10P-500/3L Synchronous TDM mode, or up to two satellite sensors in Synchronous Satsync-steered mode. The MCU can retrieve the current-modulated sensor data and query the channel status via the SPI.

SYNC-PULSE ACTIVATION SIGNAL INPUT (SATSYNC)

The MCU provides a periodic Satsync signal to the 33789 at the SATSYNC pin to activate higher voltage sync pulse generation, The 33789 adds the sync pulses on each satellite channel in sequence, to synchronize the satellite data sampling.

SATELLITE SENSOR INTERFACE CLOCK INPUT (CLK)

The PSI5 interface block receives a 4.0 MHz clock input from the MCU at the CLK pin, and uses it for satellite sensor signal decoding and synchronizing other internal logic processing.

SATELLITE GROUND (GND_PSI)

GND_PSI is a dedicated common ground connection point for all PSI5 satellite sensor channels.

SERIAL PERIPHERAL INTERFACE (SPI) DATA INPUT (SI)

Since the 33789 is configured as a slave device connected on the Master Out Slave In (SI) line of SPI bus, the SI pin is implemented as an SPI data serial input pin.

SPI DATA OUTPUT (SO)

SO is a Slave Data Output pin for the 33789 to send serial data out via the SPI bus.

SPI CLOCK (SCK)

The 33789 uses the SCK pin to receive the SPI clock signal from the MCU. The SPI clock is used to synchronize the data transaction and the logic processing at the SPI interface block.

SPI CHIP SELECTS (CS)

The MCU selects to communicate with the 33789 by pulling \overline{CS} pin to ground. Once the data transaction is completed, the voltage level on the \overline{CS} pin will return high.



CHIP SELECTS FOR SPI MONITOR (CS_X)

When the MCU sends a "sensor request" over the SPI interface, the 33789 SPI Monitor listens to the sensor response and extracts valid sensor data from up to four sources using additional chip select signals on CS x:

- CS: dedicated for satellite sensors
- CS_A: Intended for an on-board accelerometer
- CS_B: Intended for an on-board accelerometer or an expansion satellite receiver
- CS_C: Intended for an expansion satellite receiver

ANALOG SENSOR INPUT (A_SENSOR)

There is one analog safing sensor input on the 33789. The analog signal input from the A_SENSOR pin is processed by a 10-bit ADC and digital filters. The 10-bit sensor data result will be stored in a holding register for the SPI reading.

ANALOG SENSOR SELF-TEST (ASST)

The MCU can run a self-test on the on-board analog sensor without triggering Arming. The MCU would need to issue a disable signal to the safing block to ignore the analog sensor data during its self-test period. The ASST pin on the 33789 is the digital input to receive this disable signal. Once the ASST pin is pulled high by the MCU, the internal digit filter will not process the analog sensor data, and the analog sensor register will not be loaded for comparison.

ARM OUTPUT (ARM, DISARM)

The 33789 uses a pair of digit output pins, ARM and DISARM, with opposite logic, for the Arming output. They can be directly used by squib drivers as a squib firing enable and/or disable inputs.

Both the ARM and DISARM pins are set to high-impedance under the following conditions:

- During resets
- Arm Lockout
- · While the Safing State Machine is in Start-up mode

SCRAP CONTROL (SCRAP)

The SCRAP pin on the 33789, is also called ACL input, for an Additional Communication Line, per the ISO-26021 standard. It is a digital signal input to receive the ACL signal from either the MCU or an external device. The ACL signal will be used by the 33789 to determine if it should stay in, or enter into Scrap mode from Arming mode during its scrap handshaking with the MCU.



FUNCTIONAL INTERNAL BLOCK DESCRIPTION

| | | Power Ma | nagement | | | | |
|---------------------------------|-------------------------|------------------------------|------------------------------|----------------------------|--|--|--|
| Power Mode Control | Boost Converter | Energy Reserve Control | Buck Converter | Sync Supply Charge Pump | 5V Linear Regulator 2.5V Linear Regulator | | |
| | | Watc | hdog | | | | |
| | | | | | | | |
| Satellite Sensor Interface PSI5 | | | | | | | |
| Quiescent Current Monitor | Manchester Decoder | PSI5 Clock | Mode Control | Sync Pulse Gernerator | Protection & Diagnostics | | |
| | | | | | | | |
| | | - | l I/Os | | | | |
| DC Sens | or Inputs | Analog Se | nsor Input | ostics Output | | | |
| Selectable Bias Supplies | Analog MUX | ADC | Digital Filter | Analog MUX | Analog Buffer Amplifier | | |
| | | | | | | | |
| C | ommunicatior | ıs | Cor | figurable Driv | vers | | |
| SPI | ACL | LIN / K-Line | HSD/LSD Config. | PWM | Protection & Diagnostics | | |
| | | | | | | | |
| | | Saf | ing | | | | |
| SPI Monitor & Decoder | Safing state Machine | Safing Control Counters | Safing Threshold Logic | Safing Compare Logic | Arm Enable Outputs | | |
| | | | | | | | |

MC33789 Function Block Diagram



BOOST CONVERTER

The boost converter uses an internal power switch combined with external passive components, to create a 33 V boost supply from the 12 V battery input. The 33 V boost output is used for:

- Charging energy reserve capacitor
- · Firing squibs when a safing is detected and the battery input is still available
- · Power source for all other lower voltage supplies

The boost switch is activated by a wake-up signal, and its operation is controlled by the MCU through the SPI command.

ENERGY RESERVE CONTROL

The energy reserve is a power backup for the air bag system. When a vehicle accident happens and the battery supply is lost, the energy reserve can provide sufficient power to support the system to continuously collect sensor information, process safing messages, and fire squibs, for a time determined by the capacity of the energy reserve.

To secure the energy reserve function, the 33789 has implemented sophisticated controls:

- Monitoring V_{BST} and V_{ER} to determining when the energy reserve capacitor C_{ER} needs to be charged.
- Controlling the turn on time of the high-side charge switch, to keep V_{ER} close to V_{BST}, and limiting the inrush charge current.
- Executing a MCU command to diagnose C_{ER} by momentarily turning on the low-side discharge switch (while turning off the highside charge switch), and accurately measuring the V_{ER} changes.



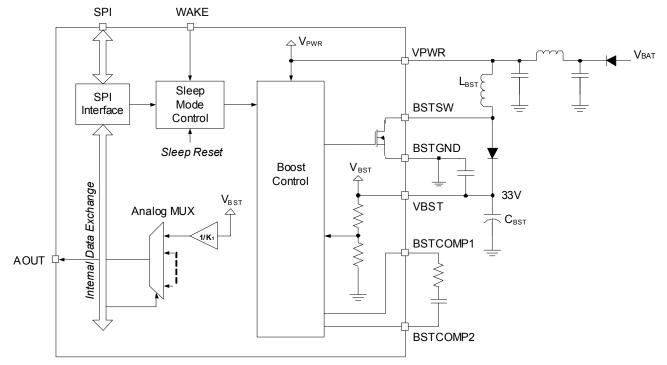


Figure 14. Boost Converter Block Diagram

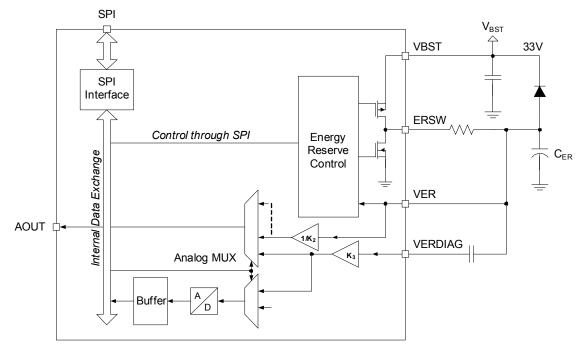


Figure 15. Energy Reserve Control Block Diagram



BUCK CONVERTER

The buck converter creates a step-down intermediate supply voltage, $V_{BUCK} \approx 9.0$ V, from the 33 V V_{BST}. It uses a synchronous buck structure, and controls the internal power switches running at 140 kHz, the same frequency as for the boost switch. The switches are fully protected against overvoltage, overcurrent and overtemperature.

The buck converter operation is under control of the power mode signal and SPI commands from the MCU. The buck converter status can be read via the SPI, and its output voltage, V_{BUCK}, can be monitored via AOUT by the MCU.

The 33789 provides redundant pins to input V_{BUCK} for the voltage regulation and further power conversions.

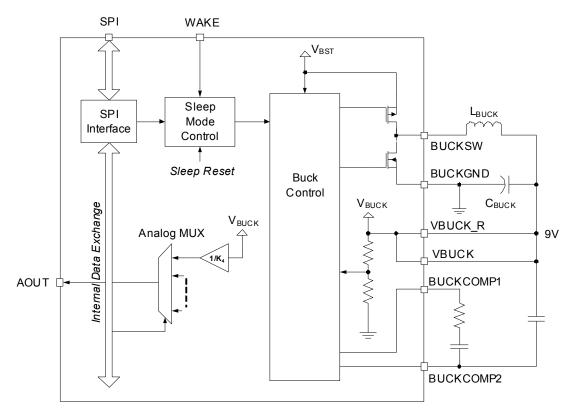


Figure 16. Buck Converter Block Diagram

SYNC SUPPLY FOR PSI5 INTERFACE

To create a regulated sync pulse supply with a voltage at least 5.0 V above the bus voltage for the PSI5 satellite sensor interface, the 33789 uses a charge pump to "double" V_{BUCK}. The charge pump switches are operated at 160 kHz, with output current limitation. The MCU enables the sync supply and monitors V_{SYNC} via the AOUT for diagnostics.

LINEAR REGULATORS

The 33789 drives an external PNP transistor to provide a 5.0 V V_{CC} output. This design can reduce the IC power dissipation and offers the ECU designer system design flexibility.

As the prime core power supply, V_{CC} can be shared by the 33789 with other on-board ICs.

The 2.5 V V_{DD} used for the 33789 internal circuitry is created by an internal linear regulator, using V_{PWR} (for start-up) and V_{BUCK}. It utilizes an external capacitor through the VDD pin.



WATCHDOG AND RESET

The Watchdog State Machine monitors the system clock by reading refresh messages from the MCU via the SPI, and applies state control and power mode control accordingly.

The MCU periodically sends watchdog refresh messages within the watchdog time window. If the refresh to the window watchdog has failed, a system reset will be issued. The RESET pin will be pulled low to drive external reset.

The reset control is also linked to the V_{CC} monitor and the V_{DD} monitor to ensure their output voltages are within the defined tolerances.

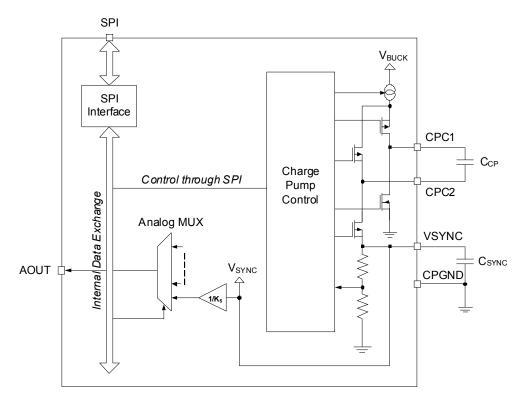


Figure 17. Sync Supply Block Diagram



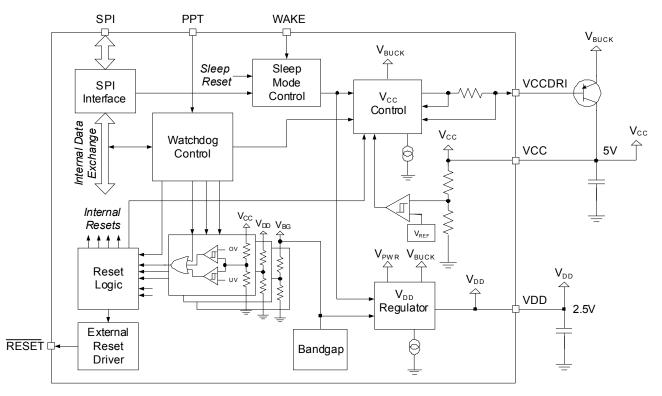


Figure 18. Linear Regulators and Watchdog Block Diagram

SATELLITE SENSOR INTERFACE PSI5

The 33789 provides four satellite sensor interface channels to collect data from up to 12 remote satellite sensors. The physical link is a two-wire pair.

The satellite sensor interface implements the P10P-500/3L mode, as defined in the PSI5 technical specification V1.3 protocol. It also supports 10-bit Synchronous Satsync-Steered mode operation. The interface receives data in synchronous mode only. In addition, a method is provided to allow implementation of the bi-directional communication feature, also defined in PSI5 V1.3, under software control.

All four satellite channels can be independently enabled or disabled via SPI commands. The selection of communication mode and the status acquisition are also controlled by the MCU via the SPI.

The physical layer of the PSI5 interface supplies continuous power and synchronization pulses, created from V_{BUCK} and V_{SYNC} respectively, to the remote satellite sensors. It senses the satellite current draw to receive the Manchester-encoded current modulation signals from the sensors. The interface converts the Satsync signal from the MCU to synchronize the sensor data transmission, and uses the CLK signal from the MCU as a time base for the Manchester decoding.

Each satellite channel has three registers to store decoded messages from up to three satellite sensors. The messages are accessible to the MCU over the SPI. Each channel's fault condition is isolated from the others. All four channels are independently protected from short to GND or battery.



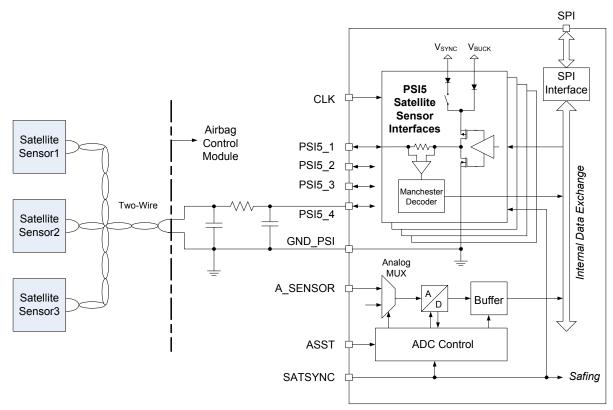


Figure 19. Satellite Sensor Interface and Analog Sensor Input Block Diagram

ANALOG SENSOR INPUT

There is one analog sensor input port provided on the 33789 for a sensitive analog safing sensor signal. The analog input shares a 10-bit A/D converter with the VERDIAG input. The periodic Satsync pulses trigger the A/D conversions.

The digital result of the analog sensor input is saved into a 10-bit analog sensor data register. It can then be read via the SPI and monitored by the safing logic in the same way as the satellite data from the PSI5 interface. The ASST input receives an inhibit signal from the MCU during the analog sensor self-test to stop the buffer register updating, thus avoid the Arming output triggered by an Analog Sensor Self Test fault condition.

DC SENSOR INTERFACE

The DC sensor interface provides 9 channels for Hall-effect sensors, resistive sensors or simple ON/OFF type switching sensors, such as seat belt buckles, seat track position sensors, etc. All nine inputs are multiplexed and buffered before they are output to the MCU through the AOUT pin. The multiplexer is controlled by SPI commands.

The DC sensor interface not only monitors the voltages at each input, but also provides a bias supply with four selectable regulated voltages for each sensor output stage. The supply regulator is capable of measuring and limiting the load current. If the load current exceeds the overcurrent detection threshold, the voltage regulator will enter into a protection mode and become a current source. During the transient period, the regulator output voltage will be increased to maintain the supply current near the current limit level, which is required by the load resistance in the Hall-effect sensor, to establish a sensing signal voltage. The DC sensor load current I_{INx} to the analog output voltage V_{AOUT} conversion curve for the AOUT monotonic operation can be found in Figure 21.

The DC sensor interface allows dual-point measurement that eliminates common-mode ground offset for implementation of sensors without a ground return to the ECU. The DC sensor interface system is capable of diagnosing whether a sensor switch is in a valid position, open circuit, short circuit to other channels, or other vehicle voltage potentials.

There is a low-current active pull-down circuit at each INx input, to discharge the residual voltage after the channel is deselected. The circuit stays activated as long as the DC sensor interface block is enabled and the channel is unselected until the channel is once again selected.

To prevent damage caused by external fault conditions, the interface local temperature is monitored with a safety feature of overtemperature shut down. The bias supply regulator configuration and the current limit functions are controlled by SPI commands, and the fault conditions including the overtemperature error, can be read via the SPI. An internal reset automatically deactivates the bias supply regulator and all of multiplexers and switches.



ANALOG OUTPUT FOR DC SENSOR MONITOR AND ANALOG DIAGNOSTICS

The AOUT pin is for SPI controlled multi-function analog output with an analog buffer amplifier. According to the SPI command, the instant AOUT voltage can be:

- · One of the DC sensor inputs with selected bias supply voltage, or the sensor load current
- · One of the system power supply voltages (rescaled), including the energy reserve diagnostic measurement
- One of the output pin voltages from the two configurable drivers

The AOUT signal provides a convenient access for the MCU to extract the DC sensor status and conduct diagnostics for all of above sub-systems.

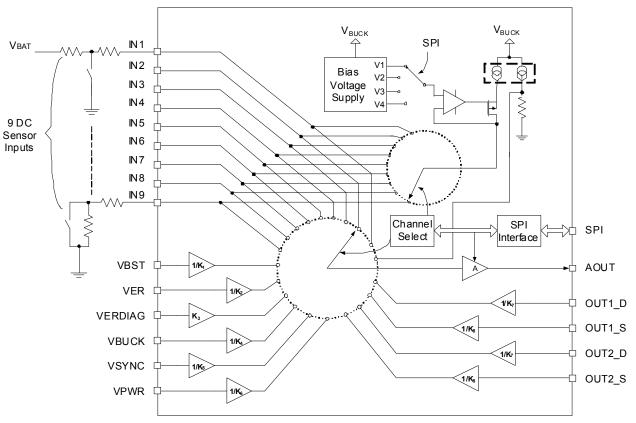


Figure 20. DC Sensor Interface and Analog Output Block Diagram

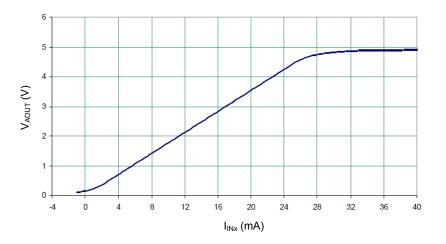


Figure 21. V_{AOUT} vs. I_{INx} Monotonic Operation



SERIAL PERIPHERIAL INTERFACE (SPI)

The 33789 SPI interface uses a slave configuration. It features:

- 16-bit data frame
- Up to 8.0 MHz SPI clock
- 5.0 or 3.3 V compatibility (receives 3.3 V SPI inputs without a level shifter)
- Three extra chip selects CS_A, CS_B, and CS_C to support SPI monitor extract on-board digital sensor data for up to four sensors.

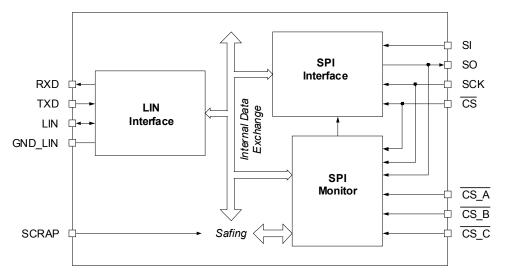


Figure 22. Communication Interfaces Block Diagram

LIN Physical Layer

The LIN physical layer is LIN 2.1 compliant, and supports three communication speeds by changing the output slew rate:

- LIN: up to 10.4 kBaud
- · LIN: up to 20 kBaud
- ISO 9141 (K-line): up to 100 kBaud

This external communication interface can also be configured to directly output one of four satellite sensor channel's Manchester code.

SAFING LOGIC

The Safing Logic block utilizes a logic structure, which is independent of the MCU, to monitor both on-board sensors and satellite sensors, to determine the vehicle safety status, and verify the necessity to warrant Arming deployment of the airbag system. The functions of each section can be summarized as following:

- 1. SPI Monitor and Decoder:
- · Extracts all of the sensor data transferred on the SPI in responding the MCU requests
- · Checks the sensor data whether they are in valid ranges and in the correct sequence requested by the MCU
- 2. Safing State Machine:
- · Applies overall safing control
- · Supports 5 exclusive operation modes:
 - •Start-up Mode
 - •Diagnostic Mode
 - •Safing Mode
 - •Scrap Mode
 - •Arming Mode

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3. Safing Control Counters:

Data Valid Counter

·Incremental by each sensor message containing valid data

•Read by the MCU to determine if the safing logic has sufficient sensor data

Sequence Counter

•Incremented by each valid sensor message

•Ensures the sensor data is requested by the MCU in the correct range of values, and aligns the sensor data to the corresponding safing threshold

- 4. Safing Threshold Logic:
- · Ensures the safing threshold values can be reliably written and read through a secure protocol run by the MCU
- 5. Safing Compare Logic:
- · Compares sensor data with configured threshold aligned by the sequence counter
- · Increments the incident counter (sample counter) whenever the sampled sensor data value is beyond the thresholds
- Checks the incident counter to determine if Arming should be asserted.
- 6. Arming Enable Output:
- A pair of complementary logical outputs used to enable the external arm circuit and/or squib drivers for deployment.

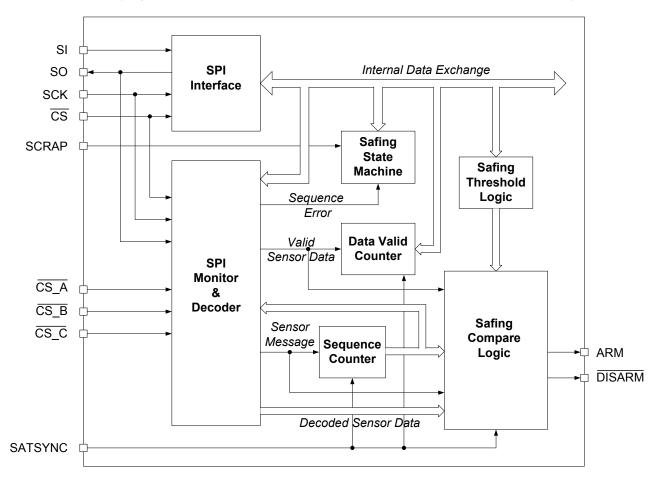


Figure 23. Safing Logic Block Diagram



CONFIGURABLE GENERAL PURPOSE DRIVERS

The 33789 offers two general purpose drivers. Each one can be configured as either a high-side driver or a low-side driver via the SPI. Both drain and source terminals of each driver have connect pins on the package, for external configuration convenience.

The driver output pins can withstand shorts to as low as -1.0 V, as high as V_{PRW} + 1.0 V, and up to 27 V for 5 minutes. They will survive with 40 V load dump. The driver output current capability is 70 mA with current limitation. The driver has integrated diagnostics and short-circuit protection. The output status can be checked by the MCU via the SPI. All output pin voltages can be monitored at the multiplexed analog output pin AOUT.

The driver control block has a built-in 128 Hz 6-bit PWM modulator. Thus, the driver can be used as a dimmable indicator driver (such as an LED). When this option is selected, the activation of both drivers will be logically synchronized, which means both drivers will be turned on simultaneously. This allows an application to combine both drivers in parallel to drive a single load with a doubled drive capability.

The output stage has slew rate control and thermal shut down features to improve performance and reliability.

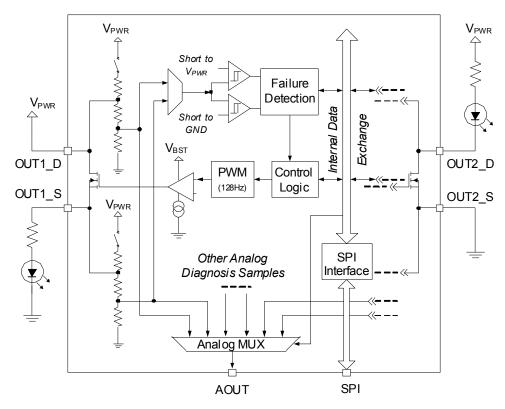


Figure 24. Configurable General Purpose Driver Block Diagram



FUNCTIONAL DEVICE OPERATION

OPERATING MODES

POWER MODE CONTROL

The 33789 Power Mode Control controls the start-up activation of both boost and buck power supplies, based on the voltages on the VPWR and WAKE pins.

The Wake input is a battery voltage, active-high logic input, and the detection threshold is normally $V_{PWR}/2$. When the battery input at the VPWR pin exceeds the low-voltage lockout threshold V_{BST_UV} , and the WAKE state is active (logic high), both the boost and buck converters are started. This low-voltage lockout threshold is also used as the ignition status threshold. The MCU can receive an indication that the threshold has been exceeded, when using the SPI STATUS to read the IGNSTSAT status and receiving the signal IGN=1 (see Table 32).

Hysteresis is applied to prevent inadvertent deactivation of the boost supply. Figure 25 shows the glitch suppression of the Wakeup signal.

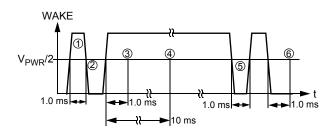


Figure 25. Wake Glitch Suppression

The suppression results of the above six marked scenarios in Figure 25 are:

- 1. No change of sleep mode state, but current consumption may exceed specification for sleep mode.
- 2. The Sleep mode current returns to within specified limits.
- 3. Power supply exits Sleep mode. Switches start operating if applicable voltages exceed the undervoltage lockout threshold, but the Sleep Reset is still active, because of its 10 ms delay in response to the Wake-up signal. The system stays in Sleep mode.
- 4. Sleep Reset is released and the entire system starts operating. After this point, a SPI command to turn off switches would not be executed, but would be latched and wait for the WAKE signal change to low.
- 5. The latched SPI command to turn off the switches would not be executed if the Wake signal has turned to a low less than 1.0 ms.
- 6. After the Wake signal stays low for more than 1.0 ms, the latched SPI command to turn off the switches is executed and the system is turned off.
- To simplify the power supply state diagrams, an internal active low signal Sleep Mode needs to be introduced.

Figure 26 shows the logic relation between the Sleep Mode signal and the Wake signal, SPI Buck_off command, and Sleep_Reset status.

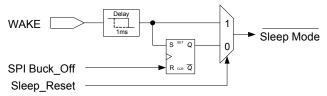
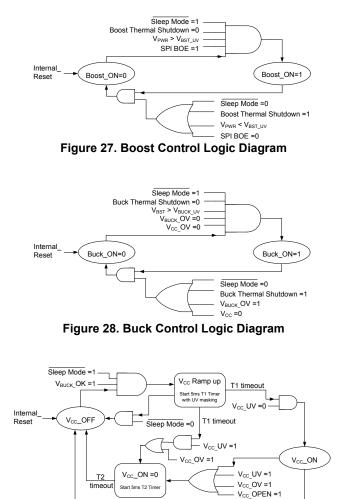


Figure 26. Sleep Mode Control Logic

With the Sleep Mode signal, the 33789 power mode control logic can be illustrated in the following diagrams.





Sleep Mode =0

Figure 29. VCC Control Logic Diagram

VBUCK DIAGNOSTIC AND VCC RESTART

<u>Figure 29</u> indicates " V_{BUCK} _OK = 1" is a necessary condition for V_{CC} start. In a specific case, it can be V_{CC} dependent. The situation could happen during the process of an MCU read of V_{BUCK} from the AOUT pin, via the analog MUX, when V_{CC} is incidentally turned off and attempted to be turned back on.

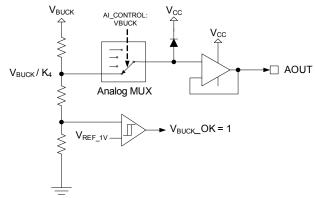


Figure 30. V_{BUCK} Diagnostic and V_{CC} Clamping



In <u>Figure 30</u>, the analog MUX output is clamped to V_{CC} , to protect the 5.0 V buffer amplifier. When V_{CC} is turned off, both the input and output of the MUX are clamped to GND, pulling the V_{BUCK} _OK comparator input below 1.0 V, therefore, " V_{BUCK} _OK = 0". This logic status will lock out V_{CC} from a restart, as long as the MUX is not changed by an internal reset.

In vehicle applications, when the battery voltage drops very low, V_{PWR} will fluctuate near the V_{BST_UV} threshold. This particular operation condition will cause both the boost and buck switches to oscillate, resulting in a V_{CC} on-off restart cycle, as described in Figure 27, Figure 28, and Figure 29 respectively. Other possible conditions causing V_{CC} to turn off, can be found in Figure 29, the VCC Control Logic Diagram.

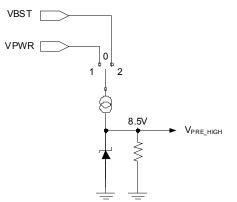
If the MCU can always read V_{BST} and show that V_{BST} is in the specified normal operation voltage range, just before reading V_{BUCK} , the buck capacitor should be able to hold the valid voltage long enough to ensure that V_{CC} will not drop off before the V_{BUCK} diagnostic read is complete. This software implementation can avoid a V_{CC} restart difficulty in the low V_{PWR} fluctuation condition. Users can also find other hardware solutions, with external configurations, to prevent V_{CC} from dropping below its threshold, flipping the V_{BUCK} _OK comparator output.

INTERNAL POWER SUPPLY

The 2.5 V internal supplies are created, based on two voltages: V_{PRE HIGH} and V_{PRE LOW}.

V_{PRE HIGH} Regulator

V_{PRE_HIGH} provides supply for the power switches. The V_{PRE_HIGH} regulator starts operation with the VPWR input. After the VBST output reaches the normal value, it switches the source to VBST.





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The V_{PRE_HIGH} switch control logic can be described with the following truth table in <u>Table 7</u>.

- . . - . .

| Table 7. | V _{PRE_HIGH} Switch Control | |
|----------|--------------------------------------|--|
| | | |

| Internal Reset | Sleep Mode | Boost_OK | Switch Position |
|-------------------|------------|----------|--------------------|
| 1 | Х | Х | 0 |
| 0 | 0 | Х | 1 |
| 0 | 1 | 0 | 1 |
| 0 | 1 | 1 | 2 |



V_{PRE_LOW} Regulator

 V_{PRE_LOW} supplies power for the logic and bandgap circuits. The V_{PRE_LOW} regulator starts operation with the VPWR input. After the VBUCK output reaches the normal value, it switches the source to VBUCK.

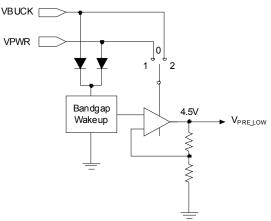


Figure 32. V_{PRE_LOW} Regulator

The $V_{PRE LOW}$ switch control logic can be described with <u>Table 8</u>.

| Table 8. | V _{PRE} | LOW Switch Control |
|----------|-------------------------|--------------------|
|----------|-------------------------|--------------------|

| V _{WAKE} > V _{PWR} /2 | Sleep Mode | Buck_OK | Switch Position |
|--|------------|---------|--------------------|
| 0 | 0 | Х | 0 |
| Х | 1 | 0 | 1 |
| Х | 1 | 1 | 2 |
| 1 | 0 | Х | 1 |

V_{2P5} and V_{DD} Regulators

The 4.5 V V_{PRE_LOW} is used to create a 2.5 V internal supply V_{2P5} , which supplies the analog circuit, and its buffered output V_{DD} supplies digital circuit.

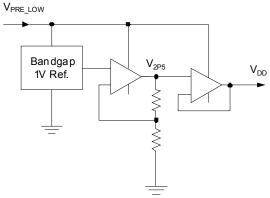


Figure 33. 2.5 V Internal Supply Regulators

V_{DD} Output Capacitor and Diagnostics

The V_{DD} regulator is switched off for about 6.0 μ s every 200 ms. Once the capacitor is disconnected or out of tolerance, the output voltage will drop and the V_{DD} undervoltage error can be detected.

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WATCHDOG STATES AND RESET

Types of Resets and Reset Sources

The reset functions of the 33789 control both its internal resets and the external resets on all of the devices in the system equipped with a reset input.

The internal reset is triggered by the V_{DD} voltage thresholds and the internal bandgap regulator status.

The external RESET pin is driven by the following reset sources:

- V_{CC} voltage monitor
- Window watchdog
- V_{DD} voltage monitor
- Open ground monitor (for GNDA and VSS)
- · Internal bandgap regulator monitor

Figure 34 shows the logic relation between all of the resets and all of the reset sources.

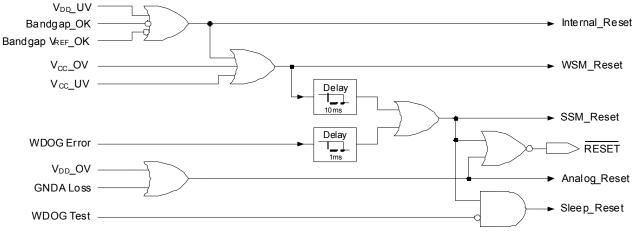


Figure 34. Reset Logic

The functions of the reset signals are:

- · Internal_Reset: Resets all internal blocks except Safing and Watchdog
- WSM_Reset: Resets Watchdog State Machine
- SSM_Reset: Resets Safing State Machine
- Analog_Reset: Arm enable for ARM / DISARM
- Sleep_Reset: Resets Sleep_Mode Logic

Start-up Behavior

After wake-up, when V_{CC} ramps up, the internal power supply holds the RESET pin low and keeps the watchdog in a "INITIAL" state with the 33789 status register bit WDR = 0, which indicates the reset is not caused by any watchdog error. The register is guaranteed by design to be inactive during the V_{CC} ramp up period.

When the power-on delay has elapsed and V_{CC} has entered into the valid voltage range, the RESET pin is released and the system operation starts.

The Watchdog State machine (WSM) does not start its operation until the first watchdog feed command is received.

Before the first watchdog refresh, the ARM and DISARM outputs are forced to maintain their high-impedance states.

Watchdog Window

A watchdog window is defined as a time window between two adjacent watchdog refreshes. The 33789 uses software watchdog, it periodically receives watchdog refresh signals from the MCU through the SPI interface.

A successful watchdog refresh is a SPI command, WDOG_FEED (high or low), followed by another SPI command, WDOG_FEED (low or high), within a designated watchdog window. (See Figure 35, Watchdog Windows)

Once the 33789 receives the first WDOG_FEED command, the first successful refresh occurs and the watchdog transits from "INITIAL" state to "DRIVE" state. (See Figure 36, Watchdog State Diagram)



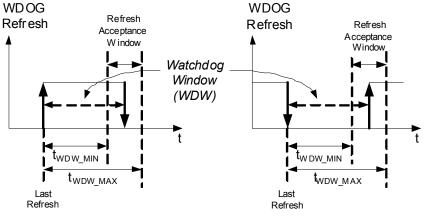


Figure 35. Watchdog Windows

Watchdog Error

WDOG Error is defined as:

NOT [WDOG OVERIDE]

AND

[WDOG_FEED with same polarity as the previous feed

OR

WDOG_FEED before the min. window time to the previous feed

OR

WDOG_FEED after the max. window time to the previous feed]

WDOG Refresh OK is defined as:

WDOG_FEED with opposite polarity to the previous feed

AND

WDOG_FEED after the min. window time to the previous feed

AND

WDOG_FEED before the max. window time to the previous feed

If a window watchdog refresh fails, the RESET pin will be pulled down for 1.0 ms to reset the system, and the 33789 internal status register will set the Watchdog Error Status bit WDR = 1, to indicate a watchdog error is the source of the reset.

The value of the WDR bit is latched and can be read by the MCU via the SPI STATUS request command. The WDR bit is cleared by either a WSM_Reset or a correct WDOG_FEED.



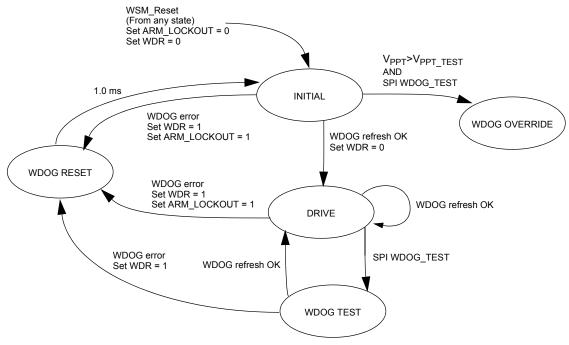


Figure 36. Watchdog State Diagram

Arm Lockout and WDOG_TEST

During a system reset, both the ARM and DISARM pin outputs are forced to the high-impedance state, which is called Arm Lockout. To individually test ARM and DISARM (The tests allow both the ARM and DISARM pins to be set to "1" or "0" at same time) while the WSM is still running in the background, the WSM can be set to the WDOG OVERRIDE state after a WSM reset, or insert the SPI command of WDOG_TEST from the DRIVE state, to avoid setting ARM_LOCKOUT = 1.

Though watchdog error always causes a system reset, which can be measured at the RESET pin and can be checked by using the SPI STATUS command to read the bit WDR = 1, it does not always cause an Arm Lockout, which depends on the WSM running in the DRIVE state, or in the WDOG TEST state before the watchdog error occurs. Regardless whether the watchdog error causes an Arm Lockout, the WSM_Reset always brings the WSM back to the INITIAL state, with the setting of ARM_LOCKOUT = 0 and WDR = 0 at the end of the system reset.

To facilitate testing of the watchdog error function, the SPI command WDOG_TEST can be used to prevent the Arm Lockout caused by a watchdog error. This command is only valid for the next watchdog window: A WDOG_TEST command has to be inserted before a watchdog error (invalid refresh or missing refresh) within the same watchdog window. Thus, once the error occurs, the consequential resets would not cause an Arm Lockout. (See Figure 37 for some typical examples of successful and unsuccessful inserted SPI WDOG_TEST commands)



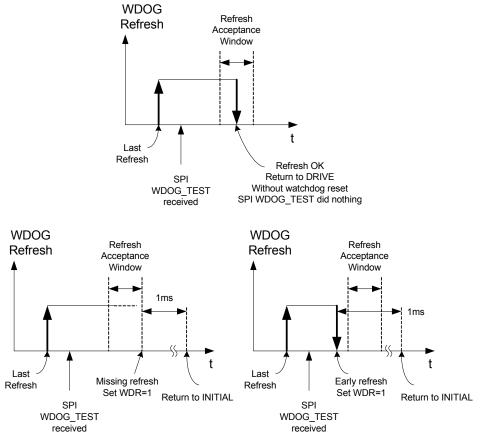


Figure 37. Successful and Unsuccessful WDOG Test Examples

Arming Logic

When an internal Arm signal is created, it shall be output through the ARM and DISARM pins only when the following conditions are satisfied:

While in WDOG_OVERRIDE state

OR

While in DRIVE state with

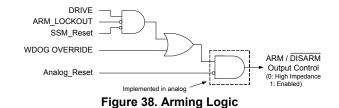
[SSM Reset inactive

AND

Arm_Lockout inactive]

In any other conditions, the internal ARM / DISARM control signal shall never be sent to the output, and the output pins ARM and DISARM shall be set to high-impedance.

Whenever an Analog_Reset is created, the ARM and DISARM outputs are set to high-impedance to inhibit outputs by an analog implementation, as a part of failure mode control, the Arming logic result will be ignored.





SATELLITE SENSOR INTERFACE

PSI5 Interface

The satellite sensor interface (see Figure 19) on the 33789 serves as master interface. Each one of its channels independently supplies a regulated DC voltage V_{SAT_OUT} to its satellite devices. At the same time, it monitors the current draw to receive the sensor signals. The output current can be limited for fault protection. The satellite sensors transmit Manchester-encoded data with current modulation. The Manchester coding uses a rising edge to represent logic "0" and a falling edge to represent logic "1".

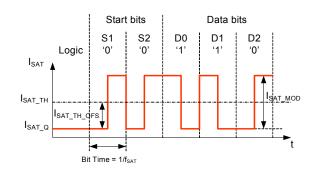


Figure 39. Current Modulation and Manchester Bit Encoding of Satellite Sensor

- The PSI5-P 10P -500/3L mode of PSI5 V1.3 protocol has the following features:
- · PSI5-P: Peripheral Sensor Interface Parallel Bus mode
- 10P: 10 data bits + 1 parity bit
- -500: 500 µs nominal synchronization period
- /3: three time slots for sensor data
- L: 125 kbps

| × | | the | first | t trar | nsmi | tted | bit | | | | | |
|----|----|-----|-------|--------|------|------|-----|----|----|----|----|---|
| S1 | S2 | D0 | D1 | D2 | D3 | D4 | D5 | D6 | D7 | D8 | D9 | Р |
| 0 | 0 | 1 | 1 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | 0 | 1 |

Manchester code example to transmit 0x1E7 = 01 1110 0111b

Figure 40. Satellite Data Frame Format

The even parity is checked for the entire data transmission except the start bits. If a parity error is detected, an error message will be sent to the MCU.

The 33789 automatically calibrates the sensor clock, to align the sampling timing of the receiver for the Manchester decoding.

Each channel has implemented an input data filter to remove the glitch from the input signal and recover data from waveform distortion, to reduce the decoding error. The input data filter includes sampling / holding circuit, shift register, and majority detector.

If one or more of following statements are true, a Manchester Error will be directed to the MCU:

- Two valid start bits are detected, and at least one of the expected 13 mid-bit transitions are not detected.
- Two valid start bits are detected, and more than 13 mid-bit transitions are detected.
- Two valid start bits are detected, and the sampled logic levels before and after any of the 13 expected mid-bit transitions are the same.

Synchronous Operation Modes

To synchronize the sampling of satellite sensor data, the master interface circuitry on the 33789 creates a sync pulse with increased voltage added on the top of sensor supply voltage V_{SAT_OUT} , to signal the initiation of sampling to the satellites. The MCU periodically sends a satellite synchronization signal (Satsync) to the 33789, to activate the sync pulses and controls the timing of the satellite data acquisition.

When the rising edge of the Satsync signal is detected, the master interface outputs four Sync pulses, one for each channel, on channels PSI5_1 through PSI5_4, in sequence. A 4.0 µs stagger time is inserted from channel to channel, to avoid high peak current. Figure 41 illustrates the sync signals' voltage and timing relations.



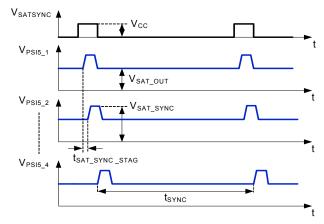


Figure 41. Satellite Synchronization Pulses

The sync pulse driver can either source or sink bus current. It outputs higher charge current to increase the bus voltage V_{PSI5_X} from V_{SAT_OUT} to V_{SAT_SYNC} , at the beginning of Sync pulse, and discharges the bus capacitance at the end of sync pulse, to return the bus voltage back to V_{SAT_OUT} .

The pull-down device to sink the bus current is current limited. The sync pulse output from the interface is wave-shaped to limit the slew rate for EMC improvement. In the synchronous mode operation, satellite sensors transmit data in response to Sync pulse. Each satellite has its own assigned time slot for sending data. All of the satellites need to be pre-programmed for timing order, to realize different communication start times.

The 33789 PSI5 interface supports two types of synchronous operation modes for scheduling satellite data transfer. The operation mode can be selected channel-by-channel per MCU SPI commands.

1. Synchronous Time-division Multiplexed (TDM) Mode

The PSI5-P 10P -500/3L mode is a synchronous TDM mode of the PSI5 protocol, which supports one to three satellites per channel.

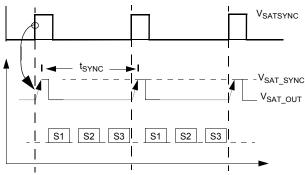


Figure 42. Synchronous TDM Mode

The rising edge of the Satsync signal triggers the generation of the sync pulse, the falling edge of Satsync is ignored.

The time window between two Sync pulses is divided into three time slots, each slot for one of the three satellite sensor's data. Once the three Manchester data are received and decoded in sequence at the 33789, they are stored in order into three internal registers A, B, and C.

All bits of these registers are simultaneously updated upon reception of the satellite message to prevent partial frame data from being checked out via the SPI interface. A fixed blanking interval, which is triggered by the rising edge of the Satsync signal, is inserted at the receiver to avoid false triggering of the Manchester decoder.

The PSI5 Sync pulse can also be used for bidirectional communication. This feature allows the 33789 to send commands to satellites, which is useful to pre-program or re-program the satellite sensors in the system. Once the PSI5 bus is set to bidirectional communication mode by the MCU via the SPI, in every fixed Satsync period, the appearance of the sync pulse represents a logic "1", and the missing pulse represents a logic "0".

The communications between an airbag ECU (master terminal) and the PSI5 satellite sensors (slave terminals), use two different modulations:

Sensors \rightarrow ECU: current modulation

 $\mathsf{ECU} \to \mathsf{Sensors:}$ voltage modulation

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2. Satsync-steered Mode

The Satsync-steered mode is another type of TDM operation. It supports up to two satellites per channel.

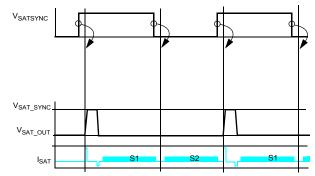


Figure 43. Satsync-steered Mode

The data from two parallel connected satellite sensors are transferred in serial, and they are time-divided with alignment to the Satsync edges.

At the 33789, the logic level of the Satsync signal steers the incoming sensor data into two input data registers:

- · When the Satsync input is high, the received data is stored in register A
- · When the Satsync input is low, the received data is stored in register B.

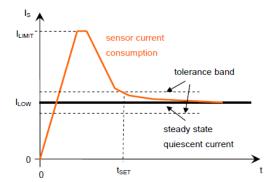
Quiescent Current Monitoring

The quiescent current on the PSI5 bus has a wide tolerance range. It varies from sensor to sensor, and depends on the number of the sensors on the bus. Supply voltage and ambient temperature also have an influence on the satellite sensor quiescent current. The 33789 automatically calibrates the interface quiescent current, and resets the adaptive current detection threshold, to achieve the demodulation accuracy.

The 33789 uses three different timing strategies to monitor quiescent current in different communication states:

1) During Startup

The PSI5 standard V1.3 allows the sensor quiescent current settling time t_{SET}, up to 10 ms.





To ensure a proper measurement, the 33789 starts to measure the bus quiescent current 10 ms after a channel is activated, and inhibits the Sync pulse generation until the first measurement is completed. The first measurement takes 35 ms.



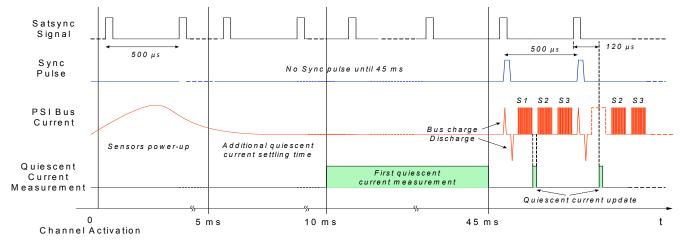


Figure 45. Quiescent Current Measurement Timing

2) During Run-time with First Data Frame

In every Sync cycle, if there is a data transfer activity during the first time slot, and the parity bit of the first data frame is checked as correct, the receiver updates the quiescent current 2.0 µs after the end of the parity bit.

3) During Run-time without First Data Frame

If there is no data transfer activity detected in the first time slot, the receiver updates quiescent current 120 µs after the rising edge of the Satsync signal. The receiver would stop the updating if there is any data bit detected during the update process.

ANALOG / DIGITAL CONVERTER

The 33789 uses a single analog to digital converter, ADC, to measure the two analog input signals:

- A_SENSOR: On-board analog safing sensor input
- VERDIAG: The voltage change across the energy reserve capacitor C_{ER} for diagnosis

When the 33789 receives the falling edge of Satsync signal, the ADC Control Logic asserts Start Of Conversion (SOC) signal, which is synchronized with the analog multiplexer (MUX) input select timing, to trigger the 10-bit A/D conversions for the two input signals in sequence. When each of conversions is completed, the ADC sends an End Of Conversion (EOC) signal back to the Control Logic, to set Sensor_val or ER_Val, depending on which input is processed.

Analog Sensor Data

After the A_SENSOR signal conversion, the Control Logic sets Sensor_val to load the data from the ADC into a high-pass digital filter, HPF, to reduce slow offset drifts caused by aging and environment. This offset remove process is also called Zero Adjust. The output of HPF is then latched into a 10-bit holding register, ASENSOR_RG.

The MCU can use Sensor Request SPI command to access the 10-bit data from ASENSOR_RG. This allows the SPI Monitor in the 33789 safing block to treat A_SENSOR data exactly same as satellite sensor data. Similar to the satellite sensor data, subsequent SPI requests of A_SENSOR data before the next Satsync falling edge will result in an error response, with the ND (No Data) bit set for Exception status.



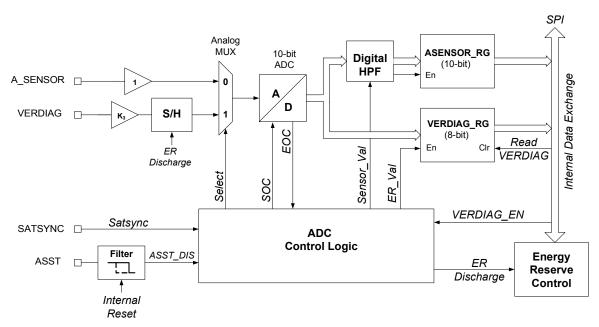


Figure 46. The 33789 ADC Process Diagram

VERDIAG Signal Conversion

To convert the VERDIAG signal, VERDIAG _EN shall be active in advance. At the next Satsync falling edge, the ADC Control Logic asserts the ER Discharge signal to turn the ER charge switch (the high-side driver) off and the ER discharge switch (the low-side driver) on, discharging the energy reserve capacitor (see Figure 15, Energy Reserve Control Block Diagram). A sampling and holding circuit catches the initial VERDIAG voltage drop to have the ER diagnostic signal ready.

When the MUX Select is switched from "0" to "1" (after the A_SENSOR signal conversion), the acquired initial VERDIAG voltage drop value is passed through and loaded into the ADC. Then the Control Logic set SOC to trigger the conversion.

At the end of conversion, if the VERDIAG_EN signal is still active, following EOC, the ER Discharge signal will be de-asserted to turn off the ER discharge switch and turn the ER charge switch back on. At the same time, upon receiving EOC, the Control Logic sets ER_Val to latch the 8 most significant bits (MSB) of the 10-bit ADC output into a holding register VERDIAG_RG. This register will be cleared after a SPI read.

The internal VERDAIG_EN signal is activated by ESR_DIAG SPI command from the MCU with the EN bit set (EN = '1'), and it remains set until a subsequent ESR_DIAG SPI command with EN = '0'. With this design, the 33789 can automatically repeat the ESR test on the ER capacitor in every Satsync cycle, using only one SPI command.



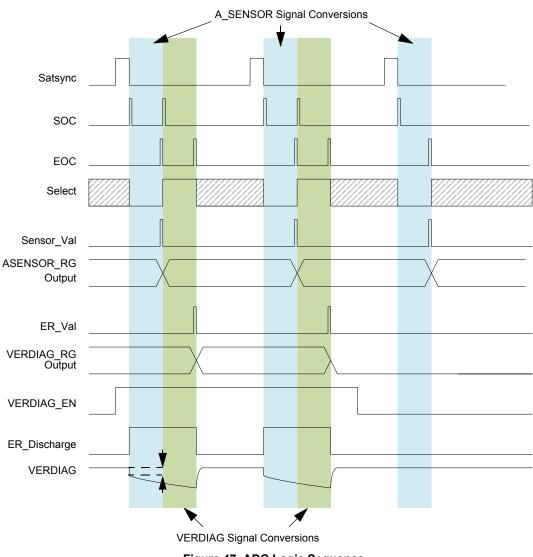


Figure 47. ADC Logic Sequence

Analog Sensor Self Test

On-board analog sensor self-test is often used to verify the functionalities and the connection between the sensor and the MCU. To facilitate the test without activation of the Arming outputs due to a fault possibility, the 33789 monitors the Analog Sensor Self Test control signal ASST from the MCU. An internal Analog Sensor Self Test Disable signal ASST_DIS is generated when the ASST pin is read logic high. The ASST_DIS signal is used to block the setting of Sensor_Val, thus inhibit triggering of the HPF and updating of the ASENSOR_RG, as the result, it suspends safing. The ASST input is filtered to prevent either inadvertent disabling of the safing during periodic self-test, or inadvertent arming, due to the slow response of the sensor output after the self-test signal deasserted. The filter is implemented with the following features:

• ASST_DIS is cleared upon an internal reset.

•ASST_DIS is set only after the ASST input is set for 3 consecutive Satsync falling edges.

•Once set, ASST_DIS will be cleared only after the ASST input is cleared for 6 consecutive Satsync falling edges.



SENSOR MESSAGE, OPERATION COMMAND AND SPI

The 33789 communicates with the MCU via the SPI bus.

SI and SO are in parallel, to transmit serial data as a bidirectional communication interface when the chip select \overline{CS} is active (pulled low), and each bit of both signals is synchronized by the SPI clock SCK. SI data is clocked into the 33789 at the rising edge of SCK, and SO data is clocked out at the falling edge of SCK.

Following a SI data request from the MCU, the 33789 transmits a SO response in single stage pipeline fashion. The request/response pattern can be seen in <u>Figure 48</u>.

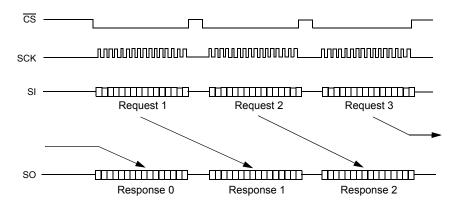


Figure 48. SPI Data Frame Latency

MESSAGE FORMATS OF SPI DATA

There are two types of messages communicated on the 33789 SPI bus: a sensor request/response message and a non-sensor request/ response message. After an internal reset, the response on SO to the first SPI command is a non-sensor data error response (with RE=1, see <u>Table 9</u>). There is a single bit (SEN, bit 13) in the request frame which defines the message type.

Sensor Message Format

The MCU uses the sensor request/response to retrieve sensor data from:

•The 33789 satellite interface block

•On-board digital sensors with SPI interface

These types of messages, as well as the analog sensor data, are also monitored by the Safing Logic block of the 33789.

Table 9. SPI Sensor Data, - Message Format

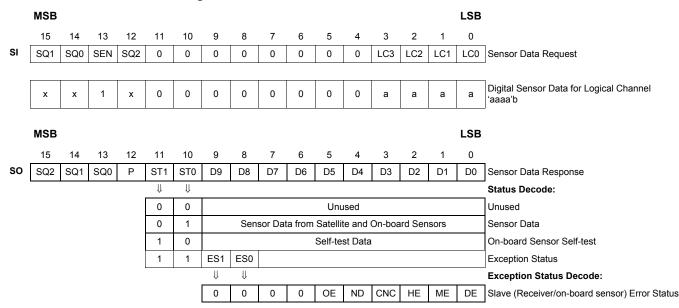




Table 9. SPI Sensor Data, - Message Format (continued)

MSB

| | | | | | | | | | LSB | |
|---|---|---|---|---|---|---|---|---|-----|------------------------------------|
| 0 | 1 | х | х | х | х | х | х | х | х | Reserved |
| 1 | 0 | х | х | х | х | х | х | х | | Used for Non-sensor Data Responses |
| 1 | 1 | х | х | х | х | х | х | х | х | Reserved |

Table 10. SPI Sensor Data, - Message Bit Definition

SENSOR DATA REQUEST SI BIT DEFINITION

| Name | Bit Position | Definition |
|---------|--------------|---|
| SQ2:SQ0 | 15, 14, 12 | Sequence identifier - used for synchronizing samples |
| SEN | 13 | Sensor bit - Defines the request as a sensor data request or a non-sensor data request (1 = sensor data, 0 = non-sensor data) |
| LC3:LC0 | 3:0 | Logical channel select |

SENSOR DATA RESPONSE SO BIT DEFINITION

| Name | Bit Position | Definition |
|---------|--------------|---|
| SQ2:SQ0 | 15:13 | Sequence identifier - used for synchronizing sensor samples |
| Р | 12 | Parity - Ensures odd parity for bits 15:0 of SO |
| ST1:ST0 | 11:10 | Status - Identifies the contents in D9:D0 of SO (sensor data, self-test data, error, etc.) |
| ES1:ES0 | 9:8 | Exception Status - Identifies the contents of exception data (Receiver/On-board Sensor Error Status, or Satellite Error) |
| OE | 5 | Overcurrent Error - Overcurrent of the low-side driver (short to battery) |
| ND | 4 | No data (channel specific) - Sensor data not available |
| CNC | 3 | Conditions Not Correct for operation (channel specific) as defined elsewhere - Request cannot be fulfilled because the channel is off, or in the wrong mode, etc. |
| HE | 2 | Hardware Error in slave (channel/channel pair specific) - caused by hardware errors defined elsewhere, such as overtemperature overcurrent of the high-side driver (short to GND), reference out of range, etc. |
| ME | 1 | Manchester error (channel specific) - incorrect number of bits, timing violation, etc. in Manchester bit-stream |
| DE | 0 | Data error (channel specific) - Parity or CRC error in Manchester data |
| D9:D0 | 9:0 | Sensor Data - For ST1:ST0 = 01 |

The Logic Channel Field (LC3:LC0) is used for the address of each of all 12 possible satellite sensors and one analog sensor. Each sensor address along with its channel and time slot on the bus, is assigned in <u>Table 11</u>.

Table 11. Logic Channel Assignment

| Logic Channel (LC3: LC0) | Physic Channel | Time Slot | Data Register |
|-----------------------------|----------------|-----------|---------------|
| 0000 | PSI5_1 | 1 | PSI5_1 RG_A |
| 0001 | PSI5_1 | 2 | PSI5_1 RG_B |
| 0010 | PSI5_1 | 3 | PSI5_1 RG_C |
| 0011 | PSI5_1 | - | N/A |
| 0100 | PSI5_2 | 1 | PSI5_2 RG_A |
| 0101 | PSI5_2 | 2 | PSI5_2 RG_B |
| 0110 | PSI5_2 | 3 | PSI5_2 RG_C |
| 0111 | PSI5_2 | - | N/A |
| 1000 | PSI5_3 | 1 | PSI5_3 RG_A |
| 1001 | PSI5_3 | 2 | PSI5_3 RG_B |
| 1010 | PSI5_3 | 3 | PSI5_3 RG_C |
| 1011 | PSI5_3 | - | N/A |
| 1100 | PSI5_4 | 1 | PSI5_4 RG_A |
| 1101 | PSI5_4 | 2 | PSI5_4 RG_B |
| 1110 | PSI5_4 | 3 | PSI5_4 RG_C |
| 1111 | A_SENSOR | N/A | ASENSOR_RG |



After the data from a given logic channel is read via the SPI interface, subsequent requests for the data from the same logic channel will result in an ERROR response with the No Data bit set (ND = '1').

The conditions for setting and clearing of status bits in the Sensor Data Request messages are defined in Table 12.

| Bit | Description | Setting Condition | Clearing Condition | Channel Behavior |
|-----|------------------------|---|---|------------------------|
| OE | Overcurrent Error | Satellite channel low-side overcurrent (short to V+ condition) and no hardware error (HE) detected | Internal reset or LINE_ENABLED command with xLE = 0 (OFF) for the affected channel | Channel is deactivated |
| ND | No Data | Channel is ON, no Manchester error, data error or overcurrent error is detected and a valid satellite frame has not been received | Cleared after a valid satellite data frame is received | None |
| CNC | Conditions Not Correct | Request for undefined channel or request for a channel not turned ON | Internal reset, or upon requesting a valid channel after it has been turned ON | None |
| HE | Hardware Error | Any of the following: 1. Satellite channel high-side overcurrent (short to GND condition) 2. Satellite average l_Q is out of range 3. Channel overtemperature conditions | Internal reset, or LINE_ENABLE command with xLE = 0 (OFF) for the affected channel | Channel is deactivated |
| ME | Manchester Error | Improper Manchester data - incorrect number of data bits, incorrect data edge timing, with no overcurrent or hardware errors detected | Internal reset, or cleared when read | None |
| DE | Data Error | Satellite data parity error, with no overcurrent error or hardware error detected | Internal reset, or cleared when read | None |

Table 12. SPI Sensor Data Request, - Error and Status Bit Setting

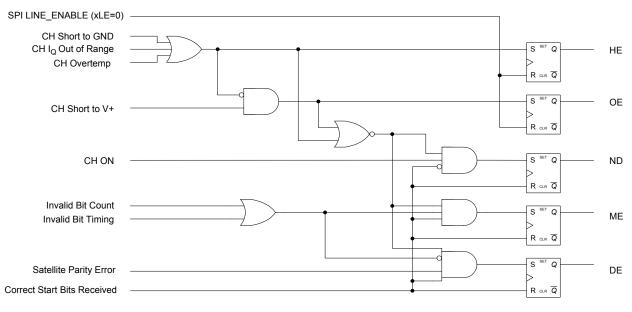


Figure 49. SPI Sensor Data Response, - Error Bit Logic

Non-sensor Message Format

Non-sensor messages are used for all of configurations, diagnostics, controls, etc. data traffic. Their message formats and bit definitions are listed in <u>Table 13</u> and <u>Table 14</u>.



MSB LSB 15 13 12 10 9 8 7 6 5 4 3 2 0 14 11 1 SI OP1 OP0 SEN A4 A3 A2 A1 A0 D7 D6 D5 D4 D3 D2 D1 D0 Slave Data Request ₽ **Operand Decode:** 11 0 0 0 Reserved х х х х х х х х х х х х х Write 0 1 0 Write Address Write Data 1 0 0 Read Address х Read х х х х х х х 1 1 0 х х х х х х х х х х х х х Test MSB LSB 15 7 6 2 1 0 14 13 12 11 10 9 8 5 4 3 so 0 OP1 OP0 Ρ ST1 ST0 ES1 ES0 D7 D6 D5 D4 D3 D2 D1 D0 Slave Data Response 1l JΙ 0 0 Ρ 1 1 0 0 0 0 0 0 SE RE 0 Error Response 1 0 1 Ρ 1 1 1 0 Slave Status Write Response Р Read Data 1 0 1 1 1 0 Read Response Р Test Response 1 1 1 1 1 0 х х х х х х х х

Table 13. SPI Non-sensor Data, - Message Format

Table 14. SPI Non-sensor Data, Message Bit Definition

SLAVE COMMAND SI BIT DEFINITION

| Name | Bit Position | Definition |
|---------|--------------|---|
| OP1:OP0 | 15:14 | Opcode - Defines operation (Read, Write) |
| SEN | 13 | Sensor bit - Defines the request as a sensor data request or non-sensor data request (1 = sensor data, 0 = non-sensor data) |
| A4:A0 | 12:8 | Address - For read or write operation |
| D7:D0 | 7:0 | Data - For write operation |

SLAVE RESPONSE SO BIT DEFINITION

| Name | Bit Position | Definition |
|---------|--------------|--|
| OP1:OP0 | 14:13 | Opcode - Identifies the contents of Read or Write data in D9:D0 - copied from SI if the request is granted |
| р | 12 | Parity - Ensures odd parity for bits 15:0 of SO |
| ST1:ST0 | 11:10 | Status - Always '11' for non-sensor response |
| ES1:ES0 | 9:8 | Exception Status - Always '10' for non-sensor response |
| D7:D0 | 7:0 | Read Data/ Error Data/ Status |
| SE | 2 | SPI Error - set to '1' for request (SI) frame violations (incorrect number of SCK pulses, etc.) |
| RE | 1 | Request Error - set to '1' for illegal, or unknown requests |

OPERATIONAL-MODE SPI COMMANDS

PSI5 Interface SPI commands

SENSOR_DATA

The SENSOR_DATA command is used to sample sensor data from the PSI5 interface and the analog sensor input. This is the only command that uses the sensor data request/response format. The details of this command are defined in <u>Table 9</u>, <u>Table 10</u>, <u>Table 11</u> and <u>Table 12</u>.

LINE_MODE (0x4F, 0x8F)

The LINE_MODE command is used to configure the PSI5 receiver channels individually, for either Synchronous TDM Mode or Satsync-Steered. The command is latched until a subsequent SPI update or internal reset. The response indicates the current state of the line mode for each channel.



Table 15. SPI Command, - LINE_MODE

| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|---|----|----|----|----|----|----|----|---|---|------|------|---|---|-----|-----|-----|-----|
| Write | SI | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 1 | х | х | х | х | LM4 | LM3 | LM2 | LM1 |
| WITE | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | LM4 | LM3 | LM2 | LM1 |
| | | | | | | | | | | | | | | | | | |
| Read | SI | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 1 | х | х | х | х | х | х | х | х |
| Redu | SO | 0 | 1 | 0 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | LM4 | LM3 | LM2 | LM1 |
| | | | | | | | | | | | | | | | | | |
| | | | LM | | | | | | | Line | Mode | | | | | | |
| Default → 0 Channel PSI5_x protocol = Synchronous TDM Mode 1 Channel PSI5_x protocol = Satsync-Steered Mode | | | | | | | | | | | | | | | | | |
| | | | | | | | | | | | | | | | | | |

LINE_MODE (0x4F, 0x8F)

LINE_ENABLE (0x43, 0x83)

The LINE_ENABLE command is used to activate or deactivate the PSI5 channels individually. The command is latched until a subsequent SPI update or internal reset. Some incident conditions, such as a thermal or overcurrent shutdown could deactivate the channel as well. The response indicates the current state of the line activation and the overtemperature status for each channel.

| | | | | | | | | | - (••, | •//••/ | | | | | | | |
|-------|----|----|----|----|----|----|----|---|--------|--------|-----|-----|-----|-----|-----|-----|-----|
| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Write | SI | 0 | 1 | 0 | 0 | 0 | 0 | 1 | 1 | х | х | х | х | 4LE | 3LE | 2LE | 1LE |
| | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | OT4 | OT3 | OT2 | OT1 | 4LE | 3LE | 2LE | 1LE |
| | | | | | | | | | | | | | | | | | |
| Read | SI | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 1 | х | х | х | х | х | х | х | х |
| | SO | 0 | 1 | 0 | Р | 1 | 1 | 1 | 0 | OT4 | OT3 | OT2 | OT1 | 4LE | 3LE | 2LE | 1LE |
| | | | | | | | | | | | | | | | | | |

LINE ENABLE (0x43, 0x83)

Table 16. SPI Command, - LINE_ENABLE

| | | ОТх | Overtemperature Shutdown Indicator |
|---------|---------------|-----|---|
| Default | \rightarrow | 0 | No overtemperature shutdown on channel PSI5_x |
| | | 1 | Overtemperature shutdown on channel PSI5_x |
| | | | |
| | | xLE | Line Enable |
| Default | \rightarrow | 0 | Channel PSI5_x OFF |
| | | 1 | Channel PSI5_x ON |

SYNC_ENABLE (0x44, 0x84)

The SYNC_ENABLE command is used to individually enable or disable the Sync pulse generation for the PSI5 channels while in Synchronous TDM Mode. It can be used to support bidirectional communication between the 33789 and the satellites. The state of the xSE bits is checked at the rising edge of the Satsync signal for each Satsync period.

In Satsync-steered mode, the SYNC_ENABLE command is latched until subsequent SPI update or reset, but it has no effect on the Sync pulse output, because the communication back to the satellite via the Sync pulse modulation is disabled.

The internal reset sets xSE = 1 for default.

The response indicates the current state of the Sync pulse enable register for each channel.



Table 17. SPI Command, - SYNC_ENABLE

| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|----------|----|----|-----|---------|-----------|-----------|-----------|---|---|---|---|---|---|-----|-----|-----|-----|
| Write | SI | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | х | х | х | х | 4SE | 3SE | 2SE | 1SE |
| ville | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 4SE | 3SE | 2SE | 1SE |
| | | | | | | | | | | | | | | | | | , |
| Read | SI | 1 | 0 | 0 | 0 | 0 | 1 | 0 | 0 | х | х | х | х | х | х | х | х |
| Reau | SO | 0 | 1 | 0 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 4SE | 3SE | 2SE | 1SE |
| <u> </u> | | | | | | | | | | | | | | | | | |
| | | | xSE | Sync Pu | ulse Enal | ole | | | | | | | | | | | |
| | | | 0 | Channel | PSI5_x | sync puls | e disable | d | | | | | | | | | |

SYNC_ENABLE (0x44, 0x84)

 $\text{Default} \rightarrow$

LIN Interface Control SPI Commands

LIN_CONFIG (0x50, 0x90)

The LIN_CONFIG command is used to control the LIN physical interface configuration. It supports two functions:

1) LIN signal wave-shaping:

There are three different slew rates that can be selected along with the LIN speed selection for the best EMC performance.

•>20 kBaud: Wave-shaping disabled. For test and production configuration use only

Channel PSI5_x sync pulse enabled

•20 kBaud: For LIN compliant 20 kBaud communications

1

•10.4 kBaud: For 10.4 kBaud LIN communications. It also can be used for ISO-9141communication.

2) Output Manchester Code at the RXD Pin:

This Manchester code output feature allows one of four PSI5 current/voltage converters to output the voltage modulated Manchester signal through the RXD pin. The logic level changes of the output voltage represent the detection threshold triggering status of the selected PSI5_x channel current drawn. This feature provides a convenient access for using test and development tools to acquire satellite sensor data.

The LIN_CONFIG command is latched until a subsequent SPI update or internal reset. The response indicates the current state of the LIN_CONFIG bits.

Table 18. SPI Command, - LIN_CONFIG

LIN_CONFIG (0x50, 0x90)

| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|----|----|----|----|----|----|----|---|---|---|---|-----|------|------|------|------|------|
| Write | SI | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | х | х | REN | RXO1 | RXO0 | FSEL | LSR1 | LSR0 |
| Wille | SO | х | 0 | 1 | Р | 1 | 1 | 1 | 0 | х | х | REN | RXO1 | RXO0 | 0 | LSR1 | LSR0 |
| | | | | | | | | | | | | | | | | | |
| Read | SI | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | х | х | х | х | х | х | х | x |
| Neau | SO | х | 1 | 0 | Р | 1 | 1 | 1 | 0 | х | х | REN | RXO1 | RXO0 | 0 | LSR1 | LSR0 |

| | LIN Slew Rate Select | | | | | | | | |
|------------------------------|----------------------|----------|--|--|--|--|--|--|--|
| | LSR1 | Function | | | | | | | |
| $\text{Default} \rightarrow$ | 0 | 0 | 20 kBaud communications | | | | | | |
| | 0 | 1 | 10.4 kBaud communications | | | | | | |
| | 1 | 0 | > 20 kBaud communications (no pulse shaping) | | | | | | |
| | 1 | 1 | > 20 kBaud communications (no pulse shaping) | | | | | | |

| | Boost/Buck Frequency Selection | | | | | | | | | |
|------------------------------|--------------------------------|--------------------------------|--|--|--|--|--|--|--|--|
| | FSEL | Function | | | | | | | | |
| $\text{Default} \rightarrow$ | 0 | Low speed switching (140 kHz) | | | | | | | | |
| | 1 | High speed switching (245 kHz) | | | | | | | | |



Table 18. SPI Command, - LIN_CONFIG (continued)

| | | RX Output Select (for REN = 1) | | | | | | | | | |
|------------------------------|---------------------|--------------------------------|--|--|--|--|--|--|--|--|--|
| | RXO1 | RXO0 | Function | | | | | | | | |
| $\text{Default} \rightarrow$ | 0 | 0 | Satellite Channel 1 | | | | | | | | |
| | 0 | 1 | Satellite Channel 2 | | | | | | | | |
| | 1 | 0 | Satellite Channel 3 | | | | | | | | |
| | 1 | 1 | Satellite Channel 4 | | | | | | | | |
| | | | | | | | | | | | |
| | | | RXD Output Enable | | | | | | | | |
| | | REN | Function | | | | | | | | |
| De | fault \rightarrow | 0 | Normal function (RX outputs LIN signal) | | | | | | | | |
| | | 1 | Satellite monitor (RX outputs satellite Manchester signal) | | | | | | | | |

Power Supply Control SPI Commands

PS_CONTROL (0x51, 0x91)

The PS_CONTROL command is used for the system power management, including controls of boost supply, buck supply, sync supply, energy reserve, and V_{CC} , as shown in <u>Table 19</u>.

The command is latched until a subsequent SPI update or internal reset occurs. Some incident conditions, such as a thermal or overcurrent shutdown, could also deactivate the function. The response indicates the current state of system power management.

The charge / discharge fault (CDF) bit is cleared by an internal reset, or by a SPI command attempting to deactivate both switches, by setting ERC[1:0] to '00'. Unlike other registers that are only set to their default state by an internal reset, the ERC bits are set to their default state by a Sleep Reset.

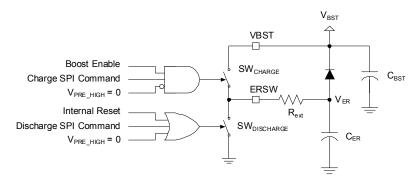


Figure 50. Energy Reserve Charge and Discharge Logic



| | | | | | | | PS_CO | NTROL | (0x51, | 0x91) | | | | | | | |
|-------|----|----|----|----|----|----|-------|-------|--------|-------|-----|-----|------|------|-----|------|------|
| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Write | SI | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | х | х | SC | BOE | х | BUE | ERC1 | ERC0 |
| Wille | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | BST | CDF | SC | BOE | 0 | BUE | ERC1 | ERC0 |
| | | | | | | | | | | | | | | | | | |
| Read | SI | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | х | х | х | х | х | х | х | x |
| Neau | SO | х | 1 | 0 | Р | 1 | 1 | 1 | 0 | х | х | REN | RXO1 | RXO0 | х | LSR1 | LSR0 |

Table 19. SPI Command, - PS_CONTROL

| | | | Boost Status |
|---------|---------------|-----|--|
| | | BST | Function |
| Default | \rightarrow | 0 | Boost voltage is less than threshold (~80% of target) |
| | | 1 | Boost voltage is greater than threshold (~80% of target) |
| | | | |

| | | | CER Charge/Discharge Switch Failure Status |
|---------|---------------|-----|---|
| | | CDF | Function |
| Default | \rightarrow | 0 | No overcurrent/temp fault on charge or discharge switches |
| | | 1 | Overcurrent/temp fault on charge or discharge switches |

| | | | Sync Supply Control |
|---------|---------------|----|------------------------|
| | | SC | Function |
| Default | \rightarrow | 0 | Deactivate sync supply |
| | | 1 | Activate sync supply |

| | | | Boost Enable |
|---------|---------------|-----|------------------|
| | | BOE | Function |
| | | 0 | Deactivate boost |
| Default | \rightarrow | 1 | Activate boost |

| | | | Buck Enable |
|---------|---------------|-----|-------------------------|
| | | BUE | Function |
| | | 0 | Deactivate buck request |
| Default | \rightarrow | 1 | Activate buck |

| | | | | Energy Reserve Con | trol |
|---------|---------------|------|------|--------------------|---------------|
| | | ERC1 | ERC0 | Discharge Switch | Charge switch |
| | | 0 | 0 | OFF | OFF |
| | | 0 | 1 | OFF | ON |
| Default | \rightarrow | 1 | 0 | ON | OFF |
| | | 1 | 1 | OFF | OFF |

ESR_DIAG (0x42, 0x82)

The ESR_DIAG command is used to initiate the energy reserve capacitor ESR test and read the VERDIAG voltage for the test.

Writing the enable bit (EN = '1') in the command will open the charge switch and close the discharge switch at the next Satsync falling edge, to allow the measurement of the ESR voltage. The enable state will remain set for repeating ESR test until a subsequent SPI ESR_DIAG command with EN = '0'. The ESR_DIAG command will respond to a read request with the most recent VERDIAG voltage from the A/D converter.



Table 20. SPI Command, - ESR_DIAG

| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|----|----|----|----|----|----|----|---|---|----|----|----|----|----|----|----|----|
| Write | SI | 0 | 1 | 0 | 0 | 0 | 0 | 1 | 0 | х | х | х | х | х | х | х | EN |
| Vinte | so | 0 | 1 | 0 | Р | 1 | 1 | 1 | 0 | х | х | х | х | х | х | х | EN |
| | | | | | | | | | | | | | | | | | |
| Read | SI | 1 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | х | х | х | х | х | х | х | x |
| uu | SO | 0 | 1 | 0 | Р | 1 | 1 | 1 | 0 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |

ESR_DIAG (0x42, 0x82)

| | | | Boost Status |
|---------|---------------|----|-----------------------------------|
| | | EN | Function |
| Default | \rightarrow | 0 | Disable ESR test (VERDIAG_EN = 0) |
| | | 1 | Enable ESR test (VERDIAG_EN = 1) |

| D7:D0 | Function |
|-------|--|
| Data | VERDIAG voltage (ADC[9:2]) 1.95 mV/count |

Analog Interface SPI Commands

AI_CONTROL (0x52, 0x92)

The AI_CONTROL command selects an analog voltage source to be routed to the analog diagnostics output AOUT pin. The lower 5 bits of the command are used for the selection to form the multiplexed analog measurement.

The AI_CONTROL command is latched until a subsequent SPI update, or a DIAG_CLR SPI command, or an internal reset occurs. The response indicates the current state of the analog interface control.

Table 21. SPI Command - AI_CONTROL

| | | | | | | Α | | ITROL | . (0X52 | 2, 0X92 | 2) | | | | | | |
|-------|----|----|----|----|----|----|----|-------|---------|---------|----|---|------|------|------|------|------|
| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | | | | | | | | |
| Write | SI | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 0 | Х | Х | Х | AIC4 | AIC3 | AIC2 | AIC1 | AIC0 |
| Wille | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | AIC4 | AIC3 | AIC2 | AIC1 | AIC0 |
| | | | | | | | | | | | | | | | | | |
| Read | SI | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 0 | Х | Х | Х | Х | Х | х | Х | х |
| Neau | SO | 0 | 1 | 0 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | AIC4 | AIC3 | AIC2 | AIC1 | AIC0 |

| | | | | Analo | g Interfa | ce Request Bits | |
|------|------|------|-------|-------|-----------|-----------------|------------|
| AIC4 | AIC3 | AIC2 | ACIC1 | AIC0 | HEX | Function | Multiplier |
| 0 | 0 | 0 | 0 | 0 | \$00 | RSENSE | ÷1 |
| 0 | 0 | 0 | 0 | 1 | \$01 | VERDIAG | x 5 |
| 0 | 0 | 0 | 1 | 0 | \$02 | VPWR | ÷ 5.6 |
| 0 | 0 | 0 | 1 | 1 | \$03 | VBST | ÷ 8.5 |
| 0 | 0 | 1 | 0 | 0 | \$04 | VER | ÷ 8.5 |
| 0 | 0 | 1 | 0 | 1 | \$05 | VBUCK | ÷ 2.8 |
| 0 | 0 | 1 | 1 | 0 | \$06 | VSYNC | ÷ 5 |
| 0 | 0 | 1 | 1 | 1 | \$07 | IN1 | ÷ 2 |
| 0 | 1 | 0 | 0 | 0 | \$08 | IN2 | ÷ 2 |
| 0 | 1 | 0 | 0 | 1 | \$09 | IN3 | ÷ 2 |
| 0 | 1 | 0 | 1 | 0 | \$0A | IN4 | ÷ 2 |
| 0 | 1 | 0 | 1 | 1 | \$0B | IN5 | ÷ 2 |
| 0 | 1 | 1 | 0 | 0 | \$0C | IN6 | ÷ 2 |
| 0 | 1 | 1 | 0 | 1 | \$0D | IN7 | ÷ 2 |

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| | | | | | Analo | g Interfa | ce Request Bits | |
|-----------------------|---|---|---|---|-------|-----------|------------------------|-------|
| | 0 | 1 | 1 | 1 | 0 | \$0E | IN8 | ÷ 2 |
| | 0 | 1 | 1 | 1 | 1 | \$0F | IN9 | ÷ 2 |
| | 1 | 0 | 0 | 0 | 0 | \$10 | Unused (High-Z-output) | |
| | 1 | 0 | 0 | 0 | 1 | \$11 | OUT1-D | ÷ 5.6 |
| | 1 | 0 | 0 | 1 | 0 | \$12 | OUT1-S | ÷ 5.6 |
| | 1 | 0 | 0 | 1 | 1 | \$13 | OUT2-D | ÷ 5.6 |
| | 1 | 0 | 1 | 0 | 0 | \$14 | OUT2-S | ÷ 5.6 |
| | 1 | 0 | 1 | 0 | 1 | \$15 | Unused (High-Z-output) | |
| | 1 | 0 | 1 | 1 | 0 | \$16 | Unused (High-Z-output) | |
| | 1 | 0 | 1 | 1 | 1 | \$17 | Unused (High-Z-output) | |
| | 1 | 1 | 0 | 0 | 0 | \$18 | Unused (High-Z-output) | |
| | 1 | 1 | 0 | 0 | 1 | \$19 | Unused (High-Z-output) | |
| | 1 | 1 | 0 | 1 | 0 | \$1A | Unused (High-Z-output) | |
| | 1 | 1 | 0 | 1 | 1 | \$1B | Unused (High-Z-output) | |
| | 1 | 1 | 1 | 0 | 0 | \$1C | Unused (High-Z-output) | |
| | 1 | 1 | 1 | 0 | 1 | \$1D | Unused (High-Z-output) | |
| | 1 | 1 | 1 | 1 | 0 | \$1E | Unused (High-Z-output) | |
| Default \rightarrow | 1 | 1 | 1 | 1 | 1 | \$1F | Unused (High-Z-output) | |

DC Sensor Interface SPI Commands

DCS_CONTROL (0x53, 0x93)

The DCS_CONTROL command is used to control two internal analog multiplexers for the DC sensor input interface activation, which include:

•Sensor Channel Selection (SS): Determines which DC sensor input shall be connected to the internal regulated bias voltage supply for the analog diagnostic output AOUT.

•Bias Voltage Selection (VS): Determines which one of four predefined voltages shall be used for the bias supply applied on the selected DC sensor output stage.

The DCS_CONTROL command is latched until a subsequent SPI update, or a DIAG_CLR SPI command, or an internal reset occurs. Some incident conditions, such as thermal or overcurrent shutdown could deactivate the selections. The response of the command indicates the current state of the DC sensor interface control.

Table 22. SPI Command - DCS_CONTROL

| | DCS_CONTROL (0X53, 0X93) | | | | | | | | | | | | | | | | |
|-------|--------------------------|----|----|----|----|----|----|---|---|-----|-----|-----|-----|-----|-----|---|---|
| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Write | SI | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 1 | SS3 | SS2 | SS1 | SS0 | VS1 | VS0 | х | х |
| Wille | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | SS3 | SS2 | SS1 | SS0 | VS1 | VS0 | 0 | 0 |
| | | | | | | | | | | | | | | | | | |
| Read | SI | 1 | 0 | 0 | 1 | 0 | 0 | 1 | 1 | Х | Х | Х | Х | Х | Х | Х | Х |
| licuu | SO | 0 | 1 | 0 | Р | 1 | 1 | 1 | 0 | SS3 | SS2 | SS1 | SS0 | VS1 | VS0 | 0 | 0 |

| | SS3 | SS2 | SS1 | SS0 | Input Sensor Select |
|----------------------|-----|-----|-----|-----|---|
| Default $ ightarrow$ | 0 | 0 | 0 | 0 | Voltage Supply not connected to any INx |
| | 0 | 0 | 0 | 1 | Voltage Supply connected to IN1 |
| | 0 | 0 | 1 | 0 | Voltage Supply connected to IN2 |
| | 0 | 0 | 1 | 1 | Voltage Supply connected to IN3 |
| | 0 | 1 | 0 | 0 | Voltage Supply connected to IN4 |
| | 0 | 1 | 0 | 1 | Voltage Supply connected to IN5 |
| | 0 | 1 | 1 | 0 | Voltage Supply connected to IN6 |
| | 0 | 1 | 1 | 1 | Voltage Supply connected to IN7 |

| SS3 | SS2 | SS1 | SS0 | Input Sensor Select |
|-----|-----|-----|-----|--|
| 1 | 0 | 0 | 0 | Voltage Supply connected to IN8 |
| 1 | 0 | 0 | 1 | Voltage Supply connected to IN9 |
| 1 | 0 | 1 | 0 | Voltage Supply not connected to any INx (reserved) |
| 1 | 0 | 1 | 1 | Voltage Supply not connected to any INx (reserved) |
| 1 | 1 | 0 | 0 | Voltage Supply not connected to any INx (reserved) |
| 1 | 1 | 0 | 1 | Voltage Supply not connected to any INx (reserved) |
| 1 | 1 | 1 | 0 | Voltage Supply not connected to any INx (reserved) |
| 1 | 1 | 1 | 1 | Voltage Supply not connected to any INx (reserved) |

Default ightarrow

| VS | 61 | VS0 | Supply Voltage Select |
|----|----|-----|------------------------|
| (| 0 | 0 | Supply Voltage = 1.5 V |
| (| 0 | 1 | Supply Voltage = 2.5 V |
| 1 | 1 | 0 | Supply Voltage = 5.0 V |
| 1 | 1 | 1 | Supply Voltage = 6.5 V |

Safing Logic SPI Commands

SAFE_CONTROL (0x58, 0x98)

The SAFE_CONTROL command is used for the following safing logic features:

- •Safing State Machine (SSM) operation mode control
- •Arming output test mode control, the Arming outputs (via ARM and DISARM pins) can only be tested while SSM is in Diag mode
- •Request of the number of valid data messages received from sensors
- •Error status of the safing logic

The Sequence Error (SE) bit is cleared upon the Satsync rising edge.

Once an offset of the digital A_SENSOR data is detected at the HPF, which corresponds to an offset falls outside of $\pm 25\%$ of the expected output, an internal offset error signal will be created and the Offset Error (OE) bit will be set. The HPF will continue process the A_SENSOR data received from the ACD, but ASENSOR_RG will not be updated with the OE bit set. The OE bit is cleared upon the SPI read only if the offset error condition is no longer present, which means the A_SENSOR input has returned to the valid range.

Table 23. SPI Command - SAFE_CONTROL

SAFE_CONTROL (0X58, 0X98)

| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|----|----|----|----|----|----|----|---|---|-----|-----|-----|-----|-----|-----|-----|-----|
| Write | SI | 0 | 1 | 0 | 1 | 1 | 0 | 0 | 0 | Х | Х | Х | Х | MR1 | MR0 | TEN | LEV |
| White | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | VD3 | VD2 | VD1 | VD0 | MD1 | MD0 | OE | SE |
| | | | | | | | | | | | | | | | | | |

| Read | SI | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 0 | Х | Х | Х | Х | Х | Х | Х | Х |
|------|----|---|---|---|---|---|---|---|---|-----|-----|-----|-----|-----|-----|----|----|
| neuu | SO | 0 | 1 | 0 | Р | 1 | 1 | 1 | 0 | VD3 | VD2 | VD1 | VD0 | MD1 | MD0 | OE | SE |

| | MR1 | MR0 | Mode Request | | | | | | | | |
|-----------------------|---------------------------------------|----------|------------------------------------|--|--|--|--|--|--|--|--|
| Default \rightarrow | 0 | 0 | No mode change requested | | | | | | | | |
| | 0 | 1 | Request change to Safing Mode | | | | | | | | |
| | 1 | 0 | Request change to Scrap Mode | | | | | | | | |
| | 1 | 1 | No mode change requested | | | | | | | | |
| | | | | | | | | | | | |
| | TEN | | Arming Output Test Enable | | | | | | | | |
| Default \rightarrow | 0 | ARM/DISA | M/DISARM output Test mode disabled | | | | | | | | |
| | 1 ARM/DISARM output Test mode enabled | | | | | | | | | | |

| | LEV | | Arming Output Test Level Select |
|-----------------------|-----|--------------|---|
| Default $ ightarrow$ | 0 | Set ARM=0 |), DISARM = 0 if TEN = 1 and in Diag mode |
| | 1 | Set ARMN: | =1, DISARM = 1 if TEN = 1 and in Diag mode |
| | | | |
| | VD3 | 3:VD0 | Valid Data Count |
| | x | XXX | Number of digital sensor messages received with valid sensor data |
| | | 1 | |
| | MD1 | MD0 | Mode Status |
| Default \rightarrow | 0 | 0 | Startup Mode or Diag mode |
| | 0 | 1 | Safing mode |
| | 1 | 0 | Scrap mode |
| | 1 | 1 | Arming mode |
| | | | |
| | OE | | A_SENSOR Data Offset Error |
| Default $ ightarrow$ | 0 | Offset error | r not detected on analog safing sensor input |
| | 1 | Offset error | detected on analog safing sensor input |
| | | | |
| | SE | | Sequence Error |
| Default \rightarrow | 0 | Sequence | error not detected |
| | 1 | Sequence | error detected |

SCRAP_SEED (0x59, 0x99)

The SCRAP_SEED command is a read-only command used to request an 8-bit seed value for the safing state machine to enter into Arming mode. Upon reception of this command, the 33789 freezes the free-running seed counter, calculates a key value, and populates the frozen value as the response.

A subsequent command that submits the key value (SCRAP_KEY) will allow the entry into Arming mode.

Table 24. SPI Command, - SCRAP_SEED

| | SCRAP_SEED (0x59, 0x99) | | | | | | | | | | | | | | | | |
|---------|-------------------------|----|----|----|----|----|----|---|---|----|----|----|----|----|----|----|----|
| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Write * | SI | 0 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | х | х | х | х | х | х | х | х |
| write | SO | 0 | 0 | 0 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| | | | | 1 | 1 | | | | 1 | 1 | 1 | 1 | | | 1 | | |
| Read | SI | 1 | 0 | 0 | 1 | 1 | 0 | 0 | 1 | х | х | х | х | х | х | х | х |
| Reau | SO | 0 | 1 | 0 | Р | 1 | 1 | 1 | 0 | S7 | S6 | S5 | S4 | S3 | S2 | S1 | S0 |
| | | | | | | | | | | | | | | | | | |
| | | | | | | | | | | | 1 | | | | | | |

| S7:S0 | Function |
|-------|---------------------------------------|
| SEED | 8-bit seed value for Scrap Mode entry |
| | |

* The Write response will always be ERROR with the RE bit set to '1'

SCRAP_KEY (0x5A, 0x9A)

The SCRAP_KEY command is a write-only command used to request an 8-bit key value for the Safing state machine to enter into Scrap mode. Upon reception of this command, the 33789 checks the submitted key value against the internally calculated key value, if they are equal, enters Arming mode.

Periodic SCRAP_KEY commands are required for the Safing state machine to remain in Arming mode.



Table 25. SPI Command, - SCRAP_KEY

| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------|----|-----|----|----|----|----|----------|---|---|----|----|----|----|----|----|----|----|
| Write | SI | 0 | 1 | 0 | 1 | 1 | 0 | 1 | 0 | K7 | K6 | K5 | K4 | K3 | K2 | K1 | K0 |
| Wille | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | | | | | | | | | | | | | | | | |
| Read * | SI | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 0 | х | х | х | х | х | х | х | х |
| Neau | SO | 0 | 0 | 0 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| | | | | | | | | | | | | | | | | | |
| | | K7. | K0 | | | | Function | | | |] | | | | | | |

SCRAP_KEY (0x5A, 0x9A)

8-bit key value for Scrap Mode entry * The READ response will always be ERROR with the RE bit set to '1'

T UNLOCK (0x4D, 0x8D)

The T UNLOCK command is a write-only command used to submit an unlock code to the Safing state machine to enable updating of the safing thresholds. The response from the 33789 is a fixed write response with all of data bits set to '0'.

This command is only valid while the Safing state machine is in Start-up mode, and attempting T_UNLOCK commands while in other modes will result in an ERROR response with the RE bit set.

Table 26. SPI Command, - T_UNLOCK

KEY

| | | | | | | | _ | | , - | - / | | | | | | | |
|-------|-------|----|----|----|----|----|----|---|-----|-----|----|----|----|----|----|----|----|
| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | SI | 0 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | U7 | U6 | U5 | U4 | U3 | U2 | U1 | U0 |
| Write | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | SO ** | 0 | 0 | 0 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| | | | | | | | | | | | | 1 | | | | | 1 |

T UNLOCK (0x4D, 0x8D)

| Read * | SI | 1 | 0 | 0 | 0 | 1 | 1 | 0 | 1 | х | х | х | х | х | х | х | х |
|--------|----|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| Read | SO | 0 | 0 | 0 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |

| U7:U0 | Function |
|--------|---|
| UNLOCK | 8-bit key value for safing threshold update |

* The Read response will always be ERROR with the RE bit set to '1'

** The response to a Write while not in Start-up Mode results in ERROR with RE = 1

SAFE_THx (0x45 ~ 0x4C, 0x85 ~ 0x8C)

The SAFE_THx command is a read/write command used for reading and writing the 8 safing threshold values.

Writing of the safing thresholds can be enabled only if the following conditions are all met:

•The previously received message was a T_UNLOCK command

•The Unlock code in the T_UNLOCK command is correct per definition

•The Safing state machine is in Start-up mode

Reading of the safing thresholds is enabled in any state, and requires no prior unlock message.

A total of eight safing thresholds can be read or written using the eight commands as shown in Table 27.

Table 27. SPI Command, - SAFE_THx

SAFE_THx (0x45~0x4C, 0x85~0x8C)

| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|-------|-------|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|----|
| | SI | 0 | 1 | 0 | 0 | A3 | A2 | A1 | A0 | DE | T6 | T5 | T4 | Т3 | T2 | T1 | Т0 |
| Write | so | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | DE | T6 | T5 | T4 | Т3 | T2 | T1 | Т0 |
| | SO ** | 0 | 0 | 0 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |



Table 27. SPI Command, - SAFE_THx

| Read * | SI | 1 | 0 | 0 | 0 | A3 | A2 | A1 | A0 | х | х | х | х | х | х | х | x |
|--------|----|---|---|---|---|----|----|----|----|----|----|----|----|----|----|----|----|
| Read | SO | 0 | 1 | 0 | Р | 1 | 1 | 1 | 0 | DE | T6 | T5 | T4 | Т3 | T2 | T1 | Т0 |

| Comman d | A3 | A2 | A1 | A0 | Function |
|---------------|----|----|----|----|----------------------------|
| 0x45,0x85 | 0 | 1 | 0 | 1 | Safing Threshold 0 Command |
| 0x46,0x86 | 0 | 1 | 1 | 0 | Safing Threshold 1 Command |
| 0x47,0x87 | 0 | 1 | 1 | 1 | Safing Threshold 2 Command |
| 0x48,0x88 | 1 | 0 | 0 | 0 | Safing Threshold 3 Command |
| 0x49,0x89 | 1 | 0 | 0 | 1 | Safing Threshold 4 Command |
| 0x4A,0x8 A | 1 | 0 | 1 | 0 | Safing Threshold 5 Command |
| 0x4B,0x8 B | 1 | 0 | 1 | 1 | Safing Threshold 6 Command |
| 0x4C,0x8 C | 1 | 1 | 0 | 0 | Safing Threshold 7 Command |

 $\stackrel{\text{Default}}{\rightarrow}$

| DE | Dwell Extension |
|----|--------------------------|
| 0 | Dwell Extension = 255 ms |
| 1 | Dwell Extension = 2 s |

| T6:T0 | Safing Threshold |
|-----------|-----------------------------|
| THRESHOLD | 7-bit Safing Threshold data |

* Response when [T_UNLOCK register value] = [DE, T6:T0]^0xAD

** Response when any of the following conditions exist (ERROR with RE = 1)

1 Previous SPI command was not T_UNLOCK write

2 [T_UNLOCK register value] <> [DE, T6:T0]^0xAD

3 Not in Start-up Mode

Watchdog Control SPI Commands

WDOG_FEED (0x4E, 0x8E)

The WDOG_FEED command is a write-only command used to service the watchdog.

Only watchdog 'high' or watchdog 'low' is accepted, any other values are ignored by the logic.

The 33789 responds to the command is a fixed write response with all data bits set to '0'.

Any attempted read access to WDOG_FEED will result in an ERROR response with the RE bit set to '1'.

Table 28. SPI Command, - WDOG_FEED

| | WDOG_FEED (0x4E) | | | | | | | | | | | | | | | | |
|--------|------------------|----------|---------|-----------|----------|--------|-----------|----------|------------|----|----|----|----|----|----|----|----|
| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Write | SI | 0 | 1 | 0 | 0 | 1 | 1 | 1 | 0 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 |
| Wille | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | | | | | | | | | | | | | | | | |
| Read * | SI | 1 | 0 | 0 | 0 | 1 | 1 | 1 | 0 | х | х | х | х | х | х | х | х |
| neau | SO | 0 | 0 | 0 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| | | * The RE | AD resp | onse will | always t | e ERRO | R with th | e RE bit | set to '1' | | | | | | | | |

| D7:D0 | Function |
|-------|--------------------------|
| 0x55 | Watchdog feed value LOW |
| 0xAA | Watchdog feed value HIGH |
| Other | No effect |

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WDOG_TEST (0x55, 0x95)

The WDOG_TEST command is a write-only command used to put the watchdog state machine into the "wait for refresh failure" state. This can be used to test the watchdog error.

The 33789 responds to the command is a fixed write response with all data bits set to '0'.

Any attempted read access to WDOG_TEST will result in an ERROR response with the RE bit set to '1'.

Table 29. SPI Command, - WDOG_TEST

WDOG_TEST (0x55, 0x95)

| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------|----|-----------|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| Write | SI | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | х | х | х | х | х | х | х | х |
| Mille | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | | | | | | | | | | | | | | | | |
| Read * | SI | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | х | х | х | х | х | х | х | х |
| Read | SO | 0 | 0 | 0 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| | | + = = = = | | | | | | | | | | | | | | | |

* The READ response will always be ERROR with the RE bit set to '1

Other SPI Commands

DIAG_CLR (0x54, 0x94)

The DIAG_CLR command is a write-only command used to force all diagnostic controls to their default state. It affects two latched commands: AI_CONTROL and DCS_CONTROL. The response to the command is a fixed write response with all data bits set to '0'. Any attempted read access to DIAG_CLR will result in an ERROR response with the RE bit set to '1'.

Table 30. SPI Command, - DIAG_CLR

DIAG_CLR (0x54, 0x94)

| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------|----|----|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| Write | SI | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | х | х | х | х | х | х | х | х |
| Tinte | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | | | | | | | | | | | | | | | | |
| Read * | SI | 1 | 0 | 0 | 1 | 0 | 1 | 0 | 0 | х | х | х | х | х | х | х | х |
| Read | SO | 0 | 0 | 0 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| | | | | | | | | | | | | | | | | | |

* The READ response will always be ERROR with the RE bit set to '1'

STATUS (0x56, 0x96)

The STATUS command is a read-only command used to retrieve the C33789 status for diagnostic purposes. The response to the command is a read response containing the current 33789 status.

Attempted write access to STATUS will result in an ERROR response with the RE bit set to '1'.

There are two status bits latched in the 33789 after they are set to their 'active' states. Once the bits are read via a STATUS command, they are set to their 'inactive' states. Only an internal reset and the STATUS read command can set these bits to their 'inactive' states, and immediately after either of them occur, the states are updated to reflect their true status. This is designed to ensure intermittent error conditions can be detected by the system.

The following table defines these bits and their 'active' and 'inactive' states:

| Table ST. TWO Latched Statu | Table 31. | Two Latched | Status |
|-----------------------------|-----------|--------------------|--------|
|-----------------------------|-----------|--------------------|--------|

| Bit Name | Function | Active State | Inactive State |
|----------|---------------------------------|--------------|----------------|
| вот | Boost Supply Overtemperature | 1 | 0 |
| IGN | IGNSTAT state | 0 | 1 |

The WDR bit is set whenever the 33789 detects an incorrect watchdog refresh, and can be cleared by a WSM Reset or by a correct watchdog feed.



| | | | | | | | 5 | IAIU | S(0X5 | 6, 0x96 |) | | | | | | |
|--|--|----|---|----|--------------------|---------|---------|----------|----------|-----------|-------------|-------------|------------|-------|-----|-----|-----|
| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| | SI | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 0 | Х | Х | Х | Х | Х | Х | Х | Х |
| Write * | SO | 0 | 0 | 0 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| | | | 1 | | 1 | | | | | | | - | | | | | |
| | SI | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 0 | Х | Х | Х | Х | Х | Х | Х | Х |
| Read | SO | 0 | 1 | 0 | Р | 1 | 1 | 1 | 0 | SOT | DCOT | BOT | IGN | WU | WS1 | WS0 | WDR |
| | 1 | | 1 | | | | | | | | | | | | | | |
| | | Γ | SOT | r | | | | | | Svnc S | upply Ove | rtempera | ature Erro | or | | | |
| [| Default \rightarrow | - | 0 | | Sync si | upply c | vertem | peratu | re error | not dete | | | | - | | | |
| | | - | 1 | | Sync si | upply o | vertem | peratu | re error | detected | I | | | | | | |
| | | L | | | | | | | | | | | | | | | |
| | | ſ | DCO | т | | | | | DC | Sensor | Regulator | Overten | perature | Error | | | |
| E | Default \rightarrow | | 0 DC sensor regulator overtemperature error not detected 1 DC sensor regulator overtemperature error detected | | | | | | | | | | | | | | |
| | 1 DC sensor regulator overtemperature error detected | | | | | | | | | | | | | | | | |
| | | | | | | | | | | | | | | | | | |
| BOT Boost Supply Overtemperature Error Default → 0 Boost supply overtemperature error not detected | | | | | | | | | | | | | | | | | |
| E | Default \rightarrow | _ | 0 | | | | | | | | | | | | | | |
| | | | 1 | | Boost s | supply | overten | nperatu | ire erro | r detecte | d | | | | | | |
| | | Г | IGN | | | | | | | | ICNET | AT 04444 | | | | | |
| | | - | 0 | | V _{PWR} < | GNS | TAT th | reshold | VDOT | 1.15.7 | IGNST | AT State | | | | | |
| C | Default \rightarrow | - | 1 | | V _{PWR} ≥ | | | | | | | | | | | | |
| | | L | | | 1 0010 | | | | D01_ | 0 0 | | | | | | | |
| | | ſ | wu | | | | | | | | Wake F | Pin State | | | | | |
| | | - | 0 | | WAKE | Pin = (|) | | | | | | | | | | |
| [| Default \rightarrow | | 1 | | WAKE | Pin = 1 | | | | | | | | | | | |
| | | F | | | | | | | | | | | | | | | |
| | | _ | | | | | | | | Wa | tchdog Sta | | | | | | |
| | Defeult | - | WS | 1 | WS0 | | Mataba | lag Cta | to - "IN | | | Funct | ion | | | | |
| L | Default \rightarrow | - | 0 | | 0 | | | - | te = "IN | | d ARM_LO | CKOUT | - 0 | | | | |
| | | F | 0 | | 1 | | | | | | d ARM_LO | | | | | | |
| | | - | 1 | | 1 | | | <u> </u> | | | EST" or "WI | | | , | | | |
| | | L | • | | • | | | | | | | | | | | | |
| WDR Watchdog Error Status | | | | | | | | | | | | | | | | | |
| [| Default \rightarrow | F | 0 | | Previou | is rese | t was n | ot caus | sed by | watchdog | - | | | | | | |
| | | Ē | 1 | | Previou | is rese | t was c | aused | by wate | chdog err | or | | | | | | |
| | | L | | | | | | | | • | with RE b | it set to " | 1" | | | | |

STATUS(0x56, 0x96)

Table 32. SPI Command - STATUS

OUT1_CTL (0x5B, 0x9B) and OUT2_CTL (0x5C, 0x9C)

The OUTx_CTL commands are used to activate/deactivate the general purpose drivers. OUT1_CTL is for driver1 (OUT1_D, OUT1_S), and OUT2_CTL is for driver 2 (OUT2_D, OUT2_S).

They are also used to configure the PWM duty cycle. Setting the duty cycle to 111111b will turn the driver ON without PWM, i.e. 100% duty cycle. Setting the duty cycle to 000000b will deactivate the driver, i.e. 0% duty cycle, thus it is considered as an "OFF" command.

The OUTx_CTL commands also configure the drivers as a Highside Driver or Low-side Driver.

The response from the command indicates the echo of the driver designation, comparator diagnostics information, and shows if a thermal shutdown occurred.



Table 33. SPI Command, - OUT1_CTL

OUT1_CTL (0x5B, 0x9B)

| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|--------|----|----|----|----|----|----|----|---|---|-----|-----|-------|-------|------|------|----|---|
| Write | SI | 0 | 1 | 0 | 1 | 1 | 0 | 1 | 1 | DC5 | DC4 | DC3 | DC2 | DC1 | DC0 | HS | х |
| Wille | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | TS | 0 | OFF23 | OFF13 | ON23 | ON13 | HS | 0 |
| | | | | | | | | | | | | | | | | | |
| Read * | SI | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | х | х | х | х | х | х | х | х |
| Neau | SO | 0 | 1 | 0 | Р | 1 | 1 | 1 | 0 | TS | 0 | OFF23 | OFF13 | ON23 | ON13 | HS | 0 |

| | | DC5:D C0 | DC% | | DC5:D C0 | DC% | | DC5:D C0 | DC% | | HS | Driver Configuration Select |
|----------------------|----|-------------|------|----|-------------|------|----|-------------|------|----------------------|-------|---|
| Default $ ightarrow$ | 0 | 000000 | OFF | 22 | 010110 | 34.9 | 43 | 101011 | 68.3 | Default $ ightarrow$ | 0 | LS Driver |
| - | 1 | 000001 | 1.6 | 23 | 010111 | 36.5 | 44 | 101100 | 69.8 | | 1 | HS Driver |
| - | 2 | 000010 | 3.2 | 24 | 011000 | 38.1 | 45 | 101101 | 71.4 | | | |
| - | 3 | 000011 | 4.8 | 25 | 011001 | 39.7 | 46 | 101110 | 73.0 | | ON13 | Driver ON 1/3 V _{PWR} Comparator Result |
| - | 4 | 000100 | 6.3 | 26 | 011010 | 41.3 | 47 | 101111 | 74.6 | Default $ ightarrow$ | 0 | Diagnosis below threshold |
| - | 5 | 000101 | 7.9 | 27 | 011011 | 42.9 | 48 | 110000 | 76.2 | | 1 | Diagnosis above threshold |
| - | 6 | 000110 | 9.5 | 28 | 011100 | 44.4 | 49 | 110001 | 77.8 | | | |
| | 7 | 000111 | 11.1 | 29 | 011101 | 46.0 | 50 | 110010 | 79.4 | | ON23 | Driver ON 2/3 V _{PWR} Comparator Result |
| | 8 | 001000 | 12.7 | 30 | 011110 | 47.6 | 51 | 110011 | 81.0 | Default $ ightarrow$ | 0 | Diagnosis below threshold |
| | 9 | 001001 | 14.3 | 31 | 011111 | 49.2 | 52 | 110100 | 82.5 | | 1 | Diagnosis above threshold |
| | 10 | 001010 | 15.9 | 32 | 100000 | 50.8 | 53 | 110101 | 84.1 | | | |
| | 11 | 001011 | 17.5 | 33 | 100001 | 52.4 | 54 | 110110 | 85.7 | | OFF13 | Driver OFF 1/3 V _{PWR} Comparator Result |
| | 12 | 001100 | 19.0 | 34 | 100010 | 54.0 | 55 | 110111 | 87.3 | Default $ ightarrow$ | 0 | Diagnosis below threshold |
| | 13 | 001101 | 20.6 | 35 | 100011 | 55.6 | 56 | 111000 | 88.9 | | 1 | Diagnosis above threshold |
| | 14 | 001110 | 22.2 | 36 | 100100 | 57.1 | 57 | 111001 | 90.5 | | | |
| | 15 | 001111 | 23.8 | 37 | 100101 | 58.7 | 58 | 111010 | 92.1 | | OFF23 | Driver OFF 2/3 V _{PWR} Comparator Result |
| | 16 | 010000 | 25.4 | 38 | 100110 | 60.3 | 59 | 111011 | 93.7 | Default $ ightarrow$ | 0 | Diagnosis below threshold |
| | 17 | 010001 | 27.0 | 39 | 100111 | 61.9 | 60 | 111100 | 95.2 | | 1 | Diagnosis above threshold |
| | 18 | 010010 | 28.6 | 40 | 101000 | 63.5 | 61 | 111101 | 96.8 | | | |
| Ē | 19 | 010011 | 30.2 | 41 | 101001 | 65.1 | 62 | 111110 | 98.4 | | TS | Thermal Shutdown Indicator |
| | 20 | 010100 | 31.7 | 42 | 101010 | 66.7 | 63 | 111111 | ON | Default $ ightarrow$ | 0 | No shutdown has occurred |
| | 21 | 010101 | 33.3 | | | | | | | | 1 | Thermal shutdown has occurred* |

* Status is cleared after OFF command is sent



Table 34. SPI Command, - OUT2_CTL

| | | | | | | | 0012_0 | | , 0,00 | •, | | | | | | | | | | |
|----------------------|----|-------------|------|----|-------------|------|--------|-------------|--------|-------|-------------------|-------|--|-----------|----------------------|---------|----------|--|--|--|
| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | | | |
| Write | SI | 0 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | DC5 | DC4 | DC3 | DC2 | DC1 | DC0 | HS | x | | | |
| Vince | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | TS | 0 | OFF23 | OFF13 | ON23 | ON13 | HS | 0 | | | |
| | | | | | | | | | | | | | | | | | | | | |
| Read * | SI | 1 | 0 | 0 | 1 | 1 | 1 | 0 | 0 | х | х | х | х | х | х | х | x | | | |
| | SO | 0 | 1 | 0 | Р | 1 | 1 | 1 | 0 | TS | 0 | OFF23 | OFF13 | ON23 | ON13 | HS | 0 | | | |
| | | | | | | | | | | | | | | | | | | | | |
| | | DC5:D C0 | DC% | | DC5:D C0 | DC% | | DC5:D C0 | DC% | | | HS | Driver Configuration Select | | | | | | | |
| Default $ ightarrow$ | 0 | 000000 | OFF | 22 | 010110 | 34.9 | 43 | 101011 | 68.3 | Defau | iit \rightarrow | 0 | LS Drive | er | | | | | | |
| | 1 | 000001 | 1.6 | 23 | 010111 | 36.5 | 44 | 101100 | 69.8 | | | 1 | HS Drive | er | | | | | | |
| | 2 | 000010 | 3.2 | 24 | 011000 | 38.1 | 45 | 101101 | 71.4 | | | | | | | | | | | |
| - | 3 | 000011 | 4.8 | 25 | 011001 | 39.7 | 46 | 101110 | 73.0 | | | ON13 | Driver C | ON 1/3 V | _{PWR} Com | parator | Result | | | |
| - | 4 | 000100 | 6.3 | 26 | 011010 | 41.3 | 47 | 101111 | 74.6 | Defau | iit \rightarrow | 0 | Diagnos | is below | threshold | ł | | | | |
| | 5 | 000101 | 7.9 | 27 | 011011 | 42.9 | 48 | 110000 | 76.2 | | | 1 | Diagnos | is above | threshole | d | | | | |
| | 6 | 000110 | 9.5 | 28 | 011100 | 44.4 | 49 | 110001 | 77.8 | | | | | | | | | | | |
| | 7 | 000111 | 11.1 | 29 | 011101 | 46.0 | 50 | 110010 | 79.4 | | | ON23 | Driver ON 2/3 V _{PWR} Comparator Result | | | | | | | |
| | 8 | 001000 | 12.7 | 30 | 011110 | 47.6 | 51 | 110011 | 81.0 | Defau | III \rightarrow | 0 | Diagnosis below threshold | | | | | | | |
| - | 9 | 001001 | 14.3 | 31 | 011111 | 49.2 | 52 | 110100 | 82.5 | | | 1 | Diagnosis above threshold | | | | | | | |
| - | 10 | 001010 | 15.9 | 32 | 100000 | 50.8 | 53 | 110101 | 84.1 | | | | r | | | | | | | |
| - | 11 | 001011 | 17.5 | 33 | 100001 | 52.4 | 54 | 110110 | 85.7 | | | OFF13 | Driver C | DFF 1/3 \ | / _{PWR} Cor | nparato | r Result | | | |
| | 12 | 0000 | 19.0 | 34 | 100010 | 54.0 | 55 | 110111 | 87.3 | Defau | llt → | 0 | Diagnosis below threshold | | | | | | | |
| | 13 | | 20.6 | 35 | 100011 | 55.6 | 56 | 111000 | 88.9 | | | 1 | Diagnosis above threshold | | | | | | | |
| - | 14 | | 22.2 | 36 | 100100 | 57.1 | 57 | 111001 | 90.5 | | | | | | | | | | | |
| - | 15 | | 23.8 | 37 | 100101 | 58.7 | 58 | 111010 | 92.1 | | | | Driver C | OFF 2/3 \ | / _{PWR} Cor | mparato | r Result | | | |
| - | 16 | | 25.4 | 38 | 100110 | 60.3 | 59 | 111011 | 93.7 | Defau | ılt → | 0 | Diagnos | is below | threshold | ł | | | | |
| ŀ | | 010001 | 27.0 | 39 | 100111 | 61.9 | 60 | 111100 | 95.2 | | | 1 | Diagnos | is above | threshold | d | | | | |
| ŀ | 18 | 0.00.0 | 28.6 | 40 | 101000 | 63.5 | 61 | 111101 | 96.8 | | | | | | | | 1 | | | |
| ŀ | 19 | 0.00 | 30.2 | 41 | 101001 | 65.1 | 62 | 111110 | 98.4 | | | TS | Thermal shutdown indicator | | | | | | | |
| | 20 | | 31.7 | 42 | 101010 | 66.7 | 63 | 111111 | ON | Defau | ılt → | 0 | No shutdown has occurred | | | | | | | |
| l | 21 | 010101 | 33.3 | | | | | | | | | 1 | Thermal | shutdov | vn has oc | curred* | | | | |
| | | | | | | | | | | | * • • | | | | | | | | | |

OUT2_CTL (0x5C, 0x9C)

* Status is cleared after OFF command is sent

NOP (0x57, 0x97)

The NOP command is used to retrieve the response from a previous command without altering anything within the 33789. The response for the command is a fixed write response with all data bits set to '0'. Any attempted read access to NOP will result in an ERROR response with the RE bit set to '1'.

Table 35. SPI Command, - NOP

| | NOP (0x57, 0x97) | | | | | | | | | | | | | | | | |
|--------|------------------|----|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Write | SI | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 1 | х | х | х | х | х | х | х | х |
| Wille | SO | 0 | 0 | 1 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| | | | | | | | | | | | | | | | | | |
| Read * | SI | 1 | 0 | 0 | 1 | 0 | 1 | 1 | 1 | х | х | х | х | х | х | х | х |
| Reau | SO | 0 | 0 | 0 | Р | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |

* The READ response will always be ERROR with the RE bit set to '1'

JAL DEVICE OPERATION MESSAGE, OPERATION COMMAND AND SPI

Operational Mode SPI Command Table

All of the 33789 operational mode SPI commands are summarized in Table 36.

Table 36. Operational Mode SPI Command Table

| | | | | | 0 | peratio | nal Mo | de SPI | Comm | ands | | | | | | | | | | | | |
|-----|-------------|---|-----|-------|-----|---------|--------|----------|----------|------|----------|----------|-----------|-----|----------|-----------|-----------|----------|----------|----------|----------|--|
| ADD | Command | Function | R/W | | | | V | /rite Da | ita | | | | Read Data | | | | | | | | | |
| R | R | Function | R/W | 15:08 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | 15:08 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| 00 | | | | 40 | | | | | | | | | 80 | | | | | | | | | |
| 01 | | | | 41 | | | | | | | | | 81 | | | | | | | | | |
| 02 | ESR_DIAG | Enable ESR Test / Read VER- DIAC | R/W | 42 | х | х | х | х | х | х | х | EN | 82 | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | |
| 03 | LINE_ENABLE | Satellite Channel Enable | R/W | 43 | х | х | х | х | 4LE | 3LE | 2LE | 1LE | 83 | OT4 | OT3 | OT2 | OT1 | 4LE | 3LE | 2LE | 1LE | |
| 04 | SYNC_ENABLE | Satellite Channel Sync Pulse Enable | R/W | 44 | х | х | х | х | 4SE | 3SE | 2SE | 1SE | 84 | 0 | 0 | 0 | 0 | 4SE | 3SE | 2SE | 1SE | |
| 05 | SAFE_TH_0 | Safing Threshold 0 Value | R/W | 45 | T7 | T6 | T5 | T4 | T3 | T2 | T1 | Т0 | 85 | T7 | T6 | T5 | T4 | Т3 | T2 | T1 | T0 | |
| 06 | SAFE_TH_1 | Safing Threshold 1 Value | R/W | 46 | T7 | T6 | T5 | T4 | T3 | T2 | T1 | Т0 | 86 | T7 | T6 | T5 | T4 | Т3 | T2 | T1 | T0 | |
| 07 | SAFE_TH_2 | Safing Threshold 2 Value | R/W | 47 | T7 | T6 | T5 | T4 | T3 | T2 | T1 | T0 | 87 | T7 | T6 | T5 | T4 | Т3 | T2 | T1 | T0 | |
| 08 | SAFE_TH_3 | Safing Threshold 3 Value | R/W | 48 | T7 | T6 | T5 | T4 | T3 | T2 | T1 | Т0 | 88 | T7 | T6 | T5 | T4 | Т3 | T2 | T1 | T0 | |
| 09 | SAFE_TH_4 | Safing Threshold 4 Value | R/W | 49 | T7 | T6 | T5 | T4 | T3 | T2 | T1 | Т0 | 89 | T7 | T6 | T5 | T4 | Т3 | T2 | T1 | T0 | |
| 0A | SAFE_TH_5 | Safing Threshold 5 Value | R/W | 4A | T7 | T6 | T5 | T4 | T3 | T2 | T1 | T0 | 8A | T7 | T6 | T5 | T4 | Т3 | T2 | T1 | T0 | |
| 0B | SAFE_TH_6 | Safing Threshold 6 Value | R/W | 4B | T7 | T6 | T5 | T4 | T3 | T2 | T1 | Т0 | 8B | T7 | T6 | T5 | T4 | Т3 | T2 | T1 | T0 | |
| 0C | SAFE_TH_7 | Safing Threshold 7 Value | R/W | 4C | T7 | T6 | T5 | T4 | T3 | T2 | T1 | Т0 | 8C | T7 | T6 | T5 | T4 | Т3 | T2 | T1 | T0 | |
| 0D | T_UNLOCK | Safing Threshold Unlock | W | 4D | U7 | U6 | U5 | U4 | U3 | U2 | U1 | U0 | 8D | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | |
| 0E | WDOG_FEED | Watchdog Pet Command | W | 4E | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | 8E | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | |
| 0F | LINE_MODE | Satellite Synchronization Select | R/W | 4F | х | х | х | х | LM4 | LM3 | LM2 | LM1 | 8F | 0 | 0 | 0 | 0 | ILM4 | LM3 | LM2 | LM1 | |
| 10 | LIN_CONFIG | LIN Configuration | R/W | 50 | х | х | REN | RX01 | RXO 0 | х | LSR1 | LSR0 | 90 | х | х | REN | RX01 | RXO 0 | х | LSR1 | LSR0 | |
| 11 | PS_CONTROL | Energy Reserve Activation Con- trol | R/W | 51 | х | х | SC | BOE | х | BUE | ERC 1 | ERC 0 | 91 | BST | CDF | SC | BOE | 0 | BUE | ERC 1 | ERC 0 | |
| 12 | AI_CONTROL | Analog Interface Control | R/W | 52 | х | х | х | AIC4 | AIC3 | AIC2 | AIC1 | AIC0 | 92 | 0 | 0 | 0 | AIC4 | AIC3 | AIC2 | AIC1 | AIC0 | |
| 13 | DCS_CONTROL | DC Sensor Control | R/W | 53 | SS3 | SS2 | SS1 | SS0 | VS1 | VS0 | х | х | 93 | SS3 | SS2 | SS1 | SS0 | VS1 | VS0 | 0 | 0 | |
| 14 | DIAG_CLR | Diagnostic Test Clear | W | 54 | х | х | х | х | х | х | х | х | 94 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | |
| 15 | WDOG_TEST | Watchdog Test | W | 55 | х | х | х | х | х | х | х | х | 95 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | |
| 16 | STATUS | 33789 Status | R | 56 | х | x | х | х | х | х | х | x | 96 | SOT | DCO T | BOT | IGN | WU | WS1 | WS0 | WDR | |
| 17 | NOP | No-Op | W | 57 | х | х | х | х | х | х | х | х | 97 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | |
| 18 | SAFE_CTL | ARM/DISARM Output and Mode Control | R/W | 58 | Х | Х | Х | Х | MR1 | MR0 | TEN | LEV | 98 | VD3 | VD2 | VD1 | VD0 | MD1 | MD0 | OE | SE | |
| 19 | SCRAP_SEED | Scrapping Function Seed Request | R | 59 | х | х | х | х | х | х | х | x | 99 | S7 | S6 | S5 | S4 | S3 | S2 | S1 | S0 | |
| 1A | SCRAP_KEY | Scrapping Function Key Submit | W | 5A | K7 | K6 | K5 | K4 | K3 | K2 | K1 | K0 | 9A | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | |
| 1B | OUT1_CTL | General Purpose Driver1 Output Control | R/W | 5B | DC5 | DC4 | DC3 | DC2 | DC1 | DC0 | HS | х | 9B | TS | 0 | OFF2 3 | OFF1 3 | ON2 3 | ON1 3 | HS | 0 | |
| 1C | OUT2_CTL | General Purpose Driver2 Output Control | R/W | 5C | DC5 | DC4 | DC3 | DC2 | DC1 | DC0 | HS | x | 9C | TS | 0 | OFF2 3 | OFF1 3 | ON2 3 | ON1 3 | HS | 0 | |
| 1D | | | | 5D | | | | I | I | | 1 | | 9D | | | | | | | | 1 | |
| 1E | | | | 5E | | | | | | | 1 | | 9E | | | | | | | | | |
| 1F | | | | 5F | | | | I | I | | 1 | | 9F | İ | İ | | | | | | | |

TEST-MODE SPI COMMANDS

The 33789 enters Test mode when the PPT pin is driven high, i.e. 5.0 V, and the test-mode entry command is received.

Table 37. SPI Command, - Test Mode Entry

TESTMODE (ADDR=0xD5, DATA=0x52)

| | | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------|----|----|----|----|----|----|----|---|---|---|---|---|---|---|---|---|---|
| TEST | SI | 1 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 1 | 0 | 0 | 1 | 0 |
| | SO | 0 | 1 | 1 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

FAILURE MODE REQUIREMENTS

SPI Error

SPI Error is defined as a condition where the SPI frame format is incorrect.

When a SPI error is detected, the 33789 will respond with an error response message on SO with the 'SPI Error' (SE) bit set. When a SPI error is detected, the 33789 will immediately set SO to a high-impedance state.

SPI errors could be caused by:

•An incorrect number of SPI SCK cycles (>16, or <16 but >0), while $\overline{\text{CS}}$ is active

•Too short of an inter-frame time



SPI Request Error

A SPI Request Error is defined as a condition, where the content of a SPI request message is incorrect.

When a SPI Request Error is detected, the 33789 will respond with an error response message on SO with the 'Request Error' (RE) bit set.

SPI request errors could be caused by:

•An undefined command (e.g. incorrect address in bits [12:8])

•An illegal operation for a defined command (e.g. attempting to write when receiving a read-only command)

•An attempted command request while in the incorrect state for the command (e.g. T_UNLOCK command while not in Start-up mode)

SAFING

SAFING CONCEPT

The safing concept involves the utilization of logic independence of the MCU to monitor both on-board and remote satellite sensors, to determine if a sufficient inertial activity is present to warrant deployment Arming of the system.

While in the Safing state, on the rising edge of the SATSYNC input, the MCU will request samples from all digital sensing sources, in a predetermined sequence with SPI commands. If sensor data in response is valid, the safing logic will compare it to the appropriate safing threshold. The threshold was arranged based on the expected sequence of sampling. The safing thresholds of the 33789 have been assigned to pairs of sequence numbers as shown in <u>Table 38</u>.

| Sequence Identifier | Safing Threshold |
|---------------------|------------------|
| 0000 | Threshold 0 |
| 0001 | I nreshold 0 |
| 0010 | Threehold 4 |
| 0011 | Threshold 1 |
| 0100 | Threehold 2 |
| 0101 | Threshold 2 |
| 0110 | Threehold 2 |
| 0111 | Threshold 3 |
| 1000 | Threehold 4 |
| 1001 | Threshold 4 |
| 1010 | Thus shale 5 |
| 1011 | Threshold 5 |
| 1100 | Threehold C |
| 1101 | Threshold 6 |
| 1110 | Threshold 7 |

 Table 38.
 Sequence to Safing Threshold Mapping

If three consecutive samples from the same sensor exceed the threshold, an internal safing signal is set. This safing signal activation will assert the Arming outputs (ARM and DISARM) for the duration of the signal, plus a Dwell Extension period after it is cleared. The Dwell Extension period is defined either 255 ms or 2.0 seconds depending on the safing condition.

To prevent a loss of synchronization between the sampling order and the desired threshold (e.g. a sensor fails to respond), an internal Sequence Counter is designated to maintain the increments each time a sensor's data response is received, whether it includes valid data or not. This Sequence Counter is reset at each rising edge of Satsync to re-synchronize with the next sampling period. If a sequence ID in the SPI request/response (SQ2:SQ0) does not match the corresponding value in the Sequence Counter, the 33789 will immediately set a Sequence Error bit and disable safing on digital sensors for the rest of the sample period, until the next Satsync rising edge.

Another counter, Valid Data Counter, which is also reset at each rising edge of Satsync, is used to determine how many SPI data frames containing valid sensor data have been received in each sampling period. The Valid Data Counter is readable via the SPI for the MCU.



SAFING STATE MACHINE

The Safing State Machine (SSM) is used to control the safing function and provide diagnostics. The control logic of the 33789 Safing State Machine can be described in <u>Figure 51</u>. This logic provides a high level of robustness to the system architecture by restricting the primary safing function while diagnostics are performed. It facilitates key-on and run-time diagnostic tests. It also provides a means of activating safing for the scrap function, which would be useful to safely activate the Arming outputs for disposal of pyrotechnic devices at the end of vehicle life.

The 33789 Safing State Machine supports five mutually exclusive modes of operation:

Start-up Mode

The Start-up mode is entered upon the release of SSM Reset.

While in Start-up mode, sampling sensor data and activating the ARM/DISARM outputs are inhibited.

Updating the safing thresholds is permitted only while in Start-up mode.

When the watchdog service begins (upon the first successful watchdog feed), the SSM enters the Diagnostic mode.

Diagnostic Mode

When the Diagnostic mode is entered, testing of the ARM and DISARM outputs are enabled, which allows the MCU to activate the signals both high or both low for testing the interface. It is not possible to set both of the outputs in their active states (ARM=1 and DISARM=0) in this mode.

The SSM remains in this mode until a SAFE_CTL SPI command is received for either a Safing mode transition or a Scrap mode transition.

Safing Mode

Upon reception of the SAFE_CTL command with the CTL field set to 'Safing' while in Diagnostic mode, the SSM enters Safing mode. Safing mode is the primary run-time mode for normal operation. The safing logic can perform all of the safing functions, including monitoring sensor data and setting the ARM/DISARM signals for Arming output while in this state.

The only means of exiting Safing mode is the assertion of the SSM Reset signal.

Scrap Mode

If the MCU sends the 33789 a SAFE_CTL command with the CTL field set to 'Scrap', while the SSM is in Diagnostic mode, it will force the SSM enter into Scrap mode.

Once entered into Scrap mode, the SSM stops monitoring the sensor interface, and the safing compare logic is disabled.

From Scrap mode, the SSM can be moved into Arming mode only if the MCU initiates the transition. The only way to move it back from Scrap mode to Start-up mode is through an SSM Reset.

Arming Mode

While in Arming Mode, the safing outputs are asserted (ARM = 1 and $\overline{\text{DISARM}}$ = 0) to enable firing of squibs.

In order to protect from an inadvertent enter into Arming mode, and to prevent undesired activation of the safing signal, a handshake is used to control entering into and exiting out of Arming mode.



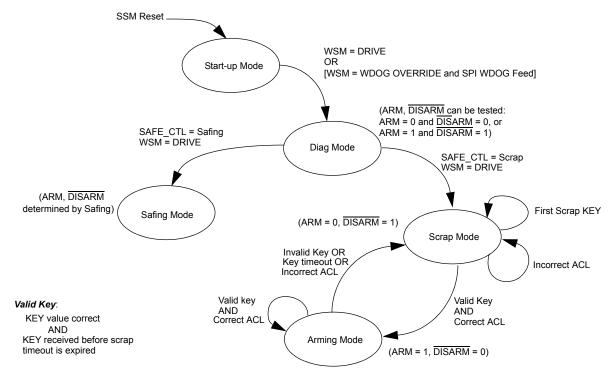


Figure 51. Safing State Diagram

The handshake sequence for activating the Arming outputs is illustrated in Figures 52. The strategy is:

The 33789 uses a free-running 8-bit counter to generate a seed value;

- ✤ The MCU read the seed value with the SCRAP_SEED command;
 - ✤ The MCU uses the seed value to generate an 8-bit key;
 - ✤ The MCU submits the key value with the SCRAP_KEY command;
- The 33789 freezes the seed value read by the MCU and computes its own key;
 - ♦ Compares two key values at the 33789;
 - ✤ The 33789 receives the ACL signal at the SCRAP pin from the MCU;
 - ✤ If two key values match each other,

AND

the ACL signal is valid,

Stransition into Arming mode

To remain in Arming mode, the MCU must periodically refresh the 33789 with SCRAP_KEY command containing correct key value, and the 33789 must continuously receive a valid ACL signal at the SCRAP pin from either the MCU or another external device, depending on the application. This must occur before the scrap timeout timer expires (in about 600 µs).

If the periodic scrap key is incorrect, or not been received before timeout, or there is no valid ACL signal at the SCRAP pin, the SSM reverts back to the Scrap mode, and the Arming outputs are deactivated.

The scrap key is derived from the seed value using a simple logic inversion on the even-numbered bit (0, 2, 4, 6), - equivalent to a bitwise XOR of the seed value with 0x55, logically.



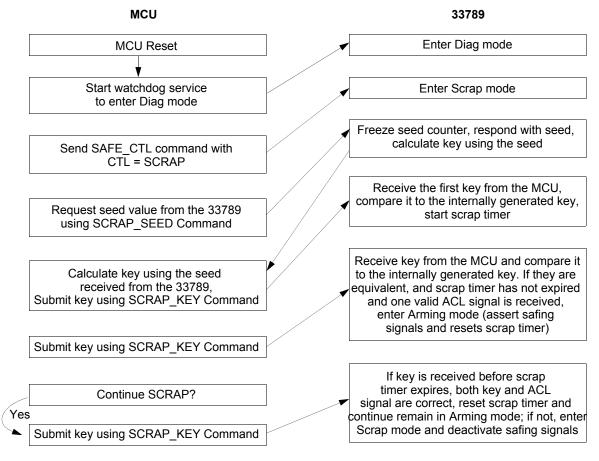


Figure 52. Arming Mode Handshake

SPI MONITOR AND DECODER

The SPI Monitor block extracts valid sensor data from the SPI sensor data messages read by the MCU to be able to determine the safing status. All of the safing related sensor data received by the safing block, including the satellite sensor data from the PSI5 interface, analog sensor data from A_SENSOR input, and other digital sensor data from local ECU sensors, are monitored for correctness of data and sequence by the SPI monitor decoder, and will be further used in the safing logic processing.

The SPI monitor is capable of receiving sensor data through the SPI interface from up to 4 sources with 4 specifically assigned chip select signals:

•CS: Dedicated to the PSI5 satellite channels

- •CS_A: Intended for an on-board high-g X, or X/Y accelerometer
- •CS_B: Intended for an on-board high-g Y, or expansion of satellite receiver
- •CS_C: Intended for an expansion of satellite receiver

While the Safing State Machine is in Safing mode, the SPI Monitor listens to all of the SPI SO responses from satellite receivers and on-board sensors corresponding to sensor data request from the MCU, and uses predefined sensor message format and data validation criteria to check the messages. Functions of the SPI Monitor results in generation of three important internal signals within the safing block:

Sensor Message Detection: - generate SENS_MSG

When the SENS_MSG signal is activated, it indicates a valid sensor message is received and the Sequence Counter is not frozen (when frozen, the counter value equal to '1110').

The SPI Monitor needs to qualify the SPI message frame first by "Frame Check":

- 1. SPI data is captured when the chip select is low;
- 2. The first 16 bits of SO data are captured regardless of the total number of SCK edges detected;
- 3. A valid frame is detected when the chip select goes high and at least 16 SCK edges have been detected;
- 4. Frames fewer than 16 SCK edges are ignored;



5. If more than one chip select is active at any time during an SPI frame, the SPI frame shall not be validated.

All of the necessary conditions to generate SENS_MSG can be found in Figure 53.

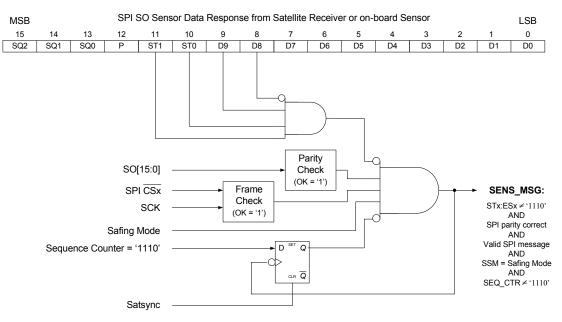


Figure 53. SPI Decode Logic for SENS_MSG Signal

Sequence Error Detection: - Generate SEQ_ERROR

When a valid sensor message is detected (SENS_MSG = 1), the SPI Monitor compares the SQ2:SQ0 field (sequence number) of the SPI response message with the expected sequence number determined by the Sequence Counter. If there is a mismatch, the SEQ_ERROR signal is asserted, as shown in Figure 54.

Activation of SEQ_ERROR will set the Sequence Error bit of the SPI SAFE_CTL command register (SE = 1), and disable the safing comparison for the affected sensor and all subsequent sensors for the rest of the current sampling period, until the next Satsync rising edge.

While in Safing mode, the MCU must ensure that the sampling sequence is maintained for every sampling period, regardless of the state of sensors, to prevent a sequence error from disabling safing on the remaining channels in the sequence. Therefore, if there is a sensor disabled, the MCU must continue requesting data from the sensor to maintain the sampling sequence. However, it may load a "dummy" request to fill the SQ2:SQ0 field of the response message.

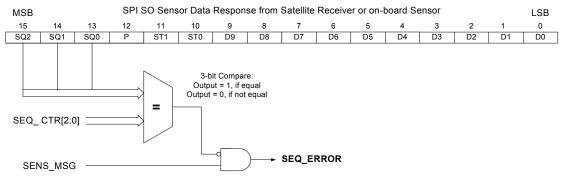


Figure 54. Sequence Error Detection Logic

Sensor Data Validation: - generate DAT_VALID

The DAT_VAL signal is activated whenever a SPI sensor data response message containing valid sensor data is received while in Safing mode.

All of following conditions must be met to validate the sensor data:

- 1. ST1:ST0 field of the SO response must be '01', to confirm this is a sensor data;
- 2. The SENS_MSG signal must be active, to confirm it has a qualified message frame;



- 3. The data must be in the valid value range:
 - Data (D9:D0) within -480_{DEC} ~ +480_{DEC} inclusive if the sequence counter value >2
 Data (D9:D0) within -512_{DEC} ~ +511_{DEC} inclusive if the sequence counter value <3
- 4. The Sequence Error (SE) bit is clear.

The SPI decode logic to validate sensor data can be illustrated in Figure 55.

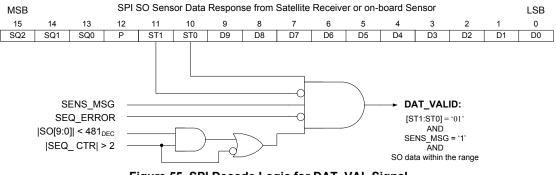


Figure 55. SPI Decode Logic for DAT_VAL Signal

SAFING CONTROL COUNTERS

There are two 4-bit Safing control counters in the Safing logic block.

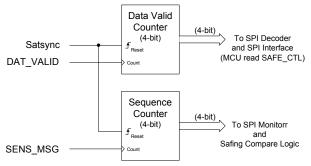


Figure 56. Safing Control Counters

Sequence Counter

The Sequence Counter increments each time a valid sensor SPI message is received, regardless of whether it contains valid data, an error message, or self-test data. It is incrementally based on the SENS_MSG signal from the SPI Monitor block, and it resets on each Satsync rising edge.

Due to the control of SENS_MSG, the Sequence Counter will never advance beyond '1110'. In order to correlate correctly with the received SPI messages, the Sequence Counter is reset to a value of '1111', so the first sample received causes it to increment to '0000'.

This counter is not read nor write accessible via the SPI interface. The counter contents are used by the SPI Monitor logic to detect sequence errors, and by the Safing Compare Logic, to correlate sensor samples to the appropriate safing threshold for comparison.

Data Valid Counter

The Data Valid Counter increments each time a sensor SPI message is received that contains valid sensor data (ST1:ST0 = '01'). It is incrementally based on the DAT_VALID signal from the SPI Monitor block, and resets on each Satsync rising edge.

Due to the control of SENS_MSG, the Data Valid Counter will freeze once the Sequence Counter reaches a value of '1110'. The Data Valid Counter is reset to a value of '0000' on each Satsync rising edge to accurately reflect the number of samples received.

The count value can be read by the MCU using the SPI SAFE_CTL command to determine whether all digital sensor samples have been received by safing logic.



SAFING THRESHOLD LOGIC

The Safing Threshold logic ensures the safing comparison threshold value can be reliably written and read by the MCU.

The 33789 is capable of storing eight 8-bit safing thresholds. The MSB of threshold data is used to indicate the Dwell Extension pulse width (either 255 ms or 2.0 s).

The thresholds are correlated to the sampling sequence number pair, as shown in Figure 57.

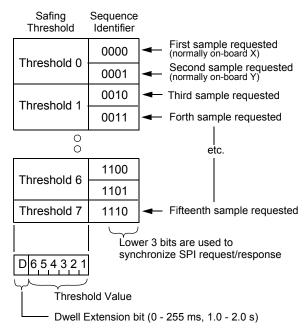


Figure 57. Safing Threshold Storage

Upon the Safing state machine reset, all of the threshold values are rest to default values. Applications may choose to use these default values or reprogram them.

The default safing thresholds are listed in Table 39:

| Table 39. | Default | Safing | Thresholds |
|-----------|---------|--------|------------|
| Table 39. | Delault | Samiy | Thesholds |

| Sequence # (Sampling Order) | Sequence ID | Desired 10-bit Threshold Value (dec) | Desired 10-bit Threshold Value (hex) | Dwell Extension | Targeted Sensor Type | Targeted Sensor Threshold | Encoded 8-bit Threshold (hex) | |
|-----------------------------------|-------------|--|--|--------------------|-------------------------|---------------------------------|-------------------------------------|----|
| 0 | 0000 | 27 | 1B | 255 ms | On-board 50 g X | 2.8 g | 0D | |
| 1 | 0001 | 27 | | | On-board 50 g Y | | | |
| 2 | 0010 | 42 | 2A | 2.0 s | Digital ARS | 30°/s | 95 | |
| 3 | 0011 | 42 | | | Analog ARS | | | |
| 4 | 0100 | 16 | 10 | 255 ms | Satellite | 10 a | 08 | |
| 5 | 0101 | 10 | | 200 1115 | 240 g | 10 g | 00 | |
| 6 | 0110 | 16 | 10 10 | 10 | 255 ms | Satellite | 10 ~ | 08 |
| 7 | 0111 | | 10 | 200 1115 | 240 g | 10 g | 08 | |
| 8 | 1000 | 16 | 10 | 255 ms | Satellite | 7.8%0 | 08 | |
| 9 | 1001 | 10 | 10 | 200 1118 | pressure | 7.0%0 | 08 | |
| 10 | 1010 | 16 | 10 | 255 ms | Satellite | 10 ~ | 08 | |
| 11 | 1011 | 10 | 10 | 200 1118 | 240 g | 10 g | 08 | |
| 12 | 1100 | 0 | 0 | 055 mg | Satellite | 10 ~ | 04 | |
| 13 | 1101 | 8 | 8 | 255 ms | 480 g | 10 g | 04 | |
| 14 | 1110 | 8 | 8 | 255 ms | Satellite 480 g | 10 g | 04 | |

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SPI Read / Write Access to Safing Thresholds

The MCU has read and write access to the safing thresholds via the SPI interface, using eight SPI SAFE_THx commands.

The application specific safing thresholds are allowed to be written to the safing logic only when the 33789 in Start-up mode, to ensure the Arming outputs are disabled during the threshold updates and to prevent inadvertent modification of the thresholds during Safing or Scrap mode.

As additional protection against an undesired safing threshold update, writing an "unlock key" into the T_UNLOCK register prior to writing thresholds value through the SAFE_THx command is required. The T_UNLOCK command must immediately precede the SAFE_THx command to correctly update the threshold values.

The unlock key value is calculated by bit-wise XORing the threshold value with the value '0xAD'.

To successfully update the safing threshold registers, all of the following conditions must be met:

•The 33789 is in Start-up mode

•The previous SPI command must be a T_UNLOCK write command

•The SAFE_THx command data field must be equal to the unlock code from the T_UNLOCK command XORed with 0xAD:

•SAFE_THx(data) = [T_UNLOCK(data)] ^ 0xAD

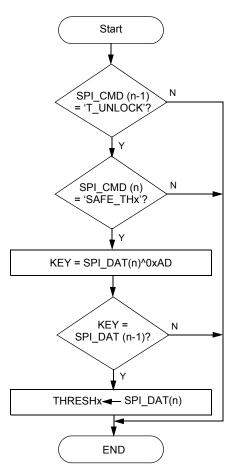


Figure 58. Safing Threshold Write Flowchart

Safing Threshold Encoding

Since the safing comparison involves the 8-bit threshold and a 9-bit magnitude, the desired threshold value must be divided by two (shift right by one bit) before being stored in the 33789. An additional MS '0 ' bit is then appended to the threshold value used for comparison.

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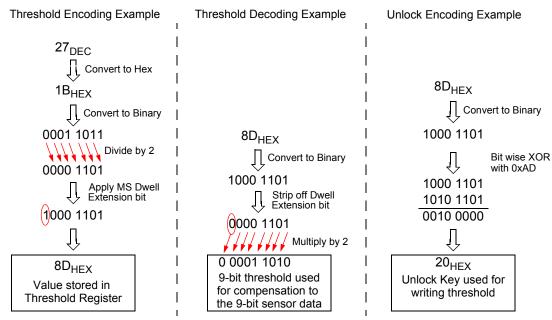


Figure 59. Safing Threshold and Unlock Key Encoding

SAFING COMPARISON LOGIC

Safing Comparison Enable

- The sensor data comparison is conducted under conditions of:
- The SPI message frames are received
- The sensor data is valid
- There is no Sequence Error

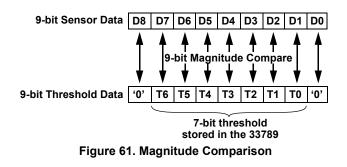


Figure 60. Safing Comparison Enable Logic

Safing Magnitude Comparison

All sensor data fed into the Safing Comparison logic is 9-bit, zero-adjusted, positive data, therefore the comparison involves a simple digital magnitude comparison between two 9-bit data.

The sensor data in the SPI response message frame uses a 10-bit sensor data format. It must be converted into 9-bit magnitude data for the comparison with the safing threshold.





Sample Counters

The sensor logic block consists of 16 2-bit Sample Counters to facilitate multi-sample evaluation of sensor data for safing.

Each counter corresponds to a specific Sequence ID in the 33789, and is incremented each time when the received sample exceeds its associated safing threshold. If there are three consecutive samples from a same sensor exceed the threshold (Sample Counter = '11'b), the Arming outputs are asserted (ARM = 1, DISARM = 0).

Once the counters reach their maximum value, they are not incremented further. The sample counters are reset upon Safing State Machine Reset, or whenever the corresponding data falls bellow its threshold.

DWELL EXTENSION

While in Safing mode, whenever the Arming signals is activated, Dwell Extension is used to extend the assertion time.

The Dwell Extension is disabled while in Diagnostic mode, - the Arming outputs could be activated for test.

While in Safing mode, If any of the 16 Sample Counters reach to their maximum value('11'b), the Arming outputs are asserted. They will be continuously asserted as long as any of the Sample Counters contain '11'b. and additionally, plus the established Dwell Extension time, after all Sample Counters contain values less than '11'b.

The Dwell Extension time is determined by the MSB (bit 7) of the safing threshold in which safing was met (i.e. the data exceeded the threshold for three consecutive samples). The Dwell Extension time can be either 255 ms or 2.0 s, based on this bit assigned with the safing threshold setting.

If safing is met on more than one Sequence ID with threshold(s) containing both 255 ms and 2.0 s Dwell Extension time choices, the longer (2.0 s) Dwell Extension is used for the safing outputs, which means the longer Dwell Extension time will override the shorter one. An example of Sample Counter, Dwell Extension time and Arming output is shown in Figure 62.

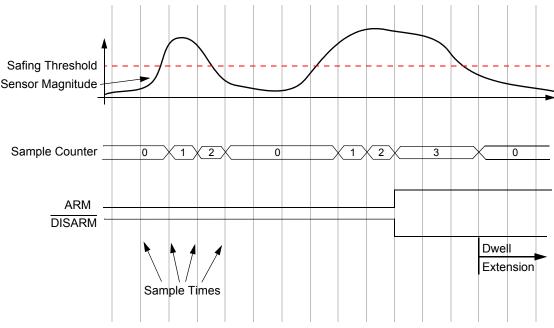


Figure 62. Example of Safing Dwell Extension



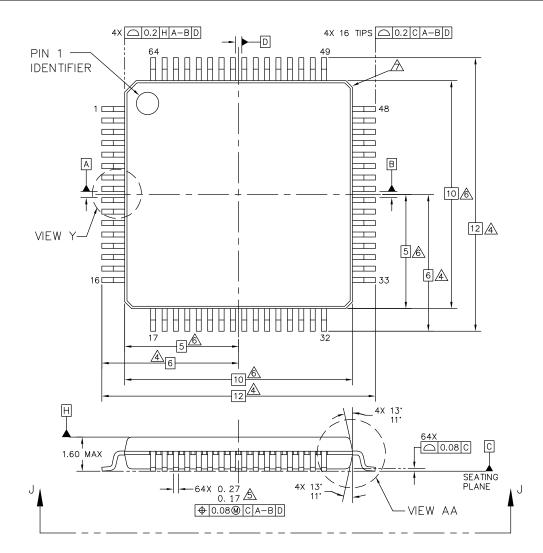
PACKAGING

PACKAGE MECHANICAL DIMENSIONS

Package dimensions are provided in package drawings. To find the most current package outline drawing, go to www.freescale.com and perform a keyword search for the drawing's document number.

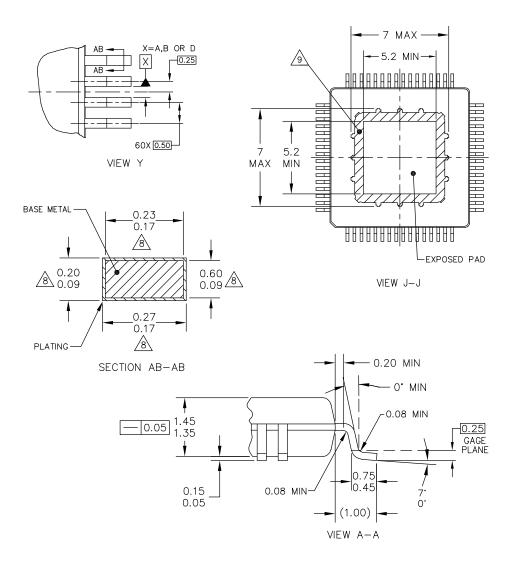
Table 40. Packaging Information

| Package | Suffix | Package Outline Drawing Number |
|----------------|--------|--------------------------------|
| 64-Pin LQFP-EP | AFE | 98ASA10763D |



| | © FREESCALE SEMICONDUCTOR, INC. ALL RIGHTS RESERVED. | MECHANICA | LOUTLINE | PRINT VERSION NO | DT TO SCALE |
|--|---|-----------|--------------|------------------|-------------|
| | TITLE: 64 LD LQFP. | | DOCUMENT NO |): 98ASA10763D | REV: A |
| | 10 X 10 X 1.4 PKG, 0.5 PITCH, 6.1 x 6.1 EXPOSED PAD | | CASE NUMBER | 8: 1899–02 | 14 DEC 2006 |
| | | | STANDARD: JE | DEC MS-026 BCD | |





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|---|-----------|--------------|------------------|-------------|
| TITLE: 64 LD LOFP. | | DOCUMENT NO | : 98ASA10763D | REV: A |
| 10 X 10 X 1.4 PKG, 0.5 PITCH, 6.1 x 6.1 EXPOSED PAD | | CASE NUMBER | 8: 1899–02 | 14 DEC 2006 |
| | | STANDARD: JE | DEC MS-026 BCD | |



NOTES:

- 1. DIMENSIONS ARE IN MILLIMETERS.
- 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994.
- 3. DATUMS A, B AND D TO BE DETERMINED AT DATUM PLANE H.
- \triangle dimensions to be determined at seating plane C.
- DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED THE MAXIMUM DIMENSION BY MORE THAN 0.08 MM. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD OR PROTRUSION 0.07 MM.
- DIMENSIONS DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25 MM PER SIDE. DIMENSIONS ARE MAXIMUM PLASTIC BODY SIZE DIMENSIONS INCLUDING MOLD MISMATCH.
- \triangle exact shape of each corner is optional.
- THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 MM AND 0.25 MM FROM THE LEAD TIP.
- A HATCHED AREA TO BE KEEP OUT ZONE FOR PCB ROUTING.
- 10. LEADFRAME PART NUMBER APPLIED IS 17ASS23232W610.

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|---|-----------|--------------|------------------|-------------|
| TITLE: 64 LD LQFP. | | DOCUMENT NE |]: 98ASA10763D | RE∨: A |
| 10 X 10 X 1.4 PKG, | | CASE NUMBER | 1899-02 | 14 DEC 2006 |
| 0.5 PITCH, 6.1 x 6.1 EXP(| DSED PAD | STANDARD: JE | DEC MS-026 BCD | |



REVISION HISTORY

| REVISION | DATE | DESCRIPTION OF CHANGES |
|----------|---------|---|
| 1.0 | 2/2011 | Initial Release |
| 2.0 | 12/2011 | Revised ESD Capability. Took Human Body Model - JESD22/A114⁽³⁾ from 6.0 kV to 2.0 kV Redefined INx Active Pull-down Current. Changed Max. from -50 to -30 μA Added First Dominant bit Delay |
| 3.0 | 4/2012 | Updated datasheet to include SafeAssure branding and technology identification. |
| 4.0 | 9/2014 | Removed MCZ33789AE from the ordering information Added MCZ33789BAE to the ordering information Updated IERSW_LEAK parameter in <u>Table 5</u> Deleted IVDD parameter in <u>Table 5</u> Updated VCC_UV parameter in <u>Table 5</u> Updated ISAT_TH_OFS parameter <u>Table 5</u> Updated ISAT_TH_HYST parameter <u>Table 5</u> Corrected the parameter label for f_{BST/BUCK} in <u>Table 5</u> Added Note 16 Added FSEL bit in LIN_CONFIG register in <u>Table 17</u> Corrected <u>Figure 37</u> Corrected <u>Table 18</u> Updated format and back page. |